HP Z6 G4 Workstation

Overview

HP Z6 G4 Workstation



Front view

- 1. Integrated Front Handle
- 2. Front I/O module options
 - Premium (optional, shown here): power button, 2 USB 3.1 G1 Type-A, 2 USB 3.1 G2 Type-C[™] (Left-most Type A port has charging capability), Headset/Mic, Media Card Reader (optional).
 - Standard: power button, 4 USB 3.1 G1 Type-A (left-most Type A port has charging capability), Headset/Mic, Media Card Reader (optional).
- 3. 2 x 5.25" external bays
- 4. 1 Slim ODD bay

HP Z6 G4 Workstation

QuickSpecs

Overview

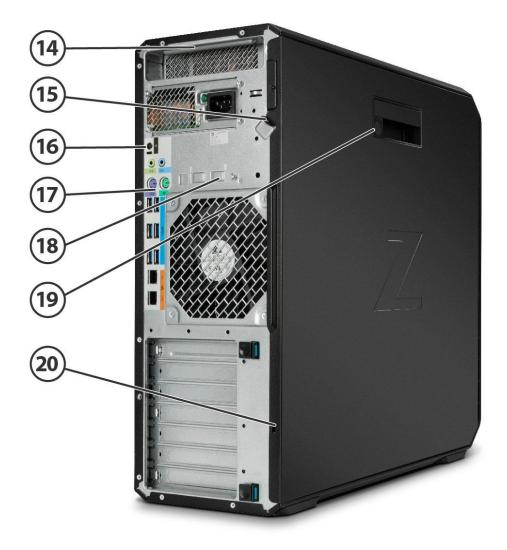


Internal view

- 5. Power supply: 1000W 90% efficient with 2 graphics power adapters
- 6. 6 DIMM slots: DDR4-2666 Registered RAM
- 7. Intel[®] Xeon[®] processor Scalable family
- 8. 2nd CPU & memory riser connector: adds 2nd CPU socket and (6) DIMM slots
- 9. PCIe slots: 2 PCIe G3 x16, 3 PCIe G3 x4, 1 PCIe G3 x8

- 10. 6 x 6Gb/s SATA ports
- 11. 2 PCIe G3 x4 M.2 for SSDs
- 12. 2 x 2.5"/3.5" internal drive bays
- 13. 2 x 5.25" external drive bays

Overview



- 14. Rear handle
- 15. Padlock loop
- 16. Rear power button
- Rear I/O (top to bottom): audio in/out, keyboard/mouse PS/2, 6 USB 3.1 G1 Type-A, 2 x 1GbE LAN ports
- Rear view
 - 18. HP Dual Port 10GBase-T NIC module slot (optional)
 - 19. Side panel barrel keylock (optional)
 - 20. Kensington lock slot

Overview

Overview

Form Factor Operating Systems Tower Preinstalled:

- Windows 10 Pro for Workstations¹
- Ubuntu 20.04 LTS²
- HP Linux-ready (minimal OS ready for customer OS installation)
- Red Hat[®] Enterprise Linux[®] Desktop Workstation (Paper license with 1 year support; no preinstalled OS)

Supported:

- Red Hat Enterprise Linux Workstation 6, 7, 8³
- SUSE Linux Enterprise Desktop 12, 15³
- Ubuntu 16.04, 18.04, 20.04 LTS²

¹Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows 10 is automatically updated, which is always enabled. ISP fees may apply, and additional requirements may apply over time for updates. See http://www.windows.com.

² Not all features are available in all editions or versions of Ubuntu. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS to take full advantage of Ubuntu functionality. Ubuntu may be automatically updated. ISP fees may apply, and additional requirements may apply over time for updates.

³**Notes**: For detailed Linux[®] OS/hardware support information, see: http://www.hp.com/support/linux_hardware_matrix

Note: In accordance with Microsoft's support policy, HP does not support the Windows[®] 7 operating system on products configured with Intel[®] 7th Generation and forward processors.

Available Processors

| Name | Cores | Clock Speed (GHz) | Cache (MB) | Memory Speed (MT/s) | Hyper- Threading | Intel® Turbo Boost Technology ¹ | Supports Intel® DCPMM Technology ² | TDP (W) | | | | |
|--|-------|-------------------------|---------------|---------------------------|---------------------|--|--|------------|--|--|--|--|
| Intel® Xeon® W Processors | | | | | | | | | | | | |
| Intel® Xeon® W-3245 16 3.2 GHz 22 2933 YES 4.4, 4.6 NO | | | | | | | | 205 | | | | |
| Intel® Xeon® W-3235 processor | 12 | 3.3 GHz | 19.25 | 2933 | YES | 4.4, 4.5 | NO | 180 | | | | |
| Intel® Xeon® W-3225 processor | 8 | 3.7 GHz | 16.5 | 2666 | YES | 4.3, 4.4 | NO | 160 | | | | |
| Intel® Xeon® W-3223 processor | 8 | 3.5 GHz | 16.5 | 2666 | YES | 4, 4.2 | NO | 160 | | | | |
| | | lı | ntel® Xeon® S | calable Proce | essors | | | | | | | |
| Intel® Xeon® Platinum 8280 processor | 28 | 2.7 GHz | 38.50 | 2933 | YES | 3.3, 4.0 | YES | 205 | | | | |
| Intel® Xeon® Platinum 8260 processor | 24 | 2.4 GHz | 35.75 | 2933 | YES | 3.1, 3.9 | YES | 165 | | | | |
| Intel® Xeon® Gold 6258R processor | 28 | 2.7 GHz | 38.50 | 2933 | YES | 4.0, 3.4 | YES | 205 | | | | |



Overview

| Intel® Xeon® Gold 6254 processor | 18 | 3.1 GHz | 24.75 | 2933 | YES | 3.9, 4.0 | YES | 200 |
|--------------------------------------|----|---------|-------|------|-----|----------|-----|-----|
| Intel® Xeon® Gold 6252 processor | 24 | 2.1 GHz | 35.75 | 2933 | YES | 2.8, 3.7 | YES | 150 |
| Intel® Xeon® Gold 6248R processor | 24 | 3.0 GHz | 35.75 | 2933 | YES | 4.0, 3.9 | YES | 205 |
| Intel® Xeon® Gold 6248 processor | 20 | 2.5 GHz | 27.50 | 2933 | YES | 3.2, 3.9 | YES | 150 |
| Intel® Xeon® Gold 6246R processor | 16 | 3.4 GHz | 35.75 | 2933 | YES | 4.1, 4.0 | YES | 205 |
| Intel® Xeon® Gold 6244 processor | 8 | 3.6 GHz | 24.75 | 2933 | YES | 4.3, 4.4 | YES | 150 |
| Intel® Xeon® Gold 6242R processor | 20 | 3.1 GHz | 35.75 | 2933 | YES | 4.1, 3.8 | YES | 205 |
| Intel® Xeon® Gold 6242 processor | 16 | 2.6 GHz | 22 | 2933 | YES | 3.5, 3.9 | YES | 150 |
| Intel® Xeon® Gold 6240R processor | 24 | 2.4 GHz | 35.75 | 2933 | YES | 4.0, 3.2 | YES | 165 |
| Intel® Xeon® Gold 6240Y processor | 18 | 2.6 GHz | 24.75 | 2933 | YES | 3.3, 3.9 | YES | 150 |
| Intel® Xeon® Gold 6240 processor | 18 | 2.6 GHz | 24.75 | 2933 | YES | 3.3, 3.9 | YES | 150 |
| Intel® Xeon® Gold 6238R processor | 28 | 2.2 GHz | 38.5 | 2933 | YES | 4.0, 3.0 | YES | 165 |
| Intel® Xeon® Gold 6238 processor | 22 | 2.1 GHz | 30.25 | 2933 | YES | 3.4, 3.7 | YES | 140 |
| Intel® Xeon® Gold 6234 processor | 8 | 3.3 GHz | 24.75 | 2933 | YES | 4.0, 4.0 | YES | 130 |
| Intel® Xeon® Gold 6230R processor | 26 | 2.1 GHz | 35.75 | 2933 | YES | 4.0, 3.0 | YES | 150 |
| Intel® Xeon® Gold 6230 processor | 20 | 2.1 GHz | 27.50 | 2933 | YES | 2.8, 3.9 | YES | 125 |
| Intel® Xeon® Gold 6226R processor | 16 | 2.9 GHz | 22 | 2933 | YES | 3.9, 3.6 | YES | 150 |
| Intel® Xeon® Gold 6226 processor | 12 | 2.7 GHz | 19.25 | 2933 | YES | 3.5, 3.7 | YES | 125 |
| Intel® Xeon® Gold 6154 processor | 18 | 3.0 GHz | 24.75 | 2666 | YES | 3.7, 3.7 | NO | 200 |
| Intel® Xeon® Gold 6136 processor | 12 | 3.0 GHz | 24.75 | 2666 | YES | 3.6, 3.7 | NO | 150 |
| Intel® Xeon® Gold 6132 processor | 14 | 2.6 GHz | 19.25 | 2666 | YES | 3.3, 3.7 | NO | 140 |
| Intel® Xeon® Gold 6128 processor | 6 | 3.4 GHz | 19.25 | 2666 | YES | 3.7, 3.7 | NO | 115 |
| Intel® Xeon® Gold 5222 processor | 4 | 3.8 GHz | 16.5 | 2666 | YES | 3.9, 3.9 | YES | 105 |
| Intel® Xeon® Gold 5220R processor | 24 | 2.2 GHz | 35.75 | 2666 | YES | 4.0, 2.9 | YES | 150 |
| Intel® Xeon® Gold 5220 processor | 18 | 2.2 GHz | 24.75 | 2666 | YES | 2.7, 3.9 | YES | 105 |
| Intel® Xeon® Gold 5218R processor | 20 | 2.1GHz | 27.5 | 2666 | YES | 4.0, 2.9 | YES | 125 |
| Intel® Xeon® Gold 5218 processor | 16 | 2.3 GHz | 22 | 2666 | YES | 2.8, 3.9 | YES | 125 |
| Intel® Xeon® Gold 5215 processor | 10 | 2.5 GHz | 13.75 | 2666 | YES | 3.0, 3.4 | YES | 85 |



Overview

| Intel® Xeon® Gold 5118 processor | 12 | 2.3 GHz | 16.50 | 2400 | YES | 2.7, 3.2 | NO | 105 | |
|--|--|--------------------------------|-------------------------------|--------------------------|-----------------------------|--|-------------------------------|----------|--|
| Intel® Xeon® Silver 4216 processor | 16 | 2.1 GHz | 22 | 2400 | YES | 2.7, 3.2 | NO | 100 | |
| Intel® Xeon® Silver 4215R processor | 8 | 3.2 GHz | 11 | 2400 | YES | 4.0, 3.6 | YES | 130 | |
| ntel® Xeon® Silver 4215 processor | 8 | 2.5 GHz | 11 | 2400 | YES | 3.0, 3.5 | YES | 85 | |
| ntel® Xeon® Silver 4214R processor | 12 | 2.4 GHz | 16.5 | 2400 | YES | 3.0, 3.5 | NO | 100 | |
| ntel® Xeon® Silver 4214Y processor | 12 | 2.2 GHz | 16.5 | 2400 | YES | 2.7, 3.2 | NO | 85 | |
| ntel® Xeon® Silver 4214 processor | 12 | 2.2 GHz | 16.5 | 2400 | YES | 2.7, 3.2 | NO | 85 | |
| ntel® Xeon® Silver 4210R processor | 10 | 2.4 GHz | 13.75 | 2400 | YES | 2.9, 3.2 | NO | 100 | |
| ntel® Xeon® Silver 4210 processor | 10 | 2.2 GHz | 13.75 | 2400 | YES | 2.7, 3.2 | NO | 85 | |
| ntel® Xeon® Silver 4208 processor | 8 | 2.1 GHz | 11 | 2400 | YES | 2.5, 3.2 | NO | 85 | |
| ntel® Xeon® Silver 4114 processor | 10 | 2.2 GHz | 13.75 | 2400 | YES | 2.5, 3.0 | NO | 85 | |
| ntel® Xeon® Silver 4112 processor | 4 | 2.6 GHz | 8.25 | 2400 | YES | 2.9, 3.0 | NO | 85 | |
| ntel® Xeon® Silver 4108 processor | 8 | 1.8 GHz | 11.00 | 2400 | YES | 2.1, 3.0 | NO | 85 | |
| Intel® Xeon® Bronze 3206R processor | 8 | 1.9 GHz | 11.00 | 2133 | YES | N/A | NO | 85 | |
| Intel® Xeon® Bronze 3204 processor | 6 | 1.9 GHz | 8.25 | 2133 | YES | N/A | NO | 85 | |
| Intel® Xeon® Bronze 3106 processor | 8 | 1.7 GHz | 11.00 | 2133 | NO | N/A | NO | 85 | |
| | All Z6G4 In | tel® Xeon® C | PUs Feature | Intel [®] vPro™ | Technology | /. | | | |
| | | | | | | wing: (all core m : have turbo fund | | | |
| | ² Intel [®] Data | a Center Pers | sistent Mem | ory Modules | availability v | vill be announce | d at a future d | late. | |
| Available Processors | | | | | | | | | |
| Disclaimers | When ordering two processors, the second processor must be the same as the first. Intel processor numbers are not a measurement of higher performance. Processor numbers differentiate features within each processor family, not across different processor families. | | | | | | | | |
| | software a frequency | pplications v will vary dep | will necessar bending on a | ily benefit fr | om use of th orkload and | tware products. is technology. P your hardware a is not a measure | Performance a and software | nd clock | |

configurations. Intel's numbering, branding and/or naming is not a measurement of higher performance. Black

Convertibility

No



Color

HP Z6 G4 Workstation

Overview

Expansion Slots (see Slot 0:

more details)

system board section for Mechanical-only, for use with devices that require only rear bulkhead mounting or when 2nd CPU riser is installed

Slot 1:

PCI Express Gen3 x4 - CPU with open-ended connector*

Slot 2:

PCI Express Gen3 x16 - CPU

Slot 3:

PCI Express Gen3 x4 - PCH with open-ended connector*

Slot 4:

PCI Express Gen3 x8 – CPU with open-ended connector (slot converts to x4 electrical when SSD is installed in 2nd M.2 slot)*

Slot 5:

PCI Express Gen3 x16 - CPU

Slot 6:

PCI Express Gen3 x4 - PCH with open-ended connector*

M.2 Slot 1:

M.2 PCle Gen 3 x4 - CPU up to 80mm storage devices

M.2 Slot 2:

M.2 PCle Gen 3 x4 - CPU up to 80mm storage devices

* Open-ended connector allows a greater bandwidth (e.g. x16) card to be installed physically into a lower bandwidth connector/slot.

| Expansion Bays (see storage section for more details) | 2 internal 3.5" bays (with acoustic dampening rail assemblies pre-installed) 2 external 5.25" bays 3rd and 4th 3.5" HDD each occupy one external bay 3rd and 4th 2.5" HDD/SSD occupy a single external bay within a 2:1 carrier) | | | | |
|---|---|--|--|--|--|
| | 1 dedicated 9.5mm slim optical disk drive bay | | | | |
| Front I/O | Base: Power button, 1 Headset audio port, 4 USB 3.1 G1 Type A (1 charging) Premium (optional): Power button, 1 Headset audio port, 2 USB 3.1 G2 Type C[™], 2 USB 3.1 G1 Type A (1 charging) Optional: SD reader | | | | |
| Internal I/O | 1 USB 3.1 G1 (aka USB 3.0) single-port header, 1 USB 2.0 single-port header and 1 USB 2.0 dual-port header | | | | |
| Rear I/O | 6 USB 3.1 G1 (aka USB 3.0) Type A ports, 2 1Gbe LAN ports (1x supporting Intel® AMT), Audio: 1 Line out, 1 Line in (Line in can be retasked as microphone), 1 PS/2 mouse port, 1 PS/2 keyboard port, 1 Rear power button Optional: 1 serial port (cable up to rear bulkhead) | | | | |
| Interfaces Supported | SD card reader (optional) 6-channel SATA interface (6 @ 6.0 Gb/s) 6 channels are eSATA configurable for use with eSATA CTO/AMO Kit (No hot plug / hot swap supported) | | | | |



Overview

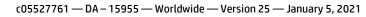
USB 2.0, USB 3.1 G1 (aka USB 3.0), USB 3.1 G2 (optional) **On-board RAID Support** SATA RAID 0 Striped Array SATA RAID 1 Mirrored Arrav SATA RAID 5 Striped/Parity SATA RAID 10 Striped/Mirrored H: 17.5" (445mm) Chassis Dimensions (H x W x D) W: 6.65" (169mm) D: 18.3" (465mm) H: 24" (610mm) **Packaged Dimensions** W: 12.3" (313mm) D: 23.3" (593mm) **Rack Dimensions** 4U Weight Exact weights depend upon configuration (System weight only). Minimum: 13.1 kg (29 lbs.) Standard: 13.6 kg (30.1 lbs.) Maximum: 23.9 kg (52.7 lbs.) Temperature Operating: 5° to 35°C (40° to 95°F) Non-operating: -40° to 60°C (-40° to 140°F) Note: Above 1524 m (5,000 feet) altitude, maximum operating temperature is reduced by 1° C (1.8° F) per 305 m (1.000 feet) elevation increase Humidity Operating: 10% to 85% relative humidity, non-condensing, 35° C maximum wet bulb Non-operating: 10% to 90% relative humidity, non-condensing, 35° C maximum wet bulb Maximum Altitude (non- Operating: 3,048m (10,000ft) pressurized) Non-operating: 9,144m (30,000ft) **Note:** Above 1524 m (5,000 feet) altitude, maximum operating temperature is reduced by 1° C (1.8° F) per 305 m (1,000 feet) elevation increase **Power Supply** 1000 watts wide-ranging, active Power Factor Correction, 90% Efficient, with 2X 6-pin graphics power cables (graphics power cables are 6/8-pin convertible) The Z6 G4 1000W power supply efficiency report can be found at this link: https://plugloadsolutions.com/psu_reports/HP_D15-1K0P1A_1000W_ECOS%204838_Report.pdf Workstation ISV See the latest list of certifications at Certifications http://www8.hp.com/us/en/campaigns/workstations/industries-and-partners.html



Supported Components

| - | |
|------------|--|
| Processors | |

| | Factory Configured | Option Kit | Option Kit Part Number ¹ | Support Notes |
|---|-----------------------|---------------|---|------------------|
| Intel® Xeon® W-3200 Series CPU | | | | |
| Intel® Xeon® W-3245 3.2 2933 16C processor | Y | Ν | | |
| Intel® Xeon® W-3235 3.3 2933 12C processor | Y | Ν | | |
| Intel® Xeon® W-3225 3.7 2666 8C processor | Y | Ν | | |
| Intel® Xeon® W-3223 3.5 2666 8C processor | Y | Ν | | |
| Intel® Xeon® Scalable CPU | | | | |
| Intel® Xeon® Platinum 8280 processor | Y | Ν | | 1 |
| Intel® Xeon® Platinum 8260 processor | Y | Ν | | 1 |
| Intel® Xeon® Gold 6258R processor | Y | Ν | | |
| Intel® Xeon® Gold 6254 processor | Y | Ν | | 1 |
| Intel [®] Xeon [®] Gold 6252 processor | Y | Y | 5YT07AA | 1 |
| Intel [®] Xeon [®] Gold 6248R processor | Y | Ν | | |
| Intel [®] Xeon [®] Gold 6248 processor | Y | Y | 5YT06AA | 1 |
| Intel® Xeon® Gold 6246R processor | Y | Ν | | |
| Intel® Xeon® Gold 6244 processor | Y | Y | 5YT05AA | 1 |
| Intel [®] Xeon [®] Gold 6242R processor | Y | Ν | | 1 |
| Intel [®] Xeon [®] Gold 6242 processor | Y | Y | 5YT04AA | 1 |
| Intel [®] Xeon [®] Gold 6240R processor | Y | Ν | | 1 |
| Intel [®] Xeon [®] Gold 6240Y processor | Y | | 5YT03AA | 1 |
| Intel [®] Xeon [®] Gold 6240 processor | Y | Y | 5YT02AA | 1 |
| Intel [®] Xeon [®] Gold 6238R processor | Y | Ν | | 1 |
| Intel [®] Xeon [®] Gold 6238 processor | Y | Y | 5YT01AA | 1 |
| Intel [®] Xeon [®] Gold 6234 processor | Y | Y | 5YTOOAA | 1 |
| Intel® Xeon® Gold 6230R processor | Y | Y | 9VA87AA | 1 |
| Intel [®] Xeon [®] Gold 6230 processor | Y | Y | 5YS99AA | 1 |
| Intel® Xeon® Gold 6226R processor | Y | Y | 9VA85AA | 1 |
| Intel® Xeon® Gold 6226 processor | Y | Y | 5YS98AA | 1 |
| Intel [®] Xeon [®] Gold 6154 processor | Y | Ν | | |
| Intel [®] Xeon [®] Gold 6136 processor | Y | Y | 1XM39AA | |
| Intel [®] Xeon [®] Gold 6134 processor | Y | Y | 1XM41AA | |
| Intel [®] Xeon [®] Gold 6132 processor | Y | Y | 1XM42AA | |
| Intel [®] Xeon [®] Gold 6128 processor | Y | Y | 1XM44AA | |
| Intel [®] Xeon [®] Gold 5222 processor | Y | Y | 5YS97AA | 1 |
| Intel [®] Xeon [®] Gold 5220R processor | Y | Y | 8BC99AA/AT | 1 |
| Intel [®] Xeon [®] Gold 5220 processor | Y | Y | 5YS96AA | 1 |
| Intel [®] Xeon [®] Gold 5218R processor | Y | Y | 9VA83AA | 1 |
| Intel [®] Xeon [®] Gold 5218 processor | Y | Y | 5YS95AA | 1 |
| Intel [®] Xeon [®] Gold 5215 processor | Y | Y | 5YS94AA | 1 |
| Intel [®] Xeon [®] Gold 5118 processor | Y | Y | 1XM45AA | |
| Intel [®] Xeon [®] Gold 4216 processor | Y | Y | 5YS93AA | |
| Intel [®] Xeon [®] Gold 4215R processor | Y | Y | 9VA81AA | |
| Intel [®] Xeon [®] Gold 4215 processor | Y | Y | 5YS92AA | 1 |
| | | | | |





1

Supported Components

| Intel [®] Xeon [®] Gold 4214R processor | Y | Y | 8BC96AA/AT | |
|---|---|---|------------|--|
| Intel [®] Xeon [®] Gold 4214Y processor | Y | Y | 5ZB33AA | |
| Intel [®] Xeon [®] Gold 4214 processor | Y | Y | 5YS91AA | |
| Intel [®] Xeon [®] Gold 4210R processor | Y | Y | 8BC95AA | |
| Intel [®] Xeon [®] Gold 4210 processor | Y | Y | 5YS90AA | |
| Intel [®] Xeon [®] Gold 4208 processor | Y | Y | 5YS89AA | |
| Intel [®] Xeon [®] Silver 4114 processor | Y | Y | 1XM49AA | |
| Intel [®] Xeon [®] Silver 4112 processor | Y | Y | 1XM50AA | |
| Intel [®] Xeon [®] Silver 4108 processor | Y | Y | 1XM51AA | |
| Intel [®] Xeon [®] Bronze 3206R processor | Y | Y | 8BC93AA | |
| Intel [®] Xeon [®] Bronze 3204 processor | Y | Y | 5YS88AA | |
| Intel [®] Xeon [®] Bronze 3106 processor | Y | Y | 1XM52AA | |
| | | | | |

¹ Options kits available for second processor upgrade.

Disclaimers: When ordering two processors, the second processor must be the same as the first. Intel processor numbers are not a measurement of higher performance. Processor numbers differentiate features within each processor family, not across different processor families.

Note 1: Intel® DCPMM® (Data Center Persistent Memory) Supported.

| Monitors / Displays | | Factory Configured | Option Kit | Option Kit Part Number | Support Notes |
|------------------------|--|-----------------------|---------------|------------------------------|------------------|
| | HP Z Display Z22n G2 | | Y | 1JS05AA | |
| | HP Z Display Z23n G2 | | Y | 1JS06AA | |
| | HP Z Display Z24i G2 | | Y | 1JS08AA | |
| | HP Z Display Z24n G2 | | Y | 1JS09AA | |
| | HP Z Display Z24nf G2 | | Y | 1JS07AA | |
| | HP Z Display Z27n G2 | | Y | 1JS10AA | |
| | HP Z Display Z27s (4K display) | | Y | J3G07AA | |
| | Supported by all operating systems available from HP Screen size measured diagonally | | | | |

Storage / Hard Drives

| SAS Hard Drives SAS Hard Drives for HP Workstations | | Factory Configured | Option Kit | Option Kit Part Number | Support Notes |
|--|---|-----------------------|---------------|------------------------------|------------------|
| | HP 300GB 15k SAS SFF | Y | Y | L5B74AA | |
| | NOTE: SAS controller add-in card required | | | | |



Supported Components

SATA Hard Drives

| | Factory Configured | Option Kit | Option Kit Part Number | Support Notes |
|--|-----------------------|------------|------------------------------|------------------|
| SATA (Serial ATA) Hard Drives for HP Workstations | | | | |
| 500GB SATA 7200RPM 6Gb/s 3.5" HDD | Y | Y | LQ036AA | |
| 500GB SATA 7200RPM 6Gb/s OPAL2 SFF 3.5" HDD | Y | Y | D8N29AA | |
| 1TB SATA 7200RPM 3.5" HDD | Y | Y | LQ037AA | |
| 1TB SATA 7200RPM Ent 3.5" HDD | Y | Y | WOR10AA | |
| 2TB SATA 7200RPM HDD | Y | Y | QB576AA | |
| 2TB 7200RPM SATA 3.5in Enterprise | Y | Y | 2Z274AA | |
| 4TB SATA 7200RPM Ent 3.5" HDD | Y | Y | K4T76AA | |
| 6TB SATA 7200RPM Ent 3.5" HDD | Y | Y | 3DH90AA | |
| 8TB 7200RPM SATA 3.5in Enterprise | Y | Y | 2Z273AA | |
| NOTES: | | | | |
| Up to (4) 2 5 in th 7200 years CATA drivery 500 CB 1 0 2 | 0. 4.0 TD | | | |

Up to (4) 3.5-inch 7200 rpm SATA drives: 500 GB, 1.0, 2.0, 4.0 TB; maximum system HDD storage: 16.0TB



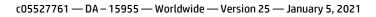
Ontion

Supported Components

SATA Solid State Drives

| | | | υριισπ | |
|---|-----------------------|---------------|--------------------|------------------|
| | Factory Configured | Option Kit | Kit Part Number | Support Notes |
| HP Solid State Drives (SSDs) for Workstations | | | | |
| HP 256GB SATA SSD | Y | Y | A3D26AA | |
| HP 512GB SATA SSD | Y | Y | D8F30AA | |
| HP 1TB SATA SSD | Y | Y | F3C96AA | |
| HP 2TB SATA SSD | Y | Y | Y6P08AA/AT | |
| HP 256GB SATA SED OPAL2 SSD | Y | Y | G7U67AA | |
| HP 512GB SATA SED OPAL2 SSD | Y | Y | N8T26AA | |
| HP 240GB SATA Enterprise SSD | Y | Y | T3U07AA | |
| HP 480GB SATA Enterprise SSD | Y | Y | T3U08AA | |
| HP 960GB 2.5in Enterprise SATA-3 SSD | Y | Y | 1W6P8AA | |
| 1920GB 2.5in Enterprise SATA-3 SSD | Y | Y | 1W6P9AA | |
| | | | | |

PCIe Solid State Drives Option **Kit Part** Factory Option Support Configured Kit Number Notes PCIe SSDs for HP Workstations HP Z Turbo Drive 256GB MLC Z4/Z6 G4 SSD Kit Y Y 1PD56AA 4 Y Υ HP Z Turbo Drive 512GB MLC Z4/Z6 G4 SSD Kit 1PD57AA/AT 4 HP Z Turbo Drive 1TB MLC Z4/Z6 G4 SSD Kit Y Y 1PD58AA 4 Y Y HP Z Turbo Drive 256GB TLC Z4/Z6 G4 SSD Kit 1PD59AA/AT HP Z Turbo Drive 512GB TLC Z4/Z6 G4 SSD Kit γ γ 1PD60AA Y Y HP Z Turbo Drive 1TB TLC Z4/Z6 G4 SSD Kit 1PD61AA HP Z Turbo Drive 2TB TLC Z4/Z6 G4 SSD Kit Y γ **3KP39AA** HP Z Turbo Drive 256GB Z4/Z6 G4 SED Kit Ν Ν EOL 4 HP Z Turbo Drive 512GB Z4/Z6 G4 SED Kit 4 Ν Ν EOL HP Z Turbo Drive 1TB TLC Z4/Z6 G4 SED Kit Y Υ 6YT76AA HP Z Turbo Drive 1TB TLC Z4/Z6 G4 SED Module γ γ **6YT79AA** Υ HP Z Turbo 2TB SED OPAL2 TLC M.2 Z4/Z6 SSD Υ 2Y7W6AA HP 256GB M.2 2280 PCIe NVMe TLC SSD Z2/Z4/Z6 Kit Υ Y 8PE68AA 3 HP 512GB M.2 2280 PCIe NVMe TLC SSD Z2/Z4/Z6 Kit γ γ 8PE69AA 3 Y Υ HP 1TB M.2 2280 PCIe NVMe TLC SSD Z2/Z4/Z6 Kit 8PE70AA 3 HP 256GB M.2 2280 PCIe NVMe TLC SSD Module Ν Υ 8PE62AA 2 HP 512GB M.2 2280 PCIe NVMe TLC SSD Module γ 2 Ν 8PE63AA γ HP 1TB M.2 2280 PCIe NVMe TLC SSD Z2 Module Ν 8PE64AA 2 HP 2TB PCIe NVME TLC M.2 Z4/6 G4 SSD Y Υ 35F74AA **HP Z Turbo Drive Dual Pro** HP Z Turbo Drive Dual Pro 256GB TLC SSD Υ Y 4YF60AA 3 HP Z Turbo Drive Dual Pro 512GB TLC SSD γ Υ 4YF61AA 3 HP Z Turbo Drive Dual Pro 1TB TLC SSD γ γ 4YF62AA 3





Supported Components

| HP Z Turbo Drive Dual Pro 2TB TLC SSD | Y | Y | 4YF63AA | 3 |
|--|---|---|---------|---|
| HP 256GB M.2 2280 PCIe NVMe TLC SSD Dual Pro Kit | Y | Y | 8PE74AA | 3 |
| HP 512GB M.2 2280 PCIe NVMe TLC SSD Dual Pro Kit | Y | Y | 8PE75AA | 3 |
| HP 1TB M.2 2280 PCIe NVMe TLC SSD Dual Pro Kit | Y | Y | 8PE76AA | 3 |
| HP Z Turbo Drive Quad Pro | | | | |
| HP Z Turbo Drive Quad Pro 2x256GB PCIe TLC SSD | Y | Y | 4YZ38AA | 1 |
| HP Z Turbo Drive Quad Pro 2x512GB PCIe TLC SSD | Y | Y | 4YZ39AA | 1 |
| HP Z Turbo Drive Quad Pro 2x1TB PCIe TLC SSD | Y | Y | 4YZ40AA | 1 |
| HP Z Turbo Drive Quad Pro 2x2TB PCIe TLC SSD | Y | Y | 3KP42AA | |
| HP Z Turbo Drive Quad Pro 256GB SSD module | Ν | Y | N2N00AA | 2 |
| HP Z Turbo Drive Quad Pro 512GB SSD module | Ν | Y | N2N01AA | 2 |
| HP Z Turbo Drive Quad Pro 1TB SSD module | Ν | Y | T9J00AA | 2 |
| HP Z Turbo Drive Quad Pro 2TB SSD module | Ν | Y | ЗКР4ЗАА | |
| Intel® 905p Series SSD (Opatane SSD) | | | | |
| Intel® Optane SSD 905p 280GB AiC** | Y | Y | 2SC47AA | |
| Intel® Optane SSD 905p 480GB AiC** | Y | Y | 2SC48AA | |
| Intel® Optane SSD 905p 380GB M.2 SSD Module | Y | Y | 6LA66AA | |
| | | | | |

Note 1: Dual M.2 SSD modules plus carrier and heat sink Note 2: M.2 SSD module only, for Quad Pro or Dual Pro carrier Note 3: Single M.2 SSD module plus dual carrier and heat sink Note 4: These M.2 SSD kits and module are End of Life and no longer available. ** PCIe card installed in standard PCIe x4 slot

| Hard Drive Controllers | 5 | Factory Configured | Option Kit | Option Kit Part Number | Support Notes |
|------------------------|--|-----------------------|---------------|------------------------------|------------------|
| | SAS Controller | | | | |
| | MicroSemi SmartHBA2100-4i4e SAS Controller | Y | Y | 1FV90AA | |

Graphics

| | Factory Configured | Option Kit | Option Kit Part Number | Support Notes | Supported # of cards |
|---|-----------------------|---------------|---------------------------|------------------|-------------------------|
| Graphics Cable Adapters | | | | | |
| HP DisplayPort to VGA Adapter | Y | Y | AS615AA | | |
| HP DisplayPort to HDMI Adapter | Y | Y | K2K92AA | | |
| HP DisplayPort to Dual Link DVI Adapter | Y | Y | NR078AA | | 1 |
| HP DisplayPort to DVI-D Adapter | Y | Y | FH973AA | | 1 |
| HP DisplayPort to DVI-D Adapter (2-pack) | Y | Ν | | | 1 |
| HP DisplayPort to DVI-D Adapter (4-pack) | Y | Ν | | | 1 |
| HP DisplayPort to DVI-D Adapter (6-pack) | Y | Ν | | | 1 |
| NVIDIA [®] SLI 3-slot Graphics Connector | Y | Y | 2YY85AA | | 1 |
| Entry 3D | | | | | |



Supported Components

| NVIDIA [®] Quadro [®] P400 2GB Graphics | Y | Y | 1ME43AA | 2 |
|---|---|---|------------|---|
| NVIDIA [®] Quadro [®] P620 2GB Graphics | Y | Y | 3ME25AA | 2 |
| AMD FirePro™ W2100 2GB Graphics | Y | Y | J3G91AA | 2 |
| Mid-range 3D | | | | |
| NVIDIA [®] Quadro [®] P1000 4GB Graphics | Y | Y | 1ME01AA | 3 |
| NVIDIA [®] Quadro [®] P2000 5GB Graphics | Y | Y | 1ME41AA | 2 |
| NVIDIA [®] Quadro [®] P2200 5GB Graphics | Y | Y | 6YT67AA | 2 |
| AMD Radeon™ Pro WX 3100 4GB Graphics | Y | Y | 2TF08AA | 2 |
| AMD Radeon™ Pro WX 3200 4GB Graphics | Y | Y | 6YT68AA | 2 |
| AMD Radeon™ Pro WX 4100 4GB Graphics | Y | Y | ZOB15AA | 2 |
| High End 3D | | | | |
| NVIDIA [®] Quadro [®] P4000 8GB Graphics | Y | Y | 1ME40AA | 2 |
| NVIDIA [®] Quadro RTX 4000 8GB Graphics | Y | Y | 5JV89AA | 2 |
| AMD Radeon™ Pro W5500 8GB 4DP GFX | Y | Y | 9GC16AA/AT | 2 |
| AMD Radeon™ Pro W5700 8GB 5mDP+USBc GFX | Y | Y | 9GC15AA/AT | 1 |
| AMD Radeon™ Pro WX 7100 8GB Graphics | Y | Y | ZOB14AA | 2 |
| Ultra High-End 3D | | | | |
| NVIDIA [®] Quadro [®] GP100 16GB Graphics | Y | | 1ZE81AA | 1 |
| NVIDIA [®] Quadro [®] P5000 16GB Graphics | Y | Y | ZOB13AA | 2 |
| NVIDIA [®] Quadro [®] P6000 24GB Graphics | Y | Y | ZOB12AA | 1 |
| NVIDIA [®] Quadro RTX 5000 16GB Graphics | Y | Y | 5JH81AA | 1 |
| NVIDIA [®] Quadro RTX 6000 24GB Graphics | Y | Y | 5JH80AA | 1 |
| NVIDIA [®] Quadro RTX 8000 48GB Graphics | Y | Y | 6NB51AA | 1 |
| AMD Radeon™ Pro WX 9100 16GB Graphics | Y | Y | 2TF01AA | 1 |
| NVIDIA® Quadro® Sync II | Y | Y | 1WT20AA | |

| Memory | СТО | Factory Configured | Option Kit | Option Kit Part Number | Support Notes |
|--------|--|-----------------------|---------------|---------------------------|------------------|
| | DDR4-2666 ECC Registered DIMMs | | | | |
| | 8GB (1x8GB) DDR4-2666 ECC Reg Memory | Y | Y | 1XD84AA | 1 |
| | 16GB (1x16GB) DDR4-2666 ECC Reg Memory | Ν | Y | 1XD85AA | 1 |
| | 32GB (1x32GB) DDR4-2666 ECC Reg Memory | Ν | Y | 1XD86AA | 1 |
| | DDR4-2933 ECC Registered DIMMs | | | | |
| | 8GB (1x8GB) DDR4-2933 ECC Reg Memory | Y | Y | 5YZ56AA | 1 |
| | 16GB (1x16GB) DDR4-2933 ECC Reg Memory | Ν | Y | 5YZ54AA | 1 |
| | 32GB (1x32GB) DDR4-2933 ECC Reg Memory | Ν | Y | 5YZ55AA | 1 |
| | 64GB (1x64GB) DDR4-2399 ECC Reg Memory | Ν | Y | 5YZ57AA | 1 |

NOTE 1: For details on the supported memory configurations on the HP Z6 G4 Workstation, please refer to the System Technical Specifications - System Board section of this document.

Each processor supports up to 6 channels of DDR4 memory. To realize full performance at least 1 DIMM must be inserted into each channel.

Supported Components

With single-processor configurations, 6 DIMM slots are available. 6 additional DIMM slots are available with the 2nd CPU & Memory Module.

The CPUs determine the speed at which the memory is clocked. If a 2400MT/s capable CPU is used in the system, the maximum speed the memory will run at is 2400MT/s, regardless of the specified speed of the memory.

The Z6 G4 is designed to work ONLY with DDR4 memory. The system will not work with DDR3 memory.

NOTE 2: Z6 G4 configurations that include a 2nd CPU require the HP Z6 Memory Cooling Solution, which is available both CTO (2JA81AV) and AMO (2HW44AA). Z6 G4 configurations that include greater than 32GB total system memory require the HP Z6 Memory Cooling Solution, which is available both CTO (2JA81AV) and AMO (2HW44AA).

NOTE: Factory-configured CTO (xxxxAV) and aftermarket AMO (xxxxAA, xxxxAT) HP memory part numbers designated as "2666" may ship with "2933" or "3200" speed memory components. Similarly, HP Memory part numbers designated as "2933" may ship with "3200" speed memory. This does not affect HP part number availability, nor does it affect system performance or operation. All hardware configurations currently supporting HP memory part numbers designated as "2666" or 2933 have been fully qualified to work with fast speed memory and are fully supported by HP under standard support terms.

| NVDIMM Memory | | Factory Configured | Option Kit | Option Kit Part Number | Support Notes |
|---------------|--|-----------------------|---------------|---------------------------|------------------|
| | Intel® Optane™ DC Persistent Memory (DCPMM) | | | | |
| | 128GB (1x128GB) DC Persistent Memory Module | Y | Y | 9NH78AA | 1 |
| | 256GB (2x128GB) DC Persistent Memory Configuration | Y | Ν | | 1 |
| | 512GB (4x128GB) DC Persistent Memory Configuration | Y | Ν | | 1,2 |

NOTE 1: Supported only with Xeon 82xx, 62xx, 52xx and 4215/4215R processors.

- a. Available as factory configured in Memory Mode or Storage Mode.
- b. Systems configured with DCPMM memory will operate the memory subsystem at 2666 MT/s.
- c. Operating System Support:
 - i. Windows 10 Pro for Workstations v1903 or later with all updates applied.
 - ii. Linux OS support may be found in the Linux Hardware Support Matrix.
- d. Detailed setup, security and support information may be found in the Intel[®] Optane[™] DC Persistent Memory: Configuration and Setup on HP Z6 G4 and Z8 G4 Workstation white paper.
- DCPMM solutions require additional DRAM memory to be included in the solution:
 Systems configured with DCPMM in Memory Mode will include DRAM memory to be used as cache.
 - The amount of included DRAM memory is based on an 8:1 DCPMM to DRAM capacity ratio. ii. Systems configured with DCPMM in Storage Mode will require DRAM System Memory to be
 - II. Systems configured with DCPMM in Storage Mode will require DRAM System Memory to be ordered separately.
 - iii. DCPMM Memory will report approximately 2% less than advertised capacity .
- f. Total Memory (DCPMM + DRAM) per processor must be <= 1TB or 2TB per dual processor system.
 i. When configured in memory mode, additional DRAM does not count against maximum processor memory.
- g. Maximum number of DCPMM modules in a Z6G4 is 4 per processor.
- h. Customer is responsible for additional required DRAM when adding DCPMM modules in Memory Mode.
- i. HP Z6G4 configured with some AMD Graphics are limited to 1TB of total DCPMM and DRAM memory. See AMD Graphics specifications for details.

NOTE 2: Requires 2nd processor option.

Multimedia and Audio Devices



HP Z6 G4 Workstation

Supported Components

Multimedia and Audio Devices

| | Factory Configured | Option Kit | Option Kit Part Number | Support Notes | |
|------------------------------------|-----------------------|---------------|------------------------------|------------------|--|
| Integrated Realtek HD ALC221 Audio | Y | Ν | | | |

Optical and Removable Storage

| | Factory Configured | Option Kit | Option Kit Part Number | Support Notes |
|--|-----------------------|------------|---------------------------|------------------|
| HP SlimTray Optical Drives | | | | |
| HP 9.5mm Slim Blu Ray Disc Writer | Y | Y | K3R65AA | |
| HP 9.5mm Slim DVD ROM | Y | Y | K3R63AA | |
| HP 9.5mm Slim DVD Writer | Y | Y | K3R64AA | |
| HP Half Height Optical Drives | | | | |
| HP HH DVD Writer (16X RW DVD-R) | Ν | Y | 4AR67AA | |
| HP SD Card Reader | | | | |
| HP SD 4 Card Reader | Y | Y | YOL99AA | |
| HDD Frame/Carriers | | | | |
| HP DX175 Removable HDD Carrier | Ν | Y | 1ZX72AA | |
| HP DX175 Removable HDD Frame/Carrier | Ν | Y | 1ZX71AA | |
| NVMe Frame/Carrier | | | | |
| HP QX310 Removable NVMe Frame/Carrier w/PCIe card | Y | Ν | 8GQ89AA/AT | |
| HP QX310 Removable Carrier only | Ν | Y | 8GQ91AA/AT | |
| | | | | |

Actual speeds may vary. No support for DVD-RAM (DVD Writer). Does not permit copying of commercially available DVD movies or other copyright protected materials. Intended for creation and storage of your original material and other lawful uses. Double Layer discs can store more data than single layer discs. However, double-layer discs burned with this drive may not be compatible with many existing single-layer DVD drives and players.

With Blu-ray, certain disc, digital connection, compatibility and/or performance issues may arise, and do not constitute defects in the product. Flawless playback on all systems is not guaranteed. In order for some Blu-ray titles to play, they may require a DVI or HDMI digital connection and your display may require HDCP support. HD-DVD movies cannot be played on this workstation.

Option **Kit Part** Factory Option Configured Kit Number Support Notes HP i350-T2 PCIe Dual Port Gigabit NIC Υ Υ V4A91AA Intel[®] i350-T4 PCIe 4-Port Gigabit NIC γ W8X25AA Ν Intel® Ethernet I210-T1 PCIe x1 Gb NIC Υ Υ E0X95AA Aquantia® NBASE-T 5GbE PCIe NIC Ν Υ 1PM63AA Υ γ HP Dual Port 10GBase-T NIC Module 10L49AA Intel[®] 8265 802.11 a/b/g/n/ac + BT PCIe WLAN Ν Υ 1QL48AA

Networking and Communications



Supported Components

| Intel® X550-T2 10GbE Dual Port NIC | Y | Y | 1QL46AA | |
|---|---|---|---------|---|
| Intel® X710-DA2 10GbE SFP+ Dual Port NIC | Y | Y | 1QL47AA | 1 |
| HP 10GbE SFP+ SR Transceiver | Y | Y | C3N53AA | |
| Intel® Wi-Fi 6 AX200 & BT PCIe | Ν | Y | 7CE01AA | 1 |
| Allied Telesis AT-2914SX/LC-901 1GB LC Fiber NIC Note 1: Windows 7 is NOT supported | Y | Y | 1C7Q2AA | |

Racking and Physical Security



Supported Components

Racking and Physical Security

| | Factory Configured | Option Kit | Option Kit Part Number | Support Notes |
|--|-----------------------|---------------|------------------------------|------------------|
| HP Z4/Z6 Side Panel Barrel Keylock | Y | Ν | | |
| HP Solenoid Lock / Hood Sensor | Y | Ν | | |
| HP Z4/Z6 Depth Adjustable Fixed Rail Rack Kit | Ν | Y | 2HW42AA | |
| HP Z2 Mini/Z2 TWR/Z4/Z6 Dept Adj Fixed Rail Rack Kit | | Y | 2A8Y5AA | |
| HP Keyed Cable Lock 10mm | Ν | Y | T1A62AA | |

Input Devices

| | Factory Configured | Option Kit | Option Kit Part Number | Support Notes |
|--|-----------------------|---------------|------------------------------|------------------|
| HP Wireless Business Slim Keyboard and Mouse | Y | Y | N3R88AA | |
| Business Slim PS/2 Wired Keyboard | Y | Y | N3R86AA | |
| USB Business Slim Wired Keyboard | Y | Y | N3R87AA | |
| USB Premium Wired Keyboard | Y | Y | Z9N40AA | |
| USB Wired SmartCard CCID Keyboard | Y | Y | E6D77AA | |
| 3Dconnexion CADMouse | Ν | Y | M5C35AA | |
| 3DConnexion 3 Button Wired CAD Mouse Pro | Ν | Y | 2H5H5AA | |
| HP Optical USB Mouse | Y | Y | QY777AA | |
| HP PS/2 Mouse | Y | Y | QY775AA | |
| HP USB Hardened Mouse | Y | Y | P1N77AA | |

Other Hardware

| | Factory Configured | Option Kit | Option Kit Part Number | Support Notes |
|---|-----------------------|------------|------------------------------|---------------|
| HP ENERGY STAR [®] Certified Configuration | Y | | | |
| HP Z Premium Front I/O 2xUSB-A 2xUSB-C | Y | Y | 1XM32AA | |
| HP Z6 G4 Memory Cooling Solution | Y | Y | 2HW44AA | Note 1 |
| HP Internal USB Port Kit | Ν | Y | EM165AA | Note 2 |
| HP eSATA 2 port PCI Bulkhead Kit | Y | Y | GM110AA | |
| HP Serial Port Adapter | Y | Y | PA716A | |
| HP Workstation Mouse Pad | Y | | | |

Note 1: Z6 G4 configurations that include a 2nd CPU require the HP Z6 Memory Cooling Solution, which is available both CTO (2JA81AV) and AMO (2HW44AA). Z6 G4 configurations that include greater than 32GB total system memory require the HP Z6 Memory Cooling Solution, which is available both CTO (2JA81AV) and AMO (2HW44AA).

Note 2: The HP Internal USB Port kit has a single USB 2.0 type A connector.



Supported Components

| Software | | Factory Configured | | Option Kit Part Number | Support Notes |
|----------|------------------------|-----------------------|---|------------------------------|---------------|
| | Sobey Video Editing SW | Y | Ν | | |
| | SW HP RGS for Z | Y | Ν | | |
| | HP Sure Start Gen3 | Y | Ν | | |
| | HP Performance Advisor | Y | Ν | | |



Supported Components

Operating Systems

HP Z6 G4 Workstation

| S | | Support Notes |
|---|--|---------------|
| | Windows 10 Pro | |
| | Windows 7 Professional 64-bit | |
| | Ubuntu 20.04 LTS | |
| | HP Linux [®] Installer Kit | Note 2 |
| | Red Hat® Enterprise Linux® (RHEL) Workstation - Paper License (1yr) | Note 1 |
| | NOTE 1 : This second OS must be ordered with the HP Linux [®] Installer Kit as the first (| DS. |
| | NOTE 2 : For detailed Linux [®] OS/hardware support information, see: http://www.hp.com/support/linux_hardware_matrix | |
| | For datailed Windows 7 OS hardware support information see | |

For detailed Windows 7 OS hardware support information see http://h10032.www1.hp.com/ctg/Manual/c05857891.pdf. Intel Xeon® SP Processors: Platinum 8100, Gold 6100, Gold 5100, Silver 4100, & Bronze 3100 Family support Microsoft Windows 7 Professional 64-bit.



System Technical Specifications

System Board

| System Board Form Factor | Main System Board: 24 x 31 cm 9.6 x 12.2 inches |
|-----------------------------|---|
| | 2nd CPU/Memory Board (optional): |
| | 14.9 x 29.2 cm |
| | 5.85 x 11.50 inches |
| Processor Socket | FCLGA3647 (Socket P) |
| | 1st CPU on system board |
| | 2nd CPU on optional 2nd CPU/Memory Module |
| CPU Bus Speed | UPI: Up to 10.4GT/second, depending on processor |
| Chipset | Intel® C622 Chipset |
| Super I/O Controller | Nuvoton SIO15 |
| Memory Expansion Slots | 6 on system board (CPUO) + 6 on optional 2nd CPU/Memory Module (CPU1) |
| Memory Type Supported | DDR4 R-DIMM (Registered), ECC: 8GB, 16GB, 32GB, and 64GB |
| Memory Modes | NUMA (Non-Uniform Memory Architecture), Memory Node Interleave |
| Memory Speed Supported | 2133MT/s, 2400MHz, 2666MT/s, and 2933MT/s |

Available Memory Configurations:

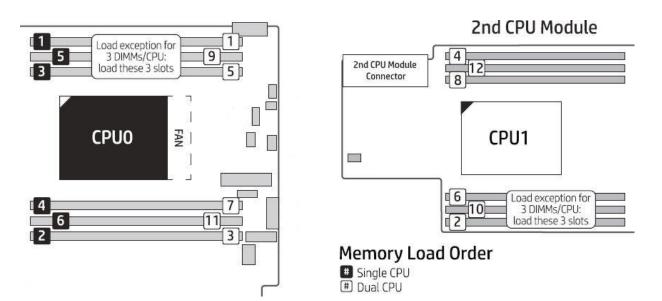
| | | | Single P | ocessor | | | | | |
|----------|------------------------|-------|----------|---------|-------|-------|----------------|--|--|
| | | | CP | U O | | | | | |
| | Top Slots Bottom Slots | | | | | | | | |
| Capacity | DIMM1 | DIMM2 | DIMM3 | DIMM4 | DIMM5 | DIMM6 | Perf Rating | | |
| 8 GB | 8 GB | | | | | | Fair | | |
| 16 GB | 8 GB | | | | | 8 GB | Good | | |
| 24 GB | 8 GB | 8 GB | 8 GB | | | | Better | | |
| 32 GB | 8 GB | | 8 GB | 8 GB | | 8 GB | Better | | |
| 32 UD | 16 GB | | | | | 16 GB | Good | | |
| 48 GB | 8 GB | 8 GB | 8 GB | 8 GB | 8 GB | 8 GB | Best | | |
| 40 GD | 16 GB | 16 GB | 16 GB | | | | Better | | |
| 64 GB | 16 GB | | 16 GB | 16 GB | | 16 GB | Better | | |
| 04 UD | 32 GB | | | | | 32 GB | Good | | |
| 96 GB | 16 GB | 16 GB | 16 GB | 16 GB | 16 GB | 16 GB | Best | | |
| 90 GB | 32 GB | 32 GB | 32 GB | | | | Better | | |
| 128 GB | 32 GB | | 32 GB | 32 GB | | 32 GB | Better | | |
| 192 GB | 32 GB | 32 GB | 32 GB | 32 GB | 32 GB | 32 GB | Best | | |
| 256 GB | 64 GB | | 64 GB | 64 GB | | 64 GB | Better | | |
| 384 GB | 64 GB | 64 GB | 64 GB | 64 GB | 64 GB | 64 GB | Best | | |

| | | | | | | Dual Pr | ocessor | | | | | | |
|----------|-----------|-----------|-----------|-----------|-----------|-----------|-----------|-----------|-----------|-----------|-----------|-----------|--------|
| | | | CP | U 0 | | | | | CP | U 1 | | | |
| | T | op Slot | S | Bo | ttom Sl | ots | ٦ | 'op Slot | S | Bo | ttom Sl | ots | |
| Capacity | DIMM 1 | DIMM 2 | DIMM 3 | DIMM 4 | DIMM 5 | DIMM 6 | DIMM 1 | DIMM 2 | DIMM 3 | DIMM 4 | DIMM 5 | DIMM 6 | Rating |
| 16 GB | 8 GB | | | | | | 8 GB | | | | | | Fair |
| 32 GB | 8 GB | | | | | 8 GB | 8 GB | | | | | 8 GB | Good |
| 48 GB | 8 GB | 8 GB | 8 GB | | | | 8 GB | 8 GB | 8 GB | | | | Better |
| 64 C P | 8 GB | | 8 GB | Better |
| 64 GB | 16 GB | | | | | 16 GB | 16 GB | | | | | 16 GB | Good |
| 06 C B | 8 GB | Best |
| 96 GB | 16 GB | 16 GB | 16 GB | | | | 16 GB | 16 GB | 16 GB | | | | Better |
| 128 GB | 16 GB | | 16 GB | 16 GB | | 16 GB | 16 GB | | 16 GB | 16 GB | | 16 GB | Better |
| 120 UD | 32 GB | | | | | 32 GB | 32 GB | | | | | 32 GB | Good |
| 192 GB | 16 GB | 16 GB | 16 GB | 16 GB | 16 GB | 16 GB | 16 GB | 16 GB | 16 GB | 16 GB | 16 GB | 16 GB | Best |
| 192 UD | 32 GB | 32 GB | 32 GB | | | | 32 GB | 32 GB | 32 GB | | | | Better |
| 256 GB | 32 GB | | 32 GB | 32 GB | | 32 GB | 32 GB | | 32 GB | 32 GB | | 32 GB | Better |
| 230 UD | 64 GB | | | | | 64 GB | 64 GB | | | | | 64 GB | Best |
| 384 GB | 32 GB | 32 GB | 32 GB | 32 GB | 32 GB | 32 GB | 32 GB | 32 GB | 32 GB | 32 GB | 32 GB | 32 GB | Better |
| 384 UB | 64 GB | 64 GB | 64 GB | | | | 64 GB | 64 GB | 64 GB | | | | Best |
| 512 GB | 64 GB | | 64 GB | 64 GB | | 64 GB | 64 GB | | 64 GB | 64 GB | | 64 GB | Fair |
| 768 GB | 64 GB | 64 GB | 64 GB | 64 GB | 64 GB | 64 GB | 64 GB | 64 GB | 64 GB | 64 GB | 64 GB | 64 GB | Good |

System Technical Specifications

Memory Loading Order:

Load Order for Single and Dual Processor Configuration



Supports up to 768 GB DDR4-2933 ECC RAM* (transfer rates up to 2933MT/s) and 384 GB DDR4-2666 ECC **Maximum Memory** RAM (transfer rates up to 2666MT/s). **Memory Configuration**

(Supported)

- Only Registered ECC DIMMs are supported.
- Do not install memory modules into memory slots if corresponding processor is not installed.
- Dual processor configurations with memory modules installed for only one processor is not supported.

For systems installed with Microsoft Windows 7 (Ultimate, Enterprise or Pro), the maximum accessible Notes system memory is 192GB

*768 GB configuration requires 2 CPUs configuration.

NVDIMM Memory

Intel[®] Optane[™] DC Persistent Memory is available factory configured in the following capacities:

- 128GB (1x128GB) Single Processor Configuration
- 256GB (2x128GB) Single Processor Configuration
- 512GB (4x128GB) Dual Processor Configuration

NOTES:

- a. Supported only with Xeon 82xx, 62xx, 52xx and 4215/4215R processors.
- b. Available as factory configured in Memory Mode or Storage Mode.
- Systems configured with DCPMM memory will operate the memory subsystem at 2666 MT/s. с.
- d. Operating System Support:
 - i. Windows 10 Pro for Workstations v1903 or later with all updates applied.
 - ii. Linux OS support may be found in the Linux Hardware Support Matrix.
- e. Detailed setup, security and support information may be found in the Intel[®] Optane[™] DC Persistent Memory: Configuration and Setup on HP Z6 G4 and Z8 G4 Workstation white paper.
- DCPMM solutions require additional DRAM memory to be included in the solution: f.



System Technical Specifications

- i. Systems configured with DCPMM in Memory Mode will include DRAM memory to be used as cache. The amount of included DRAM memory is based on an 8:1 DCPMM to DRAM capacity ratio.
- ii. Systems configured with DCPMM in Storage Mode will require DRAM System Memory to be ordered separately.
- iii. DCPMM Memory will report approximately 2% less than advertised capacity .
- g. Total Memory (DCPMM + DRAM) per processor must be <= 1TB or 2TB per dual processor system.
 - When Configured in Memory Mode, additional DRAM does not count against maximum processor memory.
 - ii. Maximum number of DCPMM modules in a Z6G4 is 4 per processor.
- h. Customer is responsible for additional required DRAM when adding DCPMM modules in Memory Mode.
- i. HP Z6G4 configured with some AMD Graphics are limited to 1TB of total DCPMM and DRAM memory. See AMD Graphics specifications for details.

PCI Express Connectors Slot 0:

Mechanical-only, for use with devices that require only rear bulkhead mounting or when 2nd CPU riser is installed

Slot 1:

PCI Express Gen3 x4 - CPU with open-ended connector*

Slot 2:

PCI Express Gen3 x16 - CPU

Slot 3:

PCI Express Gen3 x4 - PCH with open-ended connector*

Slot 4:

PCI Express Gen3 x8 – CPU with open-ended connector (slot converts to x4 electrical when SSD is installed in 2nd M.2 slot)*

Slot 5:

PCI Express Gen3 x16 - CPU

Slot 6:

PCI Express Gen3 x4 - PCH with open-ended connector*

M.2 Slot 1:

M.2 PCIe Gen 3 x4 - CPU up to 80mm storage devices

M.2 Slot 2:

M.2 PCIe Gen 3 x4 - CPU up to 80mm storage devices

* Open-ended connector allows a greater bandwidth (e.g. x16) card to be installed physically into a lower bandwidth connector/slot.

| Supported Drive Interfaces | SATA | 6 SATA @6Gb/s, supports RAID 0, 1, 5, & 10 |
|-------------------------------|----------------------------|--|
| | Serial Attached SCSI | Requires Optional PCIe card |
| | Factory Configured RAID | SATA RAID 0 Striped Array SATA RAID 1 Mirrored Array SATA RAID 10 Striped/Mirrored |



System Technical Specifications

| | | Notes: Factory integrated Intel [®] SATA RAID is Microsoft Windows only. |
|--|---|---|
| | External SATA (eSATA) | Supported on all SATA ports configurable with optional eSATA* cable kit * hot plug / hot swap not supported with eSATA |
| Network Controller | Integrated Intel® I219LM GbE LAN | Supports the following management functionalities: Intel® AMT11.2, TXT, DASH 1.1, WOL, VLAN, and PXE 2.1 |
| | Integrated Intel X722 for 1GbE | Data rates supported: 1000 Mb/s Compliance IEEE 802.1as/1588v2, 802.1p, 802.1Q, 802.3, 802.3ab, 802.3az, 802.3x Up to 16 UDP/TCP programmable filters Bus architecture: PCIe 3.0 UEFI and PXE Boot ROM support Intel iWARP Support (RDMA) Network transfer rates: 1000BASE-T (full-duplex) 2000 Mb/s Management capabilities: WOL (Excluding Max Power Savings), auto MDI crossover, PXE, Quad Hash filtering, RSS, Advanced cable diagnostics |
| USB Connector(s) | Front | Front I/O Entry: 4 USB 3.1 Gen1 (Left-most Port has Charging Capability) Front I/O Premium: 2x USB 3.1 Gen1, 2x USB 3.1 Gen2 Type-C™ (Left-most Port has Charging Capability) Charging Ports provide 1.5 Amps @ 5 Volts Standard USB Type A Ports provide 900mA @ 5 Volts USB Type C Ports provide 3 Amps @ 5 Volts and adhere to the Power Delivery 3.0 specification. |
| | Rear | 6 USB 3.1 G1 Type A |
| | Internal | 1 USB 3.1 G1 single-port header 1 USB 2.0 single-port header 1x USB 2.0 dual-port header |
| Integrated Graphics HD Integrated Audio Flash ROM CPU Fan Header Rear Chassis Fan Header Front PCI Fan Header CMOS Battery Holder - Lithium Integrated Trusted Platform Module Power Supply Headers Power Switch, Power | Yes Yes Common Criteria EAL4+ FIPS 140-2 Certified TPM Certified products | Certified |
| LED & Hard Drive LED Header | | |



Clear Password Jumper Yes

| Serial Port Parallel Port Keyboard/Mouse Hood Lock Header Hood Sensor Header Memory Fan AUX IN (audio) | 1 internal header No USB or PS/2 Yes Yes 1 Memory Fan Header per No | CPU | |
|--|---|---|--|
| Z6 Required Power Sup | ply Info | | |
| Power Supply | | 1000W 90% Efficien (Wide Ranging, | Active PFC) |
| Operating Voltage Ran | ge | 90–269 | VAC |
| Rated Voltage Range | | 100-127 VAC 200-240 VAC | 118 VAC |
| Rated Line Frequency | | 50-60 Hz | 400 Hz |
| Operating Line Freque | ncy Range | 47-66 Hz | 393-407 Hz |
| Rated Input Current | | 12 A @ 100-127 VAC 6.3 A @ 200-240 VAC | 12A @ 118 VAC |
| Heat Dissipation (Configuration and softw | are dependent) | Typical = 246 Maximum = 41 | |
| Power Supply Fan | | 80x25 mm vari | able speed |
| ENERGY STAR® Qualifie (Configuration depend | | Yes | |
| 80 PLUS® Compliant | | Yes, 90% Ei The Z6 G4 1000W power supply efficier https://plugloadsolutions.com 1K0P1A_1000W_ECOS% | ncy report can be found at this link: m/psu_reports/HP_D15- |
| FEMP Standby Power C (<1W in S5 – Power Off | | Yes | |
| EuP Compliant @ 230V (<0.5 W in S5 – Power C |)ff) | Yes | |
| CECP Compliant @ 220 (<4W in S3 – Suspend to | o RAM) | Yes; Configuratio | n dependent |
| (S3) | STAR®) – Suspend to RAM | <= 201 | W |
| (Instantly Available PC Built-in Self Test LED | .) | Yes | |
| Surge Tolerant Full Ra | naina Power Supply | | |
| (withstands power sur | | Yes | |
| Sensor Header | | Integrated in Front User Interface (Power Speaker) Cable | Switch, Power LED, HDD LED, |
| Integrated Gigabit Eth Clear CMOS Button | ernet | Integrated Intel® I219LM GbE LAN Yes | |



System Technical Specifications

System Configuration

| Example Z6 G4 | Processor | 1x Intel Xeon | 3104 (Six-core) | | | | | | | | |
|--------------------|-----------------------|---|----------------------|-------------|--------------|--------------|-------------|--|--|--|--|
| Configuration #1 | Memory | 1x 8GB DDR4- | 2666 (Register | ed DIMM) | | | | | | | |
| | Graphics | 1x NVIDIA Quadro P400 | | | | | | | | | |
| | Disks / Optical | 1x 500GB SATA 7200 ; 1x Slim DVD-ROM SATA | | | | | | | | | |
| | Power Supply | 1000W 90% c | 1000W 90% custom PSU | | | | | | | | |
| | Other | NA | | | | | | | | | |
| | | 115 | 5 VAC | 230 | VAC | 100 | VAC | | | | |
| Energy Consumption | | LAN Enabled | LAN Disabled | LAN Enabled | LAN Disabled | LAN Enabled | LAN Enabled | | | | |
| | Windows Idle (SO) | 54 | 54.109 | | 586 | 54. | 906 | | | | |
| | Windows Busy Typ(SO) | 94.256 | | 94. | 94.275 | | 94.043 | | | | |
| | Windows Busy Max (SO) | 95.992 | | 95. | 95.268 | | 95.643 | | | | |
| | Sleep (S3) | 6.219 | 6.205 | 6.319 | 6.306 | 6.334 | 6.239 | | | | |
| | Off (S5) | 3.354 | 3.343 | 3.521 | 3.341 | 3.350 | 3.342 | | | | |
| | Zero Power Mode (ErP) | 0. | 209 | 0.3 | 888 | 0.195 | | | | | |
| | | 115 | 5 VAC | 230 | VAC | 100 | VAC | | | | |
| Heat Dissipation | | LAN Enabled | LAN Disabled | LAN Enabled | LAN Enabled | LAN Disabled | LAN Enabled | | | | |
| (Btu/hr) | Windows Idle (SO) | 184 | 1.619 | 186 | .247 | 187.339 | | | | | |
| | Windows Busy Typ(SO) | 321 | .601 | 321 | .666 | 320 | .875 | | | | |
| | Windows Busy Max (SO) | 327 | 7.524 | 325 | .054 | 326 | .334 | | | | |
| | Sleep (S3) | 21.219 | 21.171 | 21.561 | 21.516 | 21.611 | 21.287 | | | | |
| | Off (S5) | 11.444 | 11.406 | 12.014 | 11.399 | 11.430 | 11.403 | | | | |
| | Zero Power Mode (ErP) | 0. | 713 | 1.3 | 323 | 0.6 | 565 | | | | |

| Example Z6 G4 | Processor | 1x Intel Xeon | 1x Intel Xeon 4108 (Eight-core) | | | | | | |
|--------------------|-----------------------|---------------------------------------|---------------------------------|-------------|--------------|--------------|-------------|--|--|
| Configuration #2 | Memory | 4x 8GB DDR4-2666 (Registered DIMM) | | | | | | | |
| | Graphics | 1x NVIDIA Quadro P2000 | | | | | | | |
| | Disks / Optical | 2x 1TB SATA 7200 ; 1x Slim DVDRW SATA | | | | | | | |
| | Power Supply | 1000W 90% custom PSU | | | | | | | |
| | Other | NA | | | | | | | |
| Energy Consumption | | 115 | 5 VAC | 230 | VAC | 100 | VAC | | |
| (Watts) | | LAN Enabled | LAN Disabled | LAN Enabled | LAN Disabled | LAN Enabled | LAN Enabled | | |
| | Windows Idle (SO) | 61.661 | | 61.531 | | 61.354 | | | |
| | Windows Busy Typ(SO) | 168.665 | | 167.375 | | 166 | .535 | | |
| | Windows Busy Max (SO) | 166 | 5.097 | 163.682 | | 169.674 | | | |
| | Sleep (S3) | 7.231 | 7.177 | 7.229 | 7.217 | 7.324 | 7.248 | | |
| | Off (S5) | 3.376 | 3.366 | 3.527 | 3.512 | 3.354 | 3.350 | | |
| | Zero Power Mode (ErP) | 0. | 211 | 0.3 | 86 | 0.1 | 195 | | |
| | | 115 | 5 VAC | 230 | VAC | 100 VAC | | | |
| Heat Dissipation | | LAN Enabled | LAN Disabled | LAN Enabled | LAN Enabled | LAN Disabled | LAN Enabled | | |
| (Btu/hr) | Windows Idle (SO) | 210 |).387 | 209.944 | | 209.340 | | | |



| Windows Busy Typ(SO) | 575.485 | | 571.084 | | 568.217 | | |
|-----------------------|---------|--------|---------|--------|---------|--------|--|
| Windows Busy Max (SO) | 576.959 | | 575.543 | | 578.928 | | |
| Sleep (S3) | 24.672 | 24.488 | 24.665 | 24.624 | 24.989 | 24.730 | |
| Off (S5) | 11.519 | 11.484 | 12.034 | 11.983 | 11.443 | 11.430 | |
| Zero Power Mode (ErP) | 0. | 0.720 | | 1.317 | | 0.665 | |

| Example Z6 G4 | Processor | 1x Intel Xeon | 6136 (Twelve-c | ore) | | | | | |
|--------------------|-----------------------|-------------------------|------------------|-------------|--------------|--------------|-------------|--|--|
| Configuration #3 | Memory | 6x 8GB DDR4 | -2666 (Registe | red DIMM) | | | | | |
| ENERGY STAR | Graphics | 1x NVIDIA Qua | adroP4000 | | | | | | |
| QUALIFIED | Disks/Optical | 2x 1TB SATA | 7200 ; 1x Slim [| OVDRW SATA | | | | | |
| | Power Supply | 1000W 90% c | ustom PSU | | | | | | |
| Other NA | | | | | | | | | |
| Energy Consumption | | 115 VAC 230 VAC 100 VAC | | | | | | | |
| (Watts) | | LAN Enabled | LAN Disabled | LAN Enabled | LAN Disabled | LAN Enabled | LAN Enabled | | |
| | Windows Idle (SO) | 79 | .074 | 79. | 109 | 79. | 938 | | |
| 1 | Windows Busy Typ(SO) | 324.975 | | 317 | .991 | 327.451 | | | |
| | Windows Busy Max (SO) | 328.268 | | 320.296 | | 329.668 | | | |
| 1 | Sleep (S3) | 7.847 | 7.756 | 7.878 | 7.826 | 7.931 | 7.852 | | |
| 1 | Off (S5) | 3.353 | 3.348 | 3.535 | 3.489 | 3.373 | 3.355 | | |
| | Zero Power Mode (ErP) | 0. | 206 | 0.3 | 86 | 0.196 | | | |
| | | 115 | 5 VAC | 230 | VAC | 100 | 100 VAC | | |
| Heat Dissipation | | LAN Enabled | LAN Disabled | LAN Enabled | LAN Enabled | LAN Disabled | LAN Enabled | | |
| (Btu/hr) | Windows Idle (SO) | 269 | 9.801 | 269 | .920 | 272.748 | | | |
| | Windows Busy Typ(SO) | 110 | 8.815 | 1084 | .985 | 1117 | 7.262 | | |
| | Windows Busy Max (SO) | 112 | 0.051 | 1092 | 2.850 | 1124 | 1.827 | | |
| | Sleep (S3) | 26.774 | 26.463 | 26.880 | 26.702 | 27.061 | 26.791 | | |
| | Off (S5) | 11.441 | 11.426 | 12.061 | 11.904 | 11.509 | 11.447 | | |
| 1 | Zero Power Mode (ErP) | 0. | 703 | 1.3 | 17 | 0.6 | 569 | | |

| Example Z6 G4 | Processor | 2x Intel Xeon | 8160 (Dual 24 | 2x Intel Xeon 8160 (Dual 24-core) | | | | | | |
|--------------------|-----------------------|---------------|--------------------------------------|-----------------------------------|--------------|-------------|-------------|--|--|--|
| Configuration #4 | Memory | 12x 32GB DDF | 12x 32GB DDR4-2666 (Registered DIMM) | | | | | | | |
| | Graphics | 2x NVIDIA Qua | adro P5000 | | | | | | | |
| | Disks / Optical | 4x 2TB SATA 7 | 200 ; 1x Slim | DVDRW SATA | | | | | | |
| | Power Supply | 1000W 90% c | 000W 90% custom PSU | | | | | | | |
| | Other | NA | | | | | | | | |
| Energy Consumption | | 115 | VAC | 230 | VAC | 100 | VAC | | | |
| (Watts) | | LAN Enabled | LAN Disabled | LAN Enabled | LAN Disabled | LAN Enabled | LAN Enabled | | | |
| | Windows Idle (SO) | 112. | 388 | 115 | 115.635 | | 112.102 | | | |
| | Windows Busy Typ(SO) | 512. | 368 | 490 | .165 | 526.905 | | | | |
| | Windows Busy Max (SO) | 698.548 | | 673 | .465 | 706.461 | | | | |
| 1 | Sleep (S3) | 14.208 | 15.176 | 13.886 | | | | | | |



System Technical Specifications

| | Off (S5) | 3.511 | 3.418 | 3.575 | 3.570 | 3.509 | 3.412 |
|-------------------------------------|-----------------------|-------------|--------------|-------------|-------------|--------------|-------------|
| | Zero Power Mode (ErP) | 0.2 | 87 | 0.3 | 887 | 0.2 | 272 |
| | | 115 | VAC | 230 | VAC | 100 | VAC |
| Heat Dissipation (Btu/hr) | | LAN Enabled | LAN Disabled | LAN Enabled | LAN Enabled | LAN Disabled | LAN Enabled |
| | Windows Idle (SO) | 383. | 469 | 394 | .547 | 382 | .492 |
| | Windows Busy Typ(SO) | 1748 | .120 | 1672 | 2.443 | 1797 | 7.800 |
| | Windows Busy Max (SO) | 2383 | .446 | 2297 | 7.863 | 2410 |).445 |
| | Sleep (S3) | 48.478 | 47.198 | 50.150 | 49.430 | 51.781 | 47.379 |
| | Off (S5) | 11.980 | 11.662 | 12.198 | 12.181 | 11.973 | 11.642 |
| | Zero Power Mode (ErP) | 0.9 | 79 | 1.3 | 821 | 0.9 | 928 |

NOTE: Power consumption measurements do not take advantage of the Intel Turbo Boost Technology. As a result, power consumption measurements may be higher.

DECLARED NOISE EMISSIONS

| System Configuration (Entry level) | Processor Info | Intel [®] Xeon [®] Gold 6130 processor 2.1GHz 12C CPU |
|---------------------------------------|----------------|---|
| | Memory Info | 24GB (3x8GB) DDR4-2666 ECC Memory RDIMMs |
| | Graphics Info | 1-NVIDIA® Quadro® P400 2GB |
| | Disks/Optical | 1-500GB SATA 7200RPM 3.5" HDD / 1-HP 9.5mm Slim Blu Ray Disc Writer |
| | Power Supply | 1000 W |

| Declared Noise Emission (in accordance with ISO | | Sound Power (LWAd, bels) | Deskside Sound Pressure (LpAm, decibels) |
|---|--|-----------------------------|--|
| 7779 and ISO 9296) | Idle | 3.3 | 15 |
| | Hard drive Operating (random reads) | 3.5 | 18 |

| System Configuration (Mid-range) | Processor Info | Intel [®] Xeon [®] Platinum 8168 processor 2.7GHz 24C CPU |
|-------------------------------------|----------------|---|
| | Memory Info | 96GB (6x16GB) DDR4-2666 ECC Memory RDIMMs |
| | Graphics Info | 1-NVIDIA [®] Quadro [®] P6000 24GB |
| | Disks/Optical | 2-4TB 6Gb/s 7200RPM SATA HDD / 1-HP 9.5mm Slim Blu Ray Disc Writer |
| | Power Supply | 1000 W |

| Declared Noise Emission (in accordance with ISO 7779 and ISO 9296) | | Sound Power (LWAd, bels) | Deskside Sound Pressure (LpAm, decibels) |
|---|--|-----------------------------|---|
| | Idle | 3.8 | 23 |
| | Hard drive Operating (random reads) | 3.9 | 23 |



System Technical Specifications

| System Configuration (High end) | Processor Info | 2-Intel [®] Xeon [®] Gold 6136 processor 3.0GHz 12C CPU |
|------------------------------------|----------------|---|
| | Memory Info | 192GB (12x16GB) DDR4-2666 ECC Memory RDIMMs |
| | Graphics Info | 1-NVIDIA [®] Quadro [®] P6000 24GB |
| | Disks/Optical | 2-4TB 6Gb/s 7200RPM SATA HDD / 1-HP 9.5mm Slim Blu Ray Disc Writer |
| | Power Supply | 1000 W |

| Declared Noise Emission (in accordance with ISO | | Sound Power (LWAd, bels) | Deskside Sound Pressure (LpAm, decibels) |
|---|--|-----------------------------|--|
| 7779 and ISO 9296) | Idle | 3.8 | 23 |
| | Hard drive Operating (random reads) | 3.9 | 24 |

ENVIRONMENTAL DATA

| Environmental Requirements | Temperature | Operating: 5° to 35° C (40° to 95° F) Non-operating: -40° to 60° C (-40° to 140° F) |
|-------------------------------|------------------------|--|
| | Humidity | Operating: 10% to 85% RH, non-condensing, 35° C maximum wet bulb Non-operating: 10% to 90% RH, non-condensing, 35° C maximum wet bulb |
| | Maximum Altitude | Operating: 3,048 m (10,000 feet) |
| | | Above 1524 m (5,000 feet) altitude, the maximum operating temperature is reduced by 1° C (1.8° F) for every 305 m (1,000 feet) increase in elevation |
| | | Non-operating: 9,144 m (30,000 feet) |
| | Shock (non-repetitive) | Operating: ½-sine: 40g, 2-3ms (~62 cm/sec) Non-operating: ½-sine: 160 cm/s, 2-3ms (~105g) square: 422 cm/s, 20g |
| | | Vibration Operating random: 0.5g (rms), 5-300 Hz, up to 0.0025g²/Hz |

Operating random: 0.5g (rms), 5-300 Hz, up to 0.0025g²/Hz Non-operating random: 2.0g (rms), 5-500 Hz, up to 0.0150 g²/Hz

Physical Security and Serviceability

| Access Panel | Tool-less Includes system board and memory information. |
|--|--|
| Optical Drive | Tool-less, no carrier or rails required |
| Hard Drives | Tool-less |
| | Optional 5.25" external bay carriers |
| Expansion Cards | Tool-less |
| Processor Socket | 1st socket on main system board. 2nd socket on optional 2nd CPU/Memory Module. |
| Blue User Touch Points | Yes, on primary serviceable components. |
| Color-coordinated Cables and Connectors | Yes |



| Memory | Tool-less |
|----------------------------|---|
| System Board | Torx T15 screws |
| System Board | |
| | 2nd CPU/Memory Module: Tool-less |
| | |
| Front of Computer LEDs | Dual Color Power/Failure LED = Yes |
| | HDD Activity LED = Yes |
| | |
| Configuration Record SW | Yes |
| Over-Temp Warning on | Yes, at POST screen on reboot |
| Screen | |
| Restore CD/DVD Set | Yes, restores the computer to its original factory shipping image; can be obtained via HP Support. |
| Dual Function Front | Yes, also acts as a reset switch when held for 4 seconds. |
| Power Switch | רכי, מושט מבוש מדרשבר שאונרו אורוווכומ וסו א שכנטומש. |
| | Yes |
| Padlock Support | res |
| | |
| Cable Lock Support | Kensington Cable Lock (optional): Prevents entire system theft and system access. 3mm x 7mm slot at |
| | rear of system |
| Universal Chassis Clamp | No |
| Lock Support | |
| Solenoid Lock and Hood | Access Panel Solenoid Lock: Yes (optional). Activated remotely to prevent system entry. |
| Sensor | Access Panel Intrusion Sensor: Yes (optional). |
| Removable Media | Yes, user can prevent the workstation from writing to or booting from removable media. |
| Write/Boot Control | |
| Power-On Password | Yes, prevents an unauthorized person from booting up the workstation |
| | |
| Setup Password | Yes, prevents an unauthorized person from changing the workstation configuration |
| 3.3V Aux Power LED on | Yes |
| System PCA | |
| NIC LEDs (integrated) | Yes |
| (Green & Amber) | |
| CPUs and Heatsinks | CPU heatsink removal requires a T-30 Torx screwdriver. |
| Power Supply Diagnostic | Yes |
| LED | |
| Front Power Button | Yes |
| Rear Power Button | Yes |
| Front Power LED | Yes, white (normal), red (fault) |
| | |
| Front Hard Drive Activity | Yes white |
| LED | res, white |
| Front ODD Activity LED | Yes on device |
| FIGHT ODD ACTIVITY LED | res on device |
| | Vec |
| Internal Speaker | Yes |
| | |
| System/Emergency ROM | Recovers corrupted system BIOS. |
| Flash Recovery | |
| Cooling Solutions | Air cooled forced convection |
| Power Supply Fans | 1 - 80 mm x 80 mm x 25 mm (non-serviceable) |
| CPU Heatsink Fan | 1st CPU: 1 - 80mm |
| | Optional 2nd CPU: 1 - 60mm x 25mm |
| Memory Fan | Front memory fan: 1 – 80mm x 25mm |
| | |
| | Memory duct blower: 1 – 90mm x 25mm |
| | Memory duct blower: 1 – 90mm x 25mm 2nd CPU/Memory Module: 1 - 60mm x 25mm |



| Chassis Fans | Front chassis fan : 1 - 120mm x 25mm Rear chassis fan: 1 - 120mm x 25mm | | |
|--|--|--|--|
| HP Vision Diagnostics Offline Edition | HP PC Hardware Diagnostics (UEFI) enables hardware level testing outside the operating system on many components. The diagnostics can be invoked by pressing ESC then F2 upon the PC reboot, and is available as a download from HP Support. | | |
| Access Panel Key Lock ACPI-Ready Hardware | Yes, side panel barrel keylock (optional from the factory only) Advanced Configuration and Power Management Interface (ACPI). | | |
| | Allows the system to wake from a low-power mode. Controls system power consumption, making it possible to place individual cards and peripherals in a low-power or powered-off state without affecting other elements of the system | | |
| Trusted Platform Module Chip | Integrated Infineon TPM 2.0. TCG and FIPS 140-2 Certified | | |
| Integrated Chassis Handles | Yes, Front handle and dedicated rear recess | | |
| Power Supply | Requires T15 Torx or flat blade screwdriver | | |
| PCIe Card Retention | Yes, tool-less | | |
| | Rear (all) Middle (full-height cards) | | |
| | Front (full-length cards with extender) | | |
| Flash ROM | Yes | | |
| Diagnostic Power Switch LED on board | Yes | | |
| Clear Password Jumper | Yes | | |
| Clear CMOS Button | Yes | | |
| CMOS Battery Holder | Yes | | |
| DIMM Connectors | /es | | |
| BIOC | | | |
| BIOS | | | |
| BIOS 32-bit Services | Standard BIOS 32-bit Service Directory Proposal v0.4 | | |
| PCI 3.0 Support | Full BIOS support for PCI Express through industry standard interfaces. | | |
| | ATAPI Removable Media Device BIOS Specification Version 1.0. | | |
| BBS WMI Support | BIOS Boot Specification v1.01. WMI is Microsoft's implementation of Web-Based Enterprise Management (WBEM) for Windows. WMI is | | |
| WMI Support | fully compliant with the Distributed Management Task Force (DMTF) Common Information Model (CIM) and WBEM specifications. | | |
| BIOS Boot Spec 1.01+ | Provides more control over how and from what devices the workstation will boot. | | |
| BIOS Power On | Users can define a specific date and time for the system to power on. | | |
| ROM Based Computer | Review and customize system configuration settings controlled by the BIOS. | | |
| Setup Utility (F10) | Decovers system BIOS in corrupted Elech DOM | | |
| System/Emergency ROM Flash Recovery with Video | Recovers system BIOS in corrupted Flash ROM. | | |
| Replicated Setup | Saves BIOS settings to USB flash device in human readable file (HpSetup.txt). BiosConfigurationUtility.exe utility can then replicate these settings on machines being deployed without entering Computer Configuration Utility (F10 Setup). | | |
| SMBIOS | System Management BIOS 2.8, for system management information. | | |
| Boot Control | Disables the ability to boot from removable media on supported devices. | | |
| Memory Change Alert | Alerts management console if memory is removed or changed. | | |



| Thermal Alert | Monitors the temperature state within the chassis. Three modes: • NORMAL - normal temperature ranges. • ALERTED - excessive temperatures are detected. Raises a flag so action can be taken to avoid |
|--|--|
| | shutdown or provide for a smoother system shutdown. SHUTDOWN - excessive temperatures are encountered. Automatically shuts down the computer without warning before hardware component damage occurs. |
| Remote ROM Flash | Provides secure, fail-safe ROM image management from a central network console. |
| ACPI (Advanced | Allows the system to enter and resume from low power modes (sleep states). |
| Configuration and Power | Enables an operating system to control system power consumption based on the dynamic workload. |
| Management Interface) | Makes it possible to place individual cards and peripherals in a low-power or powered-off state without |
| | affecting other elements of the system. |
| | Supports ACPI 5.0 for full compatibility with 64-bit operating systems. |
| Ownership Tag | A user-defined string stored in non-volatile memory that is displayed in the BIOS splash screen. |
| Shutdown | System administrators can power on, restart, and power off a client computer from a remote location. |
| Instantly Available PC (Suspend to RAM - ACPI | Allows for very low power consumption with quick resume time. |
| sleep state S3) | |
| Remote System Installation via F12 (PXE | Allows a new or existing system to boot over the network and download software, including the operating system. |
| 2.1) (Remote Boot from | operating system. |
| Server) | |
| ROM revision levels | Reports the system BIOS revision level in Computer Configuration Utility (F10 Setup). Version is |
| | available through an industry standard interface (SMBIOS and WMI) so that management SW |
| | applications can use and report this information. |
| System board revision level | Allows management SW to read revision level of the system board. Revision level is digitally encoded into the HW and cannot be modified. |
| Start-up Diagnostics (Power-on Self-Test) | Assesses system health at boot time with selectable levels of testing. |
| Auto Setup when new hardware installed | System automatically detects addition of new hardware. |
| Keyboard-less Operation | The system can be booted without a keyboard. |
| Localized ROM Setup | Common BIOS image supports System Configuration Utility (F10 Setup) menus in 14 languages with local keyboard mappings. |
| Asset Tag | The user or MIS to set a unique tag string in non-volatile memory. |
| Per-slot Control | Allows I/O slot parameters (option ROM enable/disable, bus latency) to be configured individually. |
| Adaptive Cooling | Control parameters are set according to detected hardware configuration for optimal acoustics. |
| Pre-boot Diagnostics | (Pre-video) critical errors are reported via beeps and blinks on the power LED. |
| Industry Standard | |
| Specification Support | |
| Industry Standard | Revision Supported by the BIOS |
| UEFI Specification | 2.6 |
| Revision | |
| ACPI | Advanced Configuration and Power Management Interface, Version 5.0 |
| ATA (IDE) | AT Attachment 6 with Packet Interface (ATA/ATAPI-6), Revision 3b |
| CD Boot | "El Torito" Bootable CD-ROM Format Specification Version 1.0 |
| EDD | - Enhanced Disk Drive Specification Version 1.1 |
| 51161 | - BIOS Enhanced Disk Drive Specification Version 3.0 |
| EHCI | Enhanced Host Controller Interface for Universal Serial Bus, Revision 1.0 |
| PCI | PCI Local Bus Specification, Revision 2.3 PCI Power Management Specification, Revision 1.1 PCI Firmware Specification, Revision 3.0, Draft .7 |



System Technical Specifications

| PCI Express | PCI Express Base Specification, Revision 2.0 PCI Express Base Specification, Revision 3.0 |
|-------------|--|
| РММ | POST Memory Manager Specification, Version 1.01 |
| SATA | Serial ATA Specification, Revision 1.0a Serial ATA 3 Gb/s: Serial ATA Specification, Revision 2.5 Serial ATA 6 Gb/s: Serial ATA Specification, Revision 3.0 |
| SPD | PC SDRAM Serial Presence Detect (SPD) Specification, Revision 1.2B |
| ТРМ | Trusted Platform Module (TPM) 2.0 (Infineon SLB 9670) Common Criteria EAL4+ Certified FIPS 140-2 Certification TCG TPM Certified products list: http://www.trustedcomputinggroup.org/certification/tpm-certified-products/ |
| UHCI | Universal Host Controller Interface Design Guide, Revision 1.1 |
| USB | Universal Serial Bus Revision 1.1 Specification Universal Serial Bus Revision 2.0 Specification Universal Serial Bus Revision 3.1 Specification |
| SMBIOS | System Management BIOS Reference Specification, Version 2.8 |
| | External BIOS simulator found at: http://csrsml.itcs.hp.com/ |

Social and Environmental Responsibility

Eco-Label Certifications & This product has received or is in the process of being certified to the following approvals and may be Declarations labeled with one or more of these marks: ENERGY STAR[®] (energy-saving features available on selected configurations-Windows only) • US Federal Energy Management Program (FEMP) • • **China Energy Conservation Program** The ECO declaration (TED) The Z6 G4 is registered EPEAT[®] Gold in the US and Canada. EPEAT[®] registration varies by country. See http://www.epeat.net for registration status by country. Search keyword generator on HP's 3rd party option store for solar generator accessories at http://www.hp.com/go/options The battery in this product complies with EU Directive 2006/66/EC **Batteries** Battery mass: 3q Battery type: Lithium Metal The battery in this product does not contain: Mercury greater than 5ppm by weight • Cadmium greater than 10ppm by weight • Lead greater than 40ppm by weight • **Restricted Material Usage** This product meets the material restrictions specified in HP's General Specification for the Environment. HP Inc. is committed to compliance with all applicable environmental laws and regulations, including the European Union Restriction of Hazardous Substances (RoHS) Directive. HP's goal is to exceed compliance obligations by meeting the requirements of the RoHS Directive on a worldwide basis **Low Halogen Statement** This product is low-halogen except for power cords, external cables and peripherals. Service parts obtained after purchase may not be low-halogen.



| End-of-Life Management and Recycling HP Inc. Corporate Environmental Information | HP Inc. offers end-of-life HP product return and recycling programs in many geographic areas. To recycle your product, please go to: http://www.hp.com/recycle or contact your nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner. This product is greater than 90% recyclable by weight when properly disposed of at end of life. For more information about HP's commitment to the environment: Sustainability Report |
|--|---|
| | Eco-labelcertifications: http://www.hp.com/hpinfo/globalcitizenship/environment/productdesign/ecolabels.html ISO 14001 certificate: http://www.hp.com/hpinfo/globalcitizenship/environment/operations/envmanagement.html |
| Additional Information | This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive – 2002/96/EC. Product Disassembly Instructions Plastic parts weighing over 25 grams used in the product are marked per ISO 11469 and |
| | ISO1043. |
| Packaging | HP Workstation product packaging meets the HP's General Specification for the Environment |
| | Does not contain restricted substances listed in HP Standard 011-1 General Specification for the Environment Does not contain ozone-depleting substances (ODS) Does not contain heavy metals (lead, mercury, cadmium or hexavalent chromium) in excess of |
| | Does not contain nearly metals (read, mercury, caunitari of next valent en of metals) in excess of 100 ppm sum total for all heavy metals listed Maximizes the use of post-consumer recycled content materials in packaging materials All packaging material is designed for ease of disassembly |
| | Reduced size and weight of packages to improve transportation fuel efficiency Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards formatting A multi-unit eco packaging option is available to institutional customers that uses less packaging material or has a lower volume footprint than conventional single-unit packaging. Please contact your sales representative for additional details. |
| Packaging Materials Internal External | Cushions and plastic bags made of low density polyethylene (LDPE). Outer carton, accessories carton, and insert made of corrugated paper board. |
| Manageability Industry Standard Specifications | DASH 1.1 (via Intel[®] LAN on motherboard) |
| Intel® Active ManagementIntel® Active Management Technology (AMT) 11.2x Technology (AMT) | |
| | An advanced set of remote management features and functionality providing IT administrators the latest and most effective tools to remotely discover, heal, and protect networked client systems regardless of the system's health or power state. AMT 11.2x includes the following advanced management functions: • Power Management (on, off, reset, graceful shutdown, sleep and hibernate) • Support in Max Power Savings (Shutdown and Hibernate Modes) • Hardware Inventory (includes BIOS and firmware revisions) • Hardware Alerting |



| | Agent Presence |
|--|--|
| | System Defense Filters |
| | Serial Over LAN (SOL) |
| | USB Redirect (Media Redirection) |
| | ME Wake-on-LAN (WOL), even with Maximum Power Savings Enabled |
| | DASH 1.1 compliance |
| | IPv6 Support |
| | Fast Call for Help - a client inside or outside the firewall may initiate a call for help via BIOS screen, periodic connections, or alert triggered connection |
| | Remote Scheduled Maintenance - pre-schedule when the system connects to the IT or service provider console for maintenance. |
| | Remote Alerts - automatically alert IT or service provider if issues arise |
| | • Access Monitor - Provides oversight into Intel [®] AMT actions to support security requirements |
| | PC Alarm Clock |
| | Microsoft NAP Support |
| | Host Base set-up and configuration |
| | Management Engine (ME) firmware roll back |
| | Local Time Sync to UTC |
| | Remote Memory Dump Command – Creates memory dump for debug |
| Intel® vPro™ Technology | The HP Z6 G4 Workstation supports Intel [®] vPro™ technology when configured as outlined below: |
| | Intel [®] Xeon [®] processor Scalable Family |
| | Intel [®] C622 chipset |
| | • Intel [®] I219LM GbE LAN |
| Remote Manageability Software Solutions | The HP Z6 G4 Workstation is supported on the following remote manageability software consoles: |
| | LANDesk Management Suite (HP recommended solution) |
| | Microsoft System Center Configuration Manager |
| | HP Client Automation Enterprise |
| | For questions or support for manageability needs, please visit |
| | http://www.hp.com/go/clientmanagement |
| System Software Manager | For questions or support for SSM, please visit: http://www.hp.com/go/ssm |
| Service, Support, and Warranty | On-site Warranty and Service (Note 1): Three-years, limited warranty and service offering delivers on- site, next business-day (Note 2) service for parts and labor and includes free telephone support (Note 3) 8am - 5pm. Global coverage (Note 2) ensures that any product purchased in one country and transferred to another, non-restricted country will remain fully covered under the original warranty and service offering. 24/7 operation will not void the HP warranty. |
| | NOTE 1: Terms and conditions may vary by country. Certain restrictions and exclusions apply. |
| | NOTE 2: On-site service may be provided pursuant to a service contract between HP and an authorized HP third-party provider, and is not available in certain countries. Global service response times are based on commercially reasonable best effort and may vary by country. NOTE 3: Technical telephone support applies only to HP-configured, HP and HP-qualified, third-party hardware and software. Toll-free calling and 24x7 support service may not be available in some countries. |
| | HP Care Pack Services extend service contracts beyond the standard warranties. Service starts from date of hardware purchase. To choose the right level of service for your HP product, use the HP Care Pack Services Lookup Tool at: http://www.hp.com/go/lookuptool. Additional HP Care Pack Services information by product is available at: http://www.hp.com/hps/carepack. Service levels and response times for HP Care Packs may vary depending on your geographic location. |



System Technical Specifications

Product Change Notification

- Program to proactively communicate Product Change Notifications (PCNs) and Customer Advisories by email to customers, based on a user-defined profile.
- PCNs provide advance notification of hardware and software changes to be implemented in the factory providing time to plan for transition.
- Customer Advisories provide concise, effective problem resolution, greatly reducing the need to call technical support.

Stable & Consistent Offerings

| Global Series SKUs | this breakthrough platf Consistent Offerings are designed and tested to | ent to hardware, software, and solution innovation, HP is proud to introduce orm configuration stability to HP Workstation customers. HP Stable & e built on the foundation of a carefully chosen set of hardware and software work with all HP Z Workstation platforms through their end of life. These orresponding HP Workstation platform compatibility are outlined in this |
|----------------------------------|---|--|
| Stable & Consistent Offerings | special programs, no ac components when you | Offerings are available worldwide to all HP Workstation customers-no Iditional cost-no kidding. Simply select your hardware and software customize your HP Workstation and be assured that you'll be able to buy that bughout the lifecycle of the product. |
| Processors | Product # | Offering |
| | 2DL32AV | Intel® Xeon® Gold 6128 processor |
| | 2DL32AV, 1XM44AA | Intel [®] Xeon [®] Gold 6128 2 nd processor |
| | 2DL22AV | Intel® Xeon® Silver 4114 processor |
| | 2DL22AV, 1XM49AA | Intel [®] Xeon [®] Silver 4114 2nd processor |
| | 2DL18AV | Intel [®] Xeon [®] Silver 4108 processor |
| | 2DL18AV, 1XM51AA | Intel [®] Xeon [®] Silver 4108 2 nd processor |
| Hard Drives | Product # | Offering |
| | Z5H22AV, LQ037AA | 1TB SATA 7200 RPM 3.5" HDD |
| Graphics | Product # | Offering |
| | 2TF08AA | AMD Radeon™ Pro WX 3100 4GB Graphics |
| | | |
| Memory | Product # | Offering |
| | TBD | TBD |
| Optical and Removable | Product # | Offering |
| Storage | TBD | TBD |
| | | |



Technical Specifications - Processors

Intel[®] Xeon[®] W-3200 Series CPU

Intel[®] Xeon[®] W-3245 3.2 2933 16C processor Intel® Xeon® W-3235 3.3 2933 12C processor Intel[®] Xeon[®] W-3225 3.7 2666 8C processor Intel[®] Xeon[®] W-3223 3.5 2666 8C processor Intel[®] Xeon[®] Scalable CPU Intel® Xeon® Platinum 8280 processor Intel[®] Xeon[®] Platinum 8260 processor Intel[®] Xeon[®] Gold 6258R processor Intel[®] Xeon[®] Gold 6254 processor Intel[®] Xeon[®] Gold 6252 processor Intel[®] Xeon[®] Gold 6248R processor Intel[®] Xeon[®] Gold 6248 processor Intel[®] Xeon[®] Gold 6246R processor Intel[®] Xeon[®] Gold 6244 processor Intel[®] Xeon[®] Gold 6242R processor Intel[®] Xeon[®] Gold 6242 processor Intel[®] Xeon[®] Gold 6240R processor Intel[®] Xeon[®] Gold 6240Y processor Intel[®] Xeon[®] Gold 6240 processor Intel[®] Xeon[®] Gold 6238R processor Intel[®] Xeon[®] Gold 6238 processor Intel[®] Xeon[®] Gold 6234 processor Intel[®] Xeon[®] Gold 6230R processor Intel[®] Xeon[®] Gold 6230 processor Intel® Xeon® Gold 6226R processor Intel[®] Xeon[®] Gold 6226 processor Intel[®] Xeon[®] Gold 6154 processor Intel[®] Xeon[®] Gold 6136 processor Intel[®] Xeon[®] Gold 6134 processor Intel[®] Xeon[®] Gold 6132 processor Intel[®] Xeon[®] Gold 6128 processor Intel[®] Xeon[®] Gold 5222 processor Intel[®] Xeon[®] Gold 5220R processor Intel[®] Xeon[®] Gold 5220 processor Intel[®] Xeon[®] Gold 5218R processor Intel[®] Xeon[®] Gold 5218 processor Intel[®] Xeon[®] Gold 5215 processor Intel[®] Xeon[®] Gold 5118 processor Intel[®] Xeon[®] Gold 4216 processor Intel[®] Xeon[®] Gold 4215R processor Intel[®] Xeon[®] Gold 4215 processor Intel[®] Xeon[®] Gold 4214R processor Intel[®] Xeon[®] Gold 4214Y processor



Technical Specifications - Processors

Intel® Xeon® Gold 4214 processor Intel® Xeon® Gold 4210R processor Intel® Xeon® Gold 4210 processor Intel® Xeon® Gold 4208 processor Intel® Xeon® Silver 4114 processor Intel® Xeon® Silver 4112 processor Intel® Xeon® Silver 4108 processor Intel® Xeon® Bronze 3206R processor Intel® Xeon® Bronze 3204 processor



STORAGE/HARD DRIVES

| HP SAS (Serial Attached SCSI) Hard Drives for HP Workstations | HP 300GB SAS 15K SFF HDD | Capacity Height Width Interface Synchronous Transfer Rate (Maximum) | 300GB 5.9 in; 15 cm Media Diameter 12Gb/s SAS Up to 1200 MB/s (SAS s | 3.5 in; 8.9 cm ingle port)* |
|---|-----------------------------|---|---|--------------------------------|
| | | Buffer | 128MB | |
| | | Seek Time (typical reads, includes controller overhead, including settling) | Average | 2.0ms * |
| | | Rotational Speed | 15K rpm | |
| | | Operating Temperature | 41° to 131° F (5° to 55° | C) |
| | | *Actual performance may | vary. | |

| SATA (Serial ATA) Hard | 500GB SATA 7200 rpm | Capacity | 500GB | |
|------------------------|---------------------|--|--------------------------|------------------|
| Drives for HP | 6Gb/s 3.5" HDD | Height | 1 in; 2.54 cm | |
| Workstations | | Width | Media Diameter | 3.5 in; 8.9 cm |
| | | | Physical Size | 4 in; 10.17 cm |
| | | Interface | Serial ATA (6.0Gb/s), N | CQ enabled |
| | | Synchronous Transfer Rate (Maximum) | Up to 600MB/s* | |
| | | Buffer | 16MB | |
| | | Seek Time (typical reads, | Single Track | 2 ms* |
| | | includes controller overhead, including | Average Full Stroke | 11 ms* 21 ms* |
| | | settling) | 7 200 | |
| | | Rotational Speed | 7,200 rpm | |
| | | Logical Blocks | 976,773,168 | C) |
| | | • Operating Temperature | 41° to 131° F (5° to 55° | () |
| | | "Actual performance may | valy. | |
| | 1TB SATA 7200 rpm | Capacity | 1TB | |
| | 6Gb/s 3.5" HDD | Height | 1 in; 2.54 cm | |
| | | Width | Media Diameter | 3.5 in; 8.9 cm |
| | | | Physical Size | 4 in; 10.17 cm |
| | | Interface | Serial ATA (6.0Gb/s), N | CQ enabled |
| | | Synchronous Transfer Rate (Maximum) | Up to 600 MB/s* | |
| | | Buffer | 64MB | |
| | | Cache | Adaptive | |
| | | Seek Time (typical reads, | Single Track | 2 ms* |
| | | includes controller | Average | 11 ms* |
| | | overhead, including settling) | Full Stroke | 21 ms* |
| | | Rotational Speed | 7,200 rpm | |
| | | Operating Temperature | 41° to 131° F (5° to 55° | C) |
| | | *Actual performance may | vary. | |
| | | | - | |
| | 2.0TB SATA 7200 rpm | Capacity | 2.0TB | |
| | 6Gb/s 3.5" HDD CMR | Height | 1 in; 2.54 cm | |
| | | Width | Media Diameter | 3.5 in; 8.9 cm |
| | | | Physical Size | 4 in; 10.17 cm |
| | | Interface | Serial ATA (6.0 Gb/s), N | CQ Enabled |
| | | Synchronous Transfer Rate (Maximum) | Up to 600 MB/s* | |
| | | Buffer | 64MB | |
| | | Seek Time (typical reads, | Single Track | 1.0 ms* |
| | | includes controller | Average | 11 ms* |
| | | overhead, including settling) | Full Stroke | 18 ms* |
| | | Rotational Speed | 7,200 rpm | |



HP Z6 G4 Workstation

| | Logical Blocks | 3,907,029,168 | |
|---------------------|--|--------------------------|------------------|
| | Operating Temperature | 41° to 131° F (5° to 55° | C) |
| | *Actual performance may | vary. | |
| 2.0TB SATA 7200 rpm | Capacity | 2.0TB | |
| 6Gb/s 3.5" HDD SMR | Height | 1 in; 2.54 cm | |
| | Width | Media Diameter | 3.5 in; 8.9 cm |
| | | Physical Size | 4 in; 10.17 cm |
| | Interface | Serial ATA (6.0 Gb/s), N | CQ Enabled |
| | Synchronous Transfer Rate (Maximum) | Up to 600 MB/s* | |
| | Buffer | 64MB | |
| | Seek Time (typical reads, | Single Track | 1.2 ms* |
| | includes controller | Average | 12 ms* |
| | overhead, including settling) | Full Stroke | 21 ms* |
| | Rotational Speed | 7,200 rpm | |
| | Logical Blocks | 3,907,029,168 | |
| | Operating Temperature | 41° to 140° F (5° to 60° | C) |
| | *Actual performance may | vary. | |
| 3.0TB SATA 7200 rpm | Capacity | 3.0TB | |
| 6Gb/s 3.5" HDD | Height | 1 in; 2.54 cm | |
| | Width | Media Diameter | 3.5 in; 8.9 cm |
| | | Physical Size | 4.0 in; 10.17 cm |
| | Interface | Serial ATA (6.0Gb/s), NC | Q enabled |
| | Synchronous Transfer Rate (Maximum) | Up to 6.0 Gb/s* | |
| | Buffer | 64MB | |
| | Seek Time (typical reads, | Single Track | 0.6 ms* |
| | includes controller | Average | 11 ms* |
| | overhead, including settling) | Full Stroke | Not Specified* |
| | Rotational Speed | 7,200 rpm | |
| | Operating Temperature | 41° to 140° F (5° to 60° | C) |
| | *Actual performance may | vary. | |
| | | | |

HP Z6 G4 Workstation

Technical Specifications - Hard Drives

| 1TB SATA 7200 rpm | Capacity | 1TB | | |
|--------------------|--|--------------------------|----------------|--|
| 6Gb/s 3.5" HDD | Protocol | SATA | | |
| (Enterprise Class) | Form Factor | 3.5" | | |
| | Controller | AHCI | | |
| | Reliability (MTBF) | 2.0M hours | | |
| | Rated Power On Hours | 8760/yr | | |
| | Annualized Failure Rate (based on Rated POH) | <0.62% YES | | |
| | Rated for 24/7/365 operation | | | |
| | Physical Size (Height) | 1 in; 2.54 cm | | |
| | Physical Size (Width) | 4 in; 10.17 cm | | |
| | Media Diameter | 3.5 in; 8.9 cm | | |
| | Interface | Serial ATA (6Gb/s), NCQ | enabled | |
| | Synchronous Transfer Rate (Maximum) | Up to 600MB/s* | | |
| | Buffer | 128MB | | |
| | Seek Time (typical reads, | Single Track | 0.32ms* | |
| | includes controller | Average | 7.45ms* | |
| | overhead, including settling) | Full Stroke | 14.2ms* | |
| | Operating Temperature | 41° to 140° F (5° to 60° | C) | |
| | Performance | Sequential Read | up to 226MB/s* | |
| | | Sequential Write | up to 226MB/s* | |
| | Enterprise Class Features | High Reliability | | |
| | *Actual porformanco may | varv | | |



| | 5ATA 7200 rpm | Capacity | 4TB | |
|---------|-----------------|--|--|-----------------------------------|
| | s 3.5" HDD | Height | 0.275 in; 0.7 cm | |
| (Ente | erprise Class) | Width | Media Diameter | 2.5 in; 6.36 cm |
| | | | Physical Size | 2.75 in; 6.99 cm |
| | | Interface | Serial ATA (6Gb/s), NO | Q enabled |
| | | Synchronous Transfer Rate (Maximum) | Up to 600MB/s* | |
| | | Buffer | 128MB | |
| | | Seek Time (typical reads, | Single Track | 0.7ms* |
| | | includes controller | Average | 8.5ms* |
| | | overhead, including settling) | Full Stroke | 15.7ms* |
| | | Rotational Speed | 7,200 rpm | |
| | | Operating Temperature | 32° to 140° F (0° to 60 |)° C) |
| | | *Actual performance may | vary. | |
| 500G | B SATA 7.2K SED | Capacity | 500GB | |
| SFF H | | Height | 0.275 in; 0.7 cm | |
| SFF NUU | | Width | Media Diameter | 2.5 in; 6.36 cm |
| | | | | |
| | | | Physical Size | 2.75 in: 6.99 cm |
| | | Interface | Physical Size Serial ATA (6Gb/s) | 2.75 in; 6.99 cm |
| | | Interface Synchronous Transfer Rate (Maximum) | - | 2.75 in; 6.99 cm |
| | | Synchronous Transfer | Serial ATA (6Gb/s) | 2.75 in; 6.99 cm |
| | | Synchronous Transfer Rate (Maximum) Buffer Seek Time (typical reads, | Serial ATA (6Gb/s) Up to 600MB/s* | 2.75 in; 6.99 cm 1ms* |
| | | Synchronous Transfer Rate (Maximum) Buffer Seek Time (typical reads, includes controller | Serial ATA (6Gb/s) Up to 600MB/s* 32MB | |
| | | Synchronous Transfer Rate (Maximum) Buffer Seek Time (typical reads, | Serial ATA (6Gb/s) Up to 600MB/s* 32MB Single Track | 1ms* |
| | | Synchronous Transfer Rate (Maximum) Buffer Seek Time (typical reads, includes controller overhead, including | Serial ATA (6Gb/s) Up to 600MB/s* 32MB Single Track Average | 1ms* 4.2ms* |
| | | Synchronous Transfer Rate (Maximum) Buffer Seek Time (typical reads, includes controller overhead, including settling) | Serial ATA (6Gb/s) Up to 600MB/s* 32MB Single Track Average Full Stroke | 1ms* 4.2ms* 25ms (typical)* |

| SATA SSDs for HP | HP 256GB SATA 6Gb/s | Capacity | 256GB | |
|------------------|---------------------|---|--------------------------|-----------------|
| Workstations | SSD | Protocol | SATA | |
| | | Form Factor | 2.5" | |
| | | Controller | AHCI | |
| | | NAND Type | 3D TLC | |
| | | Endurance | 192TBW (TB Written) | |
| | | Reliability (MTTF) | 1.5M hours | |
| | | Physical Size (Height) | 0.28 in; 0.7 cm | |
| | | Physical Size (Width) | 2.5 in; 6.36 cm | |
| | | Interface | SATA 6Gb/s | |
| | | Synchronous Transfer Rate (Maximum) | Up to 600MB/s* | |
| | | Operating Temperature | 32° to 158° F (0° to 70° | ° C) |
| | | Performance | Sequential Read | 530MB/s (max)* |
| | | | Sequential Write | 500MB/s (max)* |
| | | | Random Read | 95K IOPS (max)* |
| | | | Random Write | 83K IOPS (max)* |
| | | *Actual performance may | vary. | |
| | HP 256GB SATA 6Gb/s | Capacity | 256GB | |
| | SED Opal 2 SSD | Protocol | SATA | |
| | | Form Factor | 2.5" | |
| | | Controller | AHCI | |
| | | NAND Type | 3D TLC | |
| | | Endurance | 192TBW (TB Written) | |
| | | Reliability (MTTF) | 1.5M hours | |
| | | Physical Size (Height) | 0.28 in; 0.7 cm | |
| | | Physical Size (Width) | 2.5 in; 6.36 cm | |
| | | Interface | 6Gb/s SATA | |
| | | Synchronous Transfer Rate (Maximum) | Up to 550MB/s (Seque | ntial Read)* |
| | | Operating Temperature | 32° to 158° F (0° to 70° | ° C) |
| | | Performance | Sequential Read | 530MB/s* |
| | | | Sequential Write | 500 MB/s* |
| | | | Random Read | 95K IOPS* |
| | | | Random Write | 83K IOPS* |
| | | Self-Encrypting Drive Support | OPAL 2 | |
| | | *Actual performance may | vary. | |
| | HP 512GB SATA 6Gb/s | Capacity | 512GB | |
| | SSD | Protocol | SATA | |
| | | Form Factor | 2.5" | |
| | | Controller | AHCI | |
| | | NAND Type | 3D TLC | |
| | | Endurance | 388TBW (TB Written) | |
| | | | | |

| Netriabulty (MT Ir) 1.5M HOUS Physical Size (Width) 0.28 in; 0.7 cm Physical Size (Width) 2.5 in; 6.36 cm Interface SATA 6Gb/S Synchronous Transfer Vp to 550MB/S (Sequential Read)* Rate (Maximum) 2° to 158° F (0° to 70° C) Operating Temperature Sequential Write 500 MB/s* Random Read 95K I0P5* "Actual performance may usure 321 KD Protocol SATA Form Factor 2.5" Controller AHCI NAND Type 3D TLC Endurance SATA 6Gb/S Synchronous Transfer Physical Size (Width) 1.5M hours - Physical Size (Width) 2.5 in; 6.36 cm Interface SATA 6Gb/S Synchronous Transfer Protocol Not signeric Sequential Read 95K I0P5* Random Read 95K I0P5* Random Krite S30 MB/s* </th <th></th> <th></th> <th>1 FM harma</th> <th></th> | | | 1 FM harma | |
|---|-----------------------|------------------------------|----------------------------------|--------------|
| Physical Size (Width)2.5 in; 6.36 cm | | Reliability (MTTF) | 1.5M hours | |
| InterfaceSATA 66b/sVarionous Transf Rate (Maximum)2° to 150° F (0° to 70° -Performance2° to 150° F (0° to 70° -PerformanceSequential Read30 MB/s"Sequential Write500 MB/s500 MB/s"PerformanceSequential Read95K 109° 50*Actual performance may-v-v-Random Read95K 109° 50ProtocolSATA 5ED 50Capacity512GSProtocolSATA 5ED 50Capacity512GSProtocolSATA 5ED 50ControllerAHCINAD Type308 TBW (TB Writter)-Reliability (MTF)1.5M hours-Reliability (MTF)0.28 in; 0.7 cm-Physical Size (Height)0.28 in; 0.3 cm-Synchronous Transfe0 co 80MB/s*-Synchronous Transfe100 cm50 0MB/s*Synchronous TransfeSequential Read95K 109° 51Performance22° to 158° F (0° to 70°Performance12° to 158° F (0° to 70°Reitability (MTF)15% 100 cm-Nand Read95K 109° 51-Performance12° to 158° F (0° to 70°Performance12° to 158° F (0° to 70°Performance12° to 158° F (0° to 70°Reitability (MTF)15% 10° to 10°Performance21° to 158° F (0° to 70°Performance21° to 158° F (0° to 70°Performance21° to 158° F (0° to 70°Performance21° to 15 | | | | |
| Synchronous Transfer Rate (Maximum)Up to 550MB/s (Sequential Read)*Operating Temperature PerformanceSequential Read Sequential Read500 MB/s* Sequential WritePerformanceSequential Read Sequential Write500 MB/s* Sequential WriteRandom Read Portocol95K 10P5* Random Write95K 10P5* Random WriteProtocolS12GB95K 10P5* Random WriteProtocolS12GB | | - | | |
| Rate (Maximum)32° to 158° F (0° to 70° C)PerformanceSequential Read530 MB/s*Sequential Write500 MB/s*Random Read95K IOPS*Random Write83K IOPS**Actual performance may varv*HP 512GB SATA SED SSDCapacity512GBProtocolSATAForm Factor2.5"ControllerHCINAND Type30 TLCEndurance388TBW (TB Written)Reliability (MTTF)1.5M hoursPhysical Size (Height)0.28 in; 0.7 cmPhysical Size (Height)0.28 in; 0.7 cmInterfaceSATA 66b/sSynchronous Transfer Rate (Maximum)32° to 158° F (0° to 70° C)PerformanceSequential ReadSon MB/s*Sequential ReadSight Portonous Transfer Rate (Maximum)32° to 158° F (0° to 70° C)PerformanceSequential ReadSupport500 MB/s*SupportSequential ReadSupport330 MB/s*SupportSequential ReadSupport95K IOPS*Random Write33K IOPS*Random Read95K IOPS*Random Write33K IOPS*SupportSupportProtocolSataSupportSupportProtocolSataPhysical Size (Height)35K IOPS*Random Read95K IOPS*Random Read95K IOPS*Random Read95K IOPS*Random Read95K IOPS*Rate (Maximum)Sata Gata <t< th=""><th></th><th></th><th colspan="2"></th></t<> | | | | |
| Performance Sequential Read 530 MB/s* Sequential Write 500 MB/s* Random Read 95K 10P5* Random Write 83K 10P5* Random Write 83K 10P5* *Actual performance may varve 83K 10P5* *Actual performance may varve 83K 10P5* *Actual performance may varve 83K 10P5* *Protocol SATA Form Factor 2.5° Controller AHCI NAND Type 3D TLC Endurance 3887BW (TB Written) Physical Size (Height) 0.28 in; 0.7 cm Physical Size (Width) 2.5 in; 6.36 cm Interface SATA 660/s Synchronous Transfer Rate (Maximum) Up to 600MB/s* Operating Temperature Sequential Read 530 MB/s* Support 32* to 158° F (0° to 70° C) Performance Sequential Read 530 MB/s* Support 32* to 158° F (0° to 70° C) Performance Sequential Read 530 MB/s* Support 32* to 158° F (0° to 70° C) Performance Sequential Read 500 MB/s* Random Write 83K 10P5* Random Write 83K 10P5* Random Write 83K 10P5* Random Write | | | Up to 550MB/s (Sequential Read)* | |
| Sequential Write 500 MB/s* Sequential Write 95K 10P5* Random Read 95K 10P5* Random Write 83K 10P5* *Actual performance may-ur- 83K 10P5* Protocol SATA Protocol SATA Form Factor 2.5" Controller AHCI NAND Type 3D TLC Endurance 388TBW (TB Written) Reliability (MTTF) 1.5M hours Physical Size (Height) 0.28 in; 0.7 cm Physical Size (Width) 2.5 in; 6.36 cm Synchronous Transfer Up to 600MB/s* Synchronous Transfer Up to 600MB/s* Performance Sequential Write Support 32° to 158° F (0° to 70° U Performance Sequential Write Support 32% to 158° F (0° to 70° U Performance Sequential Write 308 MB/s* Random Write 95K 10P5* Random Write 95K 10P5* Random Write 95K 10P5* Random Write 95K 10P5* Reliability (MTTF) 1.5M hours Protocol <th></th> <th>Operating Temperature</th> <th>32° to 158° F (0° to 70°</th> <th>C)</th> | | Operating Temperature | 32° to 158° F (0° to 70° | C) |
| Name 951095 *Actual performance may 331208 *Actual performance may 312GB FP 512GB SATA SED SSD Capacity 512GB Protocol SATA 512GB Form Factor 2.5" Cause 1000000000000000000000000000000000000 | | Performance | Sequential Read | 530 MB/s* |
| Random Write B3K IOP5* *Actual performance may-vertor *Actual performance may-vertor HP 512GB SATA SED SSD Capacity 512GB Protocol SATA SATA Form Factor 2.5° | | | Sequential Write | 500 MB/s* |
| *Actual performance may variable Enter 2 HP 512GB SATA SED SSD Capacity S12GB Protocol SATA Form Factor 2.5" Controller AHCI NAND Type 3D TLC Endurance 388TBW (TB Written) Reliability (MTF) 1.5M hours Physical Size (Height) 0.28 in; 0.37 cm Physical Size (Width) 2.5 in; 6.36 cm Interface SATA 6Gb/s Synchronous Transfer Rate (Maximum) Up to 600MB/s* Operating Temperature S2° to 158° F (0° to 70° - V Performance Sequential Read 530 MB/s* Sequential Read 530 MB/s* Support 22° to 158° F (0° to 70° - V Performance S2° to 158° F (0° to 70° - V Random Read 95K 1095* Random Read 55K 1095* Random Read 95K 1095* Random Read 95K 1095* Random Read 95K 1095* Readom Read 95K 1095* Readom Read 95K 1095* Readom Read 95K 1095* Readom Read 95K 1095* <th></th> <th></th> <th>Random Read</th> <th>95K IOPS*</th> | | | Random Read | 95K IOPS* |
| HP 512GB SATA SED SSD Capacity 512GB Protocol SATA Form Factor 2.5" Controller AHCI NAND Type 3D TLC Endurance 388TBW (TB Written) Reliability (MTTF) 1.5M hours Physical Size (Height) 0.28 in; 0.7 cm Physical Size (Width) 2.5 in; 6.36 cm Synchronous Transfer Rate (Maximum) Up to 600MB/s* Operating Temperature Performance 2° to 158° F (0° to 70° C) Performance Sequential Read S30 MB/s* Self-Encrypting Drive Support OPAL 1 and 2 *Actual performance may Pritocol Settige formance SATA Protocol SATA Protocol SATA Random Write 38 K 10PS* Reliability (MTTF) 1.5M hours HP 1TB SATA 6Gb/s SSD Capacity< | | | Random Write | 83K IOPS* |
| ProtocolSATAForm Factor2.5"ControllerAHCINAND Type3D TLCEndurance388TBW (TB Written)Reliability (MTTF)1.5M hoursPhysical Size (Height)0.28 in; 0.7 cmPhysical Size (Width)2.5 in; 6.36 cmInterfaceSATA 6Gb/sSynchronous Transfer Rate (Maximum)Up to 600MB/s*Operating Temperature32° to 158° F (0° to 70° ·PerformanceSequential Read530 MB/s*Self-Encrypting DriveSequential Read530 MB/s*Self-Encrypting DriveOPAL 1 and 295K 1095*Random Read Support3ATA35K 1095*Actual performance maySATA500 MB/s*PerformanceSATA500 MB/s*Random Read Support95K 1095*35K 1095*ProtocolSATA500 MB/s*Reliability (MTFF)1.5M hours | | *Actual performance may v | /ary. | |
| Form Factor2.5"ControllerAHCINAND Type3D TLCEndurance388TBW (TB Written)Reliability (MTTF)1.5M hoursPhysical Size (Height)0.28 in; 0.7 cmPhysical Size (Width)2.5 in; 6.36 cmInterfaceSATA 6Gb/5Synchronous Transfer Rate (Maximum)Up to 600MB/s*Performance32° to 158° F (0° to 70° C)PerformanceSequential Read530 MB/s*SupportSequential Read530 MB/s*Random Read95K 10PS*8andom ReadSupport0PAL 1 and 235K 10PS**Actual performance may2.5"30 KI0PS*Support*Actual performance may54K 10PS**Actual performance may5.5"30 KI0PS*ProtocolSATA54TAForm Factor2.5"30 KI0PS*Random Kread95K 10PS*Random Write33K 10PS*Support*Actual performance may*Actual performance may5.5"ProtocolSATAForm Factor2.5"ControllerAHCINAND Type3D TLCEndurance400TBW (TB Written)Reliability (MTTF)1.5M hoursPhysical Size (Height)0.28 in; 0.7 cmPhysical Size (Height)0.28 in; 0.7 cmPhysical Size (Height)0.28 in; 0.36 cmInterfaceSATA 66b/sSynchronous Transfer Ret (Maximum)Satin 6.36 cm | HP 512GB SATA SED SSD | Capacity | 512GB | |
| Image: ControllerAHCNAND Type3D TLCEndurance3887BW(TBWritter)Reliability(MTF)1.5M hoursPhysical Size (Height)0.28 in; 0.7 cmPhysical Size (Weidth)2.5 in; 6.36 cmPhysical Size (Weidth)2.5 in; 6.36 cmPhysical Size (Weidth)2.5 in; 6.36 cmSynchronous Transfre Rate (Maximum)30' 00H/s*Operating Temperatur Rate (Maximum)30' 01H/s*PerformanceSequential Read Sol 00H/s*PerformanceSequential Read Sol 00H/s*Random Read Support95K 10PS*Rate (Dereting Temperatur Support02H 1 and 2*Actural performance Support2.5" and 2.5" and | | Protocol | SATA | |
| NAND Type3D TLCEndurance388TBW (TB Written)Reliability (MTTF)1.5M hoursPhysical Size (Height)0.28 in; 0.7 cmPhysical Size (Width)2.5 in; 6.36 cmInterfaceSATA 6Gb/sSynchronous Transfer Rate (Maximum)Up to 6000MB/s*Operating Temperature32° to 158° F (0° to 70° UPerformanceSequential Read530 MB/s*Rate (Maximum)32° to 158° F (0° to 70° UPerformanceSequential Read530 MB/s*Random Read95K 10PS*800 MB/s*Random Write30X K 10PS*Self-Encrypting Drive SupportSATA*Actual performance may: support**Actual performance may: ControllerAHClForm Factor2.5"ControllerAHClMAND Type3D TLCEndurance Reliability (MTTF)1.5M hoursPhysical Size (Height)0.28 in; 0.7 cmPhysical Size (Height)0.28 in; 0.7 cmPhysical Size (Width)2.5 in; 6.36 cmInterfaceSATA 6Gb/sSynchronous Transfer Rate (Maximum)Up to 550MB/s (Sequential Read)* [Read)* | | Form Factor | 2.5" | |
| Findurance388TBW (TB Written)Reliability (MTTF)1.5M hoursPhysical Size (Height)0.28 in; 0.7 cmPhysical Size (Width)2.5 in; 6.36 cmInterfaceSATA 6Gb/sSynchronous Transfer Rate (Maximum)Up to 6000MB/s*Operating Temperature32° to 158° F (0° to 70° C)PerformanceSequential Read530 MB/s*PerformanceSequential Read95K 10PS*Random Read95K 10PS*8816 PEncrypting DriveSequential ReadSelf-Encrypting DriveSetf-Encrypting DriveSATASupportAradom Write95K 10PS**Actual performance may: support3ATA*Actual performance may: SupportSATAForm Factor2.5"ControllerAHClNAND Type3D TLCEndurance400TBW (TB Written)Reliability (MTTF)1.5M hoursPhysical Size (Height)0.28 in; 0.7 cmPhysical Size (Width)2.5 in; 6.36 cmInterfaceSATA 6Gb/sSynchronous Transfer Rate (Maximum)Up to 550MB/s (Sequential Read)* [Read)* | | Controller | AHCI | |
| Reliability (MTTF)1.5M hoursPhysical Size (Height)0.28 in; 0.7 cmPhysical Size (Width)2.5 in; 6.36 cmInterfaceSATA 6Gb/sSynchronous Transfer Rate (Maximum)Up to 600MB/s*Operating Temperature32° to 158° F (0° to 70° UPerformanceSequential Read530 MB/s*Random Read95K 10PS*Random Write83K 10PS*Random Write83K 10PS*Self-Encrypting Drive Support0PAL 1 and 2*Actual performance may: *Actual performance may: *Actual performanceSTAProtocolSATAForm Factor2.5"ControllerAHCINAND Type3D TLCEndurance400TBW (TB Written)Reliability (MTTF)1.5M hoursPhysical Size (Height)0.28 in; 0.7 cmPhysical Size (Width)2.5 in; 6.36 cmInterfaceSATA 6Gb/sSynchronous Transfer Ret (Maximum)Up to 550MB/s (Sequ=ti-Read)* | | NAND Type | 3D TLC | |
| Physical Size (Height)0.28 in; 0.7 cmPhysical Size (Width)2.5 in; 6.36 cmPhysical Size (Width)2.5 in; 6.36 cmInterfaceSATA 6Gb/sSynchronous Transfer Rate (Maximum)Up to 600MB/s*Operating Temperature Performance20° to 158° F (0° to 70° UPerformanceSequential Read Sequential WritePerformanceSequential Write Random WriteSelf-Encrypting Drive Support0PA L1 and 2*Actual performance may: *Actual performance may: *Actual performance1TBProtocolSATAProtocolSATAForm Factor2.5°"ControllerAHCINAND Type3D TLCEndurance400TBW (TB Written)Reliability (MTTF)1.5M hoursPhysical Size (Height)0.28 in; 0.7 cmPhysical Size (Midth)2.5 in; 6.36 cmInterfaceSATA 6Gb/sSynchronous Transfer Ret (Maximum)Up to 550MB/s (Seque:) - Keat)* | | Endurance | 388TBW (TB Written) | |
| Physical Size (Height)0.28 in; 0.7 cmPhysical Size (Width)2.5 in; 6.36 cmPhysical Size (Width)2.5 in; 6.36 cmInterfaceSATA 6Gb/sSynchronous Transfer Rate (Maximum)Up to 600MB/s*Operating Temperature Performance20° to 158° F (0° to 70° UPerformanceSequential Read Sequential WritePerformanceSequential Write Random WriteSelf-Encrypting Drive Support0PA L1 and 2*Actual performance may: *Actual performance may: *Actual performance1TBProtocolSATAProtocolSATAForm Factor2.5°"ControllerAHCINAND Type3D TLCEndurance400TBW (TB Written)Reliability (MTTF)1.5M hoursPhysical Size (Height)0.28 in; 0.7 cmPhysical Size (Midth)2.5 in; 6.36 cmInterfaceSATA 6Gb/sSynchronous Transfer Ret (Maximum)Up to 550MB/s (Seque:) - Keat)* | | Reliability (MTTF) | 1.5M hours | |
| Physical Size (Width)2.5 in; 6.36 cmInterfaceSATA 6Gb/sSynchronous Transfer Rate (Maximum)Up to 600MB/s*Operating Temperature Performance32° to 158° F (0° to 70° ∪PerformanceSequential Read530 MB/s*Sequential Write500 MB/s*Random Read95K 10PS*Random Write83K 10PS*Support0PAL 1 and 2*Actual performance may0PAL 1 and 2*Actual performance maySATAProtocolSATAForm Factor2.5°ControllerAHClNAND Type3D TLCEndurance400TBW (TB Written)Physical Size (Height)0.28 in; 0.7 cmPhysical Size (Width)2.5 in; 6.36 cmInterfaceSATA 6Gb/sSynchronous Transfer Rate (Maximum)Up to 550MB/s (Seque: Leave)* | | Physical Size (Height) | 0.28 in; 0.7 cm | |
| InterfaceSATA 6Gb/sUp to 600MB/s*Synchronous Transfer Rate (Maximum)Up to 600MB/s*Operating Temperature32° to 158° F (0° to 70° UPerformanceSequential Read530 MB/s*Sequential Write500 MB/s*Sequential Write500 MB/s*Random Read95K I0PS*Random Read95K I0PS*Random Write83K I0PS*Support0PAL 1 and 2*Actual performance may:V*Actual performance may:NPAL 1 and 2ProtocolSATAForm Factor2.5°ControllerAHClNAND Type3D TLCEndurance400TBW (TB Written)Physical Size (Height)0.28 in; 0.7 cmPhysical Size (Width)2.5 in; 6.36 cmPhysical Size (Width)2.5 in; 6.36 cmInterfaceSATA 6Gb/s | | | | |
| Rate (Maximum)Operating Temperature32° to 158° F (0° to 70° · · ·PerformanceSequential Read530 MB/s*PerformanceSequential Write500 MB/s*Random Read95K IOPS*8andom WriteRandom Write83K IOPS*Random Write83K IOPS*Support0PAL 1 and 2*Actual performance may:***Actual performance may:**ProtocolSATAForm Factor2.5"ControllerAHCINAND Type3D TLCEndurance400TBW (TB Written)Reliability (MTTF)1.5M hoursPhysical Size (Width)2.5 in; 6.36 cmPhysical Size (Width)2.5 in; 6.36 cmInterfaceSATA 6Gb/sSynchronous Transfer Rate (Maximum)Up to 550MB/s (Sequ=:L Eead)* | | - | | |
| PerformanceSequential Read530 MB/s*Sequential Write500 MB/s*Sequential Write500 MB/s*Random Read95K I0PS*Random Write83K I0PS*Self-Encrypting Drive Support0PAL 1 and 2*Actual performance may varv0PAL 1 and 2*Actual performance may varv1TBProtocolSATAForm Factor2.5"ControllerAHCINAND Type3D TLCEndurance400TBW (TB Written)Reliability (MTTF)1.5M hoursPhysical Size (Height)0.28 in; 0.7 cmPhysical Size (Width)2.5 in; 6.36 cmInterfaceSATA 6Gb/sSynchronous Transfer Rate (Maximum)Up to 550MB/s (Sequential Read)* | | • | Up to 600MB/s* | |
| Sequential Write500 MB/s* Random ReadRandom Read95K 10PS* Random Write95K 10PS* 83K 10PS*Self-Encrypting Drive Support0PAL 1 and 2*Actual performance may-vary.0PAL 1 and 2HP 1TB SATA 6Gb/s SSDCapacity1TBProtocolSATAForm Factor2.5"ControllerAHCINAND Type3D TLCEndurance400TBW (TB Written)Reliability (MTTF)1.5M hoursPhysical Size (Height)0.28 in; 0.7 cmPhysical Size (Width)2.5 in; 6.36 cmInterfaceSATA 6Gb/sSynchronous Transfer Rate (Maximum)Up to 550MB/s (Sequential Read)* | | Operating Temperature | 32° to 158° F (0° to 70° | C) |
| Andom Read Random Write95K 10PS* 83K 10PS*Self-Encrypting Drive Support0PAL 1 and 2*Actual performance may *Actual performance may0PAL 1 and 2*Actual performance may *Actual performance may1TBProtocolSATAForm Factor2.5"ControllerAHCINAND Type3D TLCEndurance400TBW (TB Written)Reliability (MTTF)1.5M hoursPhysical Size (Height)0.28 in; 0.7 cmPhysical Size (Width)2.5 in; 6.36 cmInterfaceSATA 6Gb/sSynchronous Transfer Ret (Maximum)Up to 550MB/s (Sequertial Read)* | | Performance | Sequential Read | 530 MB/s* |
| Random Write83K IOPS*Self-Encrypting Drive SupportOPAL 1 and 2*Actual performance may*Actual performance may*Actual performance may*TB*Actual performance maySATAProtocolSATAForm Factor2.5"ControllerAHCINAND Type3D TLCEndurance400TBW (TB Written)Reliability (MTTF)1.5M hoursPhysical Size (Height)0.28 in; 0.7 cmPhysical Size (Width)2.5 in; 6.36 cmInterfaceSATA 6Gb/sSynchronous Transfer Rete (Maximum)Up to 550MB/s (Sequential Read)* | | | Sequential Write | 500 MB/s* |
| Self-Encrypting Drive supportOPAL 1 and 2*Actual performance may- *Actual performance may- TotocolTBProtocolSATAProtocolSATAForm Factor2.5"ControllerAHCINAND Type3D TLCEndurance400TBW(TBWitten)Reliability (MTTF)1.5M hoursPhysical Size (Height)0.28 in; 0.7 cmPhysical Size (Width)2.5 in; 6.36 cmInterfaceSATA 6Gb/sSynchronous TransferUp to 550MB/s (Sequential Read)* | | | Random Read | 95K IOPS* |
| Support*Actual performance may vary.HP 1TB SATA 6Gb/s SSDCapacity1TBProtocolSATAProtocolSATAForm Factor2.5"ControllerAHCINAND Type3D TLCEndurance400TBW (TB Written)Reliability (MTTF)1.5M hoursPhysical Size (Height)0.28 in; 0.7 cmPhysical Size (Width)2.5 in; 6.36 cmInterfaceSATA 6Gb/sSynchronous Transfer Rate (Maximum)Up to 550MB/s (Sequential Read)* | | | Random Write | 83K IOPS* |
| HP 1TB SATA 6Gb/s SSDCapacity1TBProtocolSATAProtocolSATAForm Factor2.5"ControllerAHCINAND Type3D TLCEndurance400TBW (TB Written)Reliability (MTTF)1.5M hoursPhysical Size (Height)0.28 in; 0.7 cmPhysical Size (Width)2.5 in; 6.36 cmInterfaceSATA 6Gb/sSynchronous Transfer Rate (Maximum)Up to 550MB/s (Sequential Read)* | | | OPAL 1 and 2 | |
| ProtocolSATAForm Factor2.5"ControllerAHCINAND Type3D TLCEndurance400TBW (TB Written)Reliability (MTTF)1.5M hoursPhysical Size (Height)0.28 in; 0.7 cmPhysical Size (Width)2.5 in; 6.36 cmInterfaceSATA 6Gb/sSynchronous Transfer Rate (Maximum)Up to 550MB/s (Sequential Read)* | | *Actual performance may v | /ary. | |
| Form Factor2.5"ControllerAHCINAND Type3D TLCEndurance400TBW (TB Written)Reliability (MTTF)1.5M hoursPhysical Size (Height)0.28 in; 0.7 cmPhysical Size (Width)2.5 in; 6.36 cmInterfaceSATA 6Gb/sSynchronous Transfer Rate (Maximum)Up to 550MB/s (Sequential Read)* | HP 1TB SATA 6Gb/s SSD | Capacity | 1TB | |
| ControllerAHCINAND Type3D TLCEndurance400TBW (TB Written)Reliability (MTTF)1.5M hoursPhysical Size (Height)0.28 in; 0.7 cmPhysical Size (Width)2.5 in; 6.36 cmInterfaceSATA 6Gb/sSynchronous Transfer Rate (Maximum)Up to 550MB/s (Sequential Read)* | | Protocol | SATA | |
| NAND Type3D TLCEndurance400TBW (TB Written)Reliability (MTTF)1.5M hoursPhysical Size (Height)0.28 in; 0.7 cmPhysical Size (Width)2.5 in; 6.36 cmInterfaceSATA 6Gb/sSynchronous Transfer Rate (Maximum)Up to 550MB/s (Sequential Read)* | | Form Factor | 2.5" | |
| Endurance400TBW (TB Written)Reliability (MTTF)1.5M hoursPhysical Size (Height)0.28 in; 0.7 cmPhysical Size (Width)2.5 in; 6.36 cmInterfaceSATA 6Gb/sSynchronous Transfer Rate (Maximum)Up to 550MB/s (Sequential Read)* | | Controller | AHCI | |
| Reliability (MTTF)1.5M hoursPhysical Size (Height)0.28 in; 0.7 cmPhysical Size (Width)2.5 in; 6.36 cmInterfaceSATA 6Gb/sSynchronous Transfer Rate (Maximum)Up to 550MB/s (Sequential Read)* | | NAND Type | 3D TLC | |
| Physical Size (Height)0.28 in; 0.7 cmPhysical Size (Width)2.5 in; 6.36 cmInterfaceSATA 6Gb/sSynchronous Transfer Rate (Maximum)Up to 550MB/s (Sequential Read)* | | Endurance | 400TBW (TB Written) | |
| Physical Size (Width)2.5 in; 6.36 cmInterfaceSATA 6Gb/sSynchronous Transfer Rate (Maximum)Up to 550MB/s (Sequential Read)* | | Reliability (MTTF) | 1.5M hours | |
| Interface SATA 6Gb/s Synchronous Transfer Up to 550MB/s (Sequential Read)* Rate (Maximum) | | Physical Size (Height) | 0.28 in; 0.7 cm | |
| Synchronous Transfer Up to 550MB/s (Sequential Read)* Rate (Maximum) | | Physical Size (Width) | 2.5 in; 6.36 cm | |
| Rate (Maximum) | | Interface | SATA 6Gb/s | |
| | | | Up to 550MB/s (Sequer | itial Read)* |
| | | Operating Temperature | 32° to 158° F (0° to 70° | C) |



| | Performance | Sequential Read Sequential Write Random Read | 530 MB/s* 500 MB/s* 95K IOPS* |
|---------------------------------------|---|--|--|
| | | Random Write | 83K IOPS* |
| | *Actual performance may v | ary. | |
| HP 2TB SATA 6Gb/s SSD | Capacity | 2TB | |
| | Protocol | SATA | |
| | Form Factor | 2.5" | |
| | Controller | AHCI | |
| | NAND Type | 3D TLC | |
| | Endurance | 400TBW (TB Written) | |
| | Reliability (MTTF) | 1.5M hours | |
| | Physical Size (Height) | 0.28 in; 0.7 cm | |
| | Physical Size (Width) | 2.5 in; 6.36 cm | |
| | Interface | SATA 6Gb/s | |
| | Synchronous Transfer Rate (Maximum) | Up to 550MB/s (Sequen | itial Read)* |
| | Operating Temperature | 32° to 158° F (0° to 70° | C) |
| | Performance | Sequential Read | 530 MB/s* |
| | | Sequential Write | 500 MB/s * |
| | | Random Read | 95K IOPS* |
| | | Random Write | 83K IOPS* |
| | | | |
| | *Actual performance may v | ary. | |
| HP Enterprise Class | Capacity | ary. 240GB | |
| HP Enterprise Class 240GB SATA SSD | | - | |
| - | Capacity Protocol Form Factor | 240GB | |
| - | Capacity Protocol Form Factor Controller | 240GB SATA | |
| - | Capacity Protocol Form Factor Controller NAND Type | 240GB SATA 2.5" AHCI 3D TLC | |
| - | Capacity Protocol Form Factor Controller NAND Type Endurance | 240GB SATA 2.5" AHCI 3D TLC 2,200TBW (TB Written) | |
| - | Capacity Protocol Form Factor Controller NAND Type Endurance Reliability (MTTF) | 240GB SATA 2.5" AHCI 3D TLC 2,200TBW (TB Written) 2.0M hours | |
| - | Capacity Protocol Form Factor Controller NAND Type Endurance Reliability (MTTF) Physical Size (Height) | 240GB SATA 2.5" AHCI 3D TLC 2,200TBW (TB Written) 2.0M hours 0.28 in; 0.7 cm | |
| - | Capacity Protocol Form Factor Controller NAND Type Endurance Reliability (MTTF) Physical Size (Height) Physical Size (Width) | 240GB SATA 2.5" AHCI 3D TLC 2,200TBW (TB Written) 2.0M hours 0.28 in; 0.7 cm 2.5 in; 6.36 cm | |
| - | Capacity Protocol Form Factor Controller NAND Type Endurance Reliability (MTTF) Physical Size (Height) Physical Size (Width) Interface | 240GB SATA 2.5" AHCI 3D TLC 2,200TBW (TB Written) 2.0M hours 0.28 in; 0.7 cm 2.5 in; 6.36 cm 6Gb/s SATA | |
| - | Capacity Protocol Form Factor Controller NAND Type Endurance Reliability (MTTF) Physical Size (Height) Physical Size (Width) Interface Synchronous Transfer Rate (Maximum) | 240GB SATA 2.5" AHCI 3D TLC 2,200TBW (TB Written) 2.0M hours 0.28 in; 0.7 cm 2.5 in; 6.36 cm 6Gb/s SATA Up to 600MB/s* | |
| - | Capacity Protocol Form Factor Controller NAND Type Endurance Reliability (MTTF) Physical Size (Height) Physical Size (Width) Interface Synchronous Transfer Rate (Maximum) Operating Temperature | 240GB SATA 2.5" AHCI 3D TLC 2,200TBW (TB Written) 2.0M hours 0.28 in; 0.7 cm 2.5 in; 6.36 cm 6Gb/s SATA Up to 600MB/s* | |
| - | Capacity Protocol Form Factor Controller NAND Type Endurance Reliability (MTTF) Physical Size (Height) Physical Size (Width) Interface Synchronous Transfer Rate (Maximum) | 240GB SATA 2.5" AHCI 3D TLC 2,200TBW (TB Written) 2.0M hours 0.28 in; 0.7 cm 2.5 in; 6.36 cm 6Gb/s SATA Up to 600MB/s* 32° to 158° F (0° to 70° Sequential Read | 540 MB/s* |
| - | Capacity Protocol Form Factor Controller NAND Type Endurance Reliability (MTTF) Physical Size (Height) Physical Size (Width) Interface Synchronous Transfer Rate (Maximum) Operating Temperature | 240GB SATA 2.5" AHCI 3D TLC 2,200TBW (TB Written) 2.0M hours 0.28 in; 0.7 cm 2.5 in; 6.36 cm 6Gb/s SATA Up to 600MB/s* 32° to 158° F (0° to 70° Sequential Read Sequential Write | 540 MB/s* 310 MB/s* |
| - | Capacity Protocol Form Factor Controller NAND Type Endurance Reliability (MTTF) Physical Size (Height) Physical Size (Width) Interface Synchronous Transfer Rate (Maximum) Operating Temperature | 240GB SATA 2.5" AHCI 3D TLC 2,200TBW (TB Written) 2.0M hours 0.28 in; 0.7 cm 2.5 in; 6.36 cm 6Gb/s SATA Up to 600MB/s* 32° to 158° F (0° to 70° Sequential Read Sequential Write Random Read | 540 MB/s* 310 MB/s* 93K IOPS* |
| - | Capacity Protocol Form Factor Controller NAND Type Endurance Reliability (MTTF) Physical Size (Height) Physical Size (Width) Interface Synchronous Transfer Rate (Maximum) Operating Temperature Performance | 240GB SATA 2.5" AHCI 3D TLC 2,200TBW (TB Written) 2.0M hours 0.28 in; 0.7 cm 2.5 in; 6.36 cm 6Gb/s SATA Up to 600MB/s* 32° to 158° F (0° to 70° Sequential Read Sequential Write Random Read Random Write | 540 MB/s* 310 MB/s* |
| - | Capacity Protocol Form Factor Controller NAND Type Endurance Reliability (MTTF) Physical Size (Height) Physical Size (Width) Interface Synchronous Transfer Rate (Maximum) Operating Temperature | 240GB SATA 2.5" AHCI 3D TLC 2,200TBW (TB Written) 2.0M hours 0.28 in; 0.7 cm 2.5 in; 6.36 cm 6Gb/s SATA Up to 600MB/s* 32° to 158° F (0° to 70° Sequential Read Sequential Write Random Read Random Write | 540 MB/s* 310 MB/s* 93K IOPS* 48K IOPS* |



| | HP Enterprise Class | Capacity | 480GB | |
|-----------------------|------------------------|---------------------------|---|-------------|
| | 480GB SATA SSD | Protocol | SATA | |
| | | Form Factor | 2.5" | |
| | | Controller | AHCI | |
| | | NAND Type | 3D TLC | |
| | | Endurance | 4,400TBW (TB Written) | |
| | | Reliability (MTTF) | 2.0M hours | |
| | | Physical Size (Height) | 0.28 in; 0.7 cm | |
| | | Physical Size (Width) | 2.5 in; 6.36 cm | |
| | | Interface | 6Gb/s SATA | |
| | | Synchronous Transfer | Up to 600MB/s* | |
| | | Rate (Maximum) | | |
| | | Operating Temperature | 32° to 158° F (0° to 70° | C) |
| | | Performance | Sequential Read | 540 MB/s* |
| | | | Sequential Write | 460 MB/s* |
| | | | Random Read | 93K IOPS* |
| | | | Random Write | 74K IOPS* |
| | | Enterprise Class Features | High Endurance NAND Power Loss Protection End-to-End Data Protect | tion |
| | | *Actual performance may v | | |
| | | | | |
| Performance PCIe SSDs | HP Z Turbo Drive 256GB | Capacity | 256GB | |
| for HP Workstations | M.2 2280 TLC SSD | Protocol | PCle | |
| | | Form Factor | M.2 | |
| | | Controller | NVMe | |
| | | NAND Type | 3D TLC | |
| | | SED Support | Opal 2 | |
| | | Endurance | 200TB | |
| | | Reliability (MTBF) | 1.5M hours | |
| | | Interface | PCI Express 3.0 x4 elect | |
| | | Operating Temperature | 32° to 158° F (0° to 70° | |
| | | Performance | Sequential Read | 3500 MB/s * |
| | | | Sequential Write | 2200 MB/s * |
| | | | Random Read | 240K IOPS * |
| | | MALL ALL CONTRACTOR | Random Write | 480K IOPS * |
| | | *Actual performance may v | ary. | |
| | HP ZTurbo Drive 512GB | Capacity | 512GB | |
| | M.2 2280 TLC SSD | Protocol | PCIe | |
| | | Form Factor | M.2 | |
| | | Controller | NVMe | |
| | | NAND Type | 3D TLC | |
| | | SED Support | Opal 2 | |
| | | Endurance | 300TB | |
| | | | | |



| | | 1 FM h auma | |
|-------------------------|------------------------------|--------------------------|--------------------|
| | Reliability (MTBF) | 1.5M hours | |
| | Interface | PCI Express 3.0 x4 elect | |
| | Operating Temperature | 32° to 158° F (0° to 70° | - |
| | Performance | Sequential Read | 3500 MB/s* |
| | | Sequential Write | 2900 MB/s* |
| | | Random Read | 460 K IOPS* |
| | | Random Write | 500K IOPS* |
| | *Actual performance may v | /ary. | |
| HP ZTurbo Drive 1TB M.2 | Capacity | 1TB | |
| 2280 TLC SSD | Protocol | PCIe | |
| | Form Factor | M.2 | |
| | Controller | NVMe | |
| | NAND Type | 3 D TLC | |
| | SED Support | Opal 2 | |
| | Endurance | 400TB | |
| | Reliability (MTBF) | 1.5M hours | |
| | Interface | PCI Express 3.0 x4 elect | trical x4 physical |
| | Operating Temperature | 32° to 158° F (0° to 70° | C) |
| | Performance | Sequential Read | 3500 MB/s* |
| | | Sequential Write | 3000 MB/s* |
| | | Random Read | 580K IOPS* |
| | | Random Write | 500K IOPS* |
| | *Actual performance may | /ary. | |
| HP ZTurbo Drive 2TB M.2 | Capacity | 2TB | |
| 2280 TLC SSD | Protocol | PCIe | |
| | Form Factor | M.2 | |
| | Controller | NVMe | |
| | NAND Type | 3D TLC | |
| | SED Support | Opal 2 | |
| | Endurance | 500TB | |
| | Reliability (MTTF) | 1.5M hours | |
| | Interface | PCI Express 3.0 x4 elect | trical x4 nhysical |
| | Operating Temperature | 32° to 158° F (0° to 70° | |
| | Performance | Sequential Read | 3300 MB/s* |
| | | Sequential Write | 2400 MB/s* |
| | | Random Read | 500K IOPS* |
| | | Random Write | 440K IOPS* |
| | *Actual performance may | | |
| | | | |
| HP Z Turbo Drive Quad | Capacity | 512GB | |
| Pro 2x256GB PCIe TLC | Protocol | PCIe | |
| SSD | – – . | | |

Form Factor

PCIe Card, Full Height PCIe Slot



| Controller | NVMe | |
|-----------------------|--------------------------|------------|
| NAND Type | 3D TLC | |
| SED Support | Opal 2 | |
| Endurance | 200TB | |
| Reliability (MTBF) | 1.5M hours | |
| Interface | PCIe Gen3 x4 architect | ure |
| Operating Temperature | 32° to 158° F (0° to 70° | ' C) |
| Performance | Sequential Read | 3500 MB/s* |
| | Sequential Write | 2200 MB/s* |
| | Random Read | 240K IOPS* |
| | Random Write | 480K IOPS* |

*Actual performance may vary.

| HP Z Turbo Drive Quad |
|-----------------------|
| Pro 2x512GB PCIe TLC |
| SSD |

| Capacity | 1TB | | |
|------------------------------|--------------------------|-------------|--|
| Protocol | PCle | | |
| Form Factor | PCIe Card, Full Height F | Cle Slot | |
| Controller | NVMe | | |
| NAND Type | 3D TLC | | |
| SED Support | Opal 2 | | |
| Endurance | 300TB | | |
| Reliability (MTBF) | 1.5M hours | | |
| Interface | PCle Gen3 x4 architect | ure | |
| Operating Temperature | 32° to 158° F (0° to 70° | C) | |
| Performance | Sequential Read | 3500 MB/s* | |
| | Sequential Write | 2900 MB/s* | |
| | Random Read | 460 K IOPS* | |
| | Random Write | 500K IOPS* | |

*Actual performance may vary.

| HP Z Turbo Drive Quad Pro | Capacity | 2TB | |
|---------------------------|-----------------------|--|------------|
| 2x1TB PCIe TLC SSD | Protocol | PCle | |
| | Form Factor | PCIe Card, Full Height PCIe Slot | |
| | Controller | NVMe | |
| | NAND Type | 3D TLC | |
| | SED Support | Opal 2 | |
| | Endurance | 400TB PCI Express 3.0 x4 electrical x4 ph | |
| | Interface | | |
| | Operating Temperature | 32° to 158° F (0° to 70° | C) |
| | Performance | Sequential Read | 3500 MB/s* |
| | | Sequential Write | 3000 MB/s* |
| | | Random Read | 580K IOPS* |
| | | Random Write | 500K IOPS* |

| HP Z Turbo Drive Dual | Capacity | 256GB | |
|-----------------------|-----------------------|---|--------------|
| Pro 256GB SSD | Protocol | PCle | |
| | Form Factor | M.2 in Half-height, half | -length card |
| | Controller | NVMe | |
| | NAND Type | 3D TLC | |
| | Endurance | 200TBW (TB Written) | |
| | Reliability (MTBF) | 1.5M hours | |
| | Interface | PCI Express 3.0 x4 electrical x4 physical | |
| | Operating Temperature | 32° to 158° F (0° to 70° | C) |
| | Performance | Sequential Read | 3500 MB/s* |
| | | Sequential Write | 2200 MB/s* |
| | | Random Read | 240K IOPS* |
| | | Random Write | 480K IOPS* |

*Actual performance may vary.

| HP Z Turbo Drive Dual | Capacity | 512GB | |
|-----------------------|-----------------------|---------------------------------------|---------------|
| Pro 512GB SSD | Protocol | PCIe | |
| | Form Factor | M.2 in Half-height, hal | f-length card |
| | Controller | NVMe | |
| | NAND Type | 3D TLC | |
| | Endurance | 300TBW (TB Written) | |
| | Reliability (MTBF) | 1.5M hours | |
| | Interface | PCI Express 3.0 x4 electrical x4 phys | |
| | Operating Temperature | 32° to 158° F (0° to 70 | ° C) |
| | Performance | Sequential Read | 3500 MB/s* |
| | | Sequential Write | 2900 MB/s* |
| | | Random Read | 460 K IOPS* |
| | | Random Write | 500K IOPS* |
| | 44 | | |

*Actual performance may vary.

| HP Z Turbo Drive Dual | Capacity | 1TB | |
|-----------------------|-------------------------|--------------------------|--------------------|
| Pro 1 TB SSD | Protocol | PCIe | |
| | | | |
| | Form Factor | M.2 in Half-height, half | -length card |
| | Controller | NVMe | |
| | NAND Type | 3D TLC | |
| | Endurance | 400TBW (TB Written) | |
| | Reliability (MTBF) | 1.5M hours | |
| | Interface | PCI Express 3.0 x4 elec | trical x4 physical |
| | Operating Temperature | 32° to 158° F (0° to 70° | C) |
| | Performance | Sequential Read | 3500 MB/s* |
| | | Sequential Write | 3000 MB/s* |
| | | Random Read | 580K IOPS* |
| | | Random Write | 500K IOPS* |
| | *Actual performance may | varv | |



HP Z6 G4 Workstation

Technical Specifications - Hard Drives

| | HP Z Turbo Drive Dual | Capacity | 2TB | |
|----------------------|-----------------------|------------------------------|--------------------------|---------------------|
| | Pro 2TB SSD | Protocol | PCIe | |
| | | Form Factor | M.2 in Half-height, hal | t-length card |
| | | Controller | NVMe | |
| | | NAND Type | 3D TLC | |
| | | Endurance | 500TBW (TB Written) | |
| | | Reliability (MTBF) | 1.5M hours | |
| | | Interface | PCI Express 3.0 x4 elec | |
| | | Operating Temperature | 32° to 158° F (0° to 70° | - |
| | | Performance | Sequential Read | 3500 MB/s* |
| | | | Sequential Write | 3000 MB/s * |
| | | | Random Read | 600K IOPS* |
| | | | Random Write | 500K IOPS* |
| | | *Actual performance may | vary. | |
| Mainstream PCIe SSDs | HP 256GB M.2 2280 TLC | Capacity | 256GB | |
| for HP Workstations | SSD | Protocol | PCIe | |
| | | Form Factor | M.2 | |
| | | Controller | NVMe | |
| | | NAND Type | 3D TLC | |
| | | Endurance | 200TB | |
| | | Reliability (MTBF) | 1.5M hours | |
| | | Interface | PCI Express 3.0 x4 elec | ctrical x4 physical |
| | | Operating Temperature | 32° to 158° F (0° to 70° | ° C) |
| | | Performance | Sequential Read | 3100 MB/s * |
| | | | Sequential Write | 1400 MB/s * |
| | | | Random Read | 200 K IOPS * |
| | | | Random Write | 320 K IOPS * |
| | | *Actual performance may | vary. | |
| | HP 512GB M.2 2280 TLC | Capacity | 512GB | |
| | SSD | Protocol | PCIe | |
| | | Form Factor | M.2 | |
| | | Controller | NVMe | |
| | | NAND Type | 3D TLC | |
| | | Endurance | 300TB | |
| | | Reliability (MTBF) | 1.5M hours | |
| | | Interface | PCI Express 3.0 x4 elec | ctrical x4 physical |
| | | Operating Temperature | 32° to 158° F (0° to 70° | ° C) |
| | | Performance | Sequential Read | 3300 MB/s* |
| | | | Sequential Write | 2500 MB/s* |
| | | | Random Read | 225 K IOPS* |
| | | | Random Write | 430 K IOPS* |
| | | *Actual performance may | vary. | |



Technical Specifications - Hard Drives

| HP 1 TB M.2 2280 TLC SSD | Capacity | 1TB | |
|--------------------------|-----------------------|--------------------------|--------------------|
| | Protocol | PCIe | |
| | Form Factor | M.2 | |
| | Controller | NVMe | |
| | NAND Type | 3D TLC | |
| | Endurance | 400TB | |
| | Reliability (MTBF) | 1.5M hours | |
| | Interface | PCI Express 3.0 x4 elec | trical x4 physical |
| | Operating Temperature | 32° to 158° F (0° to 70° | C) |
| | Performance | Sequential Read | 3300 MB/s* |
| | | Sequential Write | 2500 MB/s* |
| | | Random Read | 400 K IOPS* |
| | | Random Write | 440 K IOPS* |

*Actual performance may vary.

| HP 2TB M.2 2280 TLC SSD | Capacity | 2TB | |
|-------------------------|-----------------------|--------------------------|--------------------|
| | Protocol | PCle | |
| | Form Factor | M.2 | |
| | Controller | NVMe | |
| | NAND Type | 3D TLC | |
| | Endurance | 500TB | |
| | Reliability (MTBF) | 1.5M hours | |
| | Interface | PCI Express 3.0 x4 elec | trical x4 physical |
| | Operating Temperature | 32° to 158° F (0° to 70° | C) |
| | Performance | Sequential Read | 3300 MB/s* |
| | | Sequential Write | 2700 MB/s* |
| | | Random Read | 430 K IOPS* |
| | | Random Write | 500 K IOPS* |

| Intel® 905p Series AIC PCIe SSD | Intel® 905p Series AIC 280GB PCIe SSD | Capacity Protocol Form Factor Controller NVM Type | 280GB PCIe PCIe Card, Half Height NVMe 3DXPoint | |
|------------------------------------|--|---|--|--|
| | | Endurance Reliability (MTBF) Operating Temperature Performance | 5.11 PBW (PB Written) 1.6M hours 32° to 185° F (0° to 85° Sequential Read | ² C) 2730 MB/s* |
| | | *Actual performance may Capacity | Sequential Write Random Read Random Write vary. 480GB | 2280 MB/s* 587K IOPS* 559K IOPS* |



| | Intel® 905p Series AIC 480GB PCIe SSD | Protocol Form Factor Controller NVM Type Endurance Reliability (MTBF) Operating Temperature Performance | PCIe PCIe Card, Half Height NVMe 3DXPoint 8.76 PBW (PB Written) 1.6M hours 32° to 185° F (0° to 85 Sequential Read Sequential Write Random Read Random Write Vary. | 1 |
|--|--|--|---|------------|
| Intel® Optane™ DC Persistent Memory | Intel® Optane™ DC Persistent Memory 128GB Module | Capacity Protocol Form Factor Controller NVM Type Endurance Reliability (MTBF) Operating Temperature Performance | 128GB DDR-T DDR4 NVMe 3DXPoint 292 PBW (256B Seque 91 PBW (64B Sequenti 2M hours 32° to 185° F (0° to 85 Sequential Read Sequential Write | ial Write) |



Technical Specifications - Hard Drive Controllers

HARD DRIVE CONTROLLERS

| | Microsemi | PCI Bus | 8 lanes, PCI Express 3.0 | | |
|--|-----------------------|-------------------------------|---|-----------------------------------|--|
| | SmartHBA2100-4i4e SAS | RAID Levels | | | |
| | Card | PCI Data Burst Transfer | Half Duplex x8, PCIe, 8000 MB/s | | |
| | | Rate | | | |
| | | SAS Bandwidth | Half Duplex | 1200 MB/s per lane | |
| | | PCI Card Type | 3.3V Add-in Card | | |
| | | PCI Voltage | 12 V ± 10% | | |
| | | PCI Power | 9.8W typical, Airflow min 200 LFM | | |
| | | Bracket | Full height and low profile | | |
| | | Certification Level | PCI Express 3.0 compliant | | |
| | | SAS Processor | Microsemi SmartIOC 2100 SAS IO Controller | | |
| | | Internal Connectors | One x4 internal mini-SASHD (SFF-864 | 13) | |
| | | External Connectors | One x4 external mini-SASHD (SFF-864 | 4) | |
| | | Maximum Number of SCSI | 256 Non-RAID SAS/SATA devices | | |
| | | Devices | | | |
| | | LED Indicators | Connector for Drive Activity Light | | |
| | | | NOTE: RAID 5 is not supported on Micr RAID Card | 05emi 2100-4i4e 8-port SAS 12GD/S | |
| | | | | | |



Technical Specifications - Graphics

GRAPHICS

| NVIDIA® Quadro® P400 2GB Graphics | Form Factor | Dimensions: 2.713" H x 5.7" L Single Slot, Low Profile Cooling: Active Weight: 129 grams |
|--------------------------------------|-------------------------------|---|
| | Graphics Controller | NVIDIA® Quadro® P400 Graphics Card GPU: 256 NVIDIA® CUDA® cores Max Power: 30 Watts |
| | Bus Type | PCI Express 3.0 x16 |
| | Memory | Size: 2 GB GDDR5, 2000 MHz Memory Interface: 64-bit Memory Bandwidth: 32 GB/s |
| | Connectors | 3mDP Outputs |
| | Maximum Resolution | DisplayPort™ 1.4: - up to 3x 5120 x 2880 x 24 bpp @ 60Hz - supports Multi-Stream Transport (MST) |
| | Image Quality Features | 10-bit internal display processing pipeline 10-bit scan-out support |
| | Display Output | 3 mDP Connectors |
| | Shading Architecture | Full Microsoft DirectX [®] 12 Shader Model 5.1 |
| | Supported Graphics APIs | OpenGL [®] 4.5 DirectX [®] 12 Vulkan™ 1.0 API support includes: CUDA C, CUDA C++, DirectCompute , OpenCL™ |
| | Available Graphics Drivers | Microsoft Windows 10 Microsoft Windows 7 Professional 64-bit Linux® |
| | | HP qualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html |
| | Notes | |
| NVIDIA® Quadro® P620 2GB Graphics | Form Factor | Dimensions: 2.713" H x 5.7" L Single Slot, Low Profile Cooling: Active Weight: 129 grams |
| | Graphics Controller | NVIDIA® Quadro® P620 Graphics Card GPU: 512 CUDA cores Max Power: 40 Watts |
| | Bus Type | PCI Express 3.0 x16 |
| | Memory | Size: 2 GB GDDR5, 2000 MHz Memory Interface: 128-bit Memory Bandwidth: 64 GB/s |



| | Connectors | 4mDP Outputs * |
|------------------------------------|-------------------------------|--|
| | Maximum Resolution | DisplayPort™ 1.4: - up to 4x 5120 x 2880 x 24 bpp @ 60Hz - supports Multi-Stream Transport (MST) |
| | Image Quality Features | 10-bit internal display processing pipeline 10-bit scan-out support |
| | Display Output | 4 mDP Connectors |
| | Shading Architecture | Full Microsoft DirectX 12 Shader Model 5.1 |
| | Supported Graphics APIs | OpenGL 4.5 DirectX 12 Vulkan 1.0 API support includes: CUDA C, CUDA C++, DirectCompute , OpenCL |
| | Available Graphics Drivers | Windows10 (64-bit) Windows 7 Professional 64-bit |
| | | Linux® |
| | | HP qualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html |
| | Notes | *P620 only have mini-DisplayPort™ (mDP) video ports. |
| | | Factory Configured (Z4 G4/ Z6 G4/ Z8 G4 Workstations): No adapters included After market option kit:Two mDP-to-DP Adapters included |
| | | Additional mDP-to-DP Adapters are available as Factory Configuration or Option Kit accessories: - 2MY05AA - HP miniDP-to-DP Adapter Cables - 2KW87A6 - HP (Bulk 12) miniDP-to-DP Adapter Cables |
| AMD FirePro™ W2100 2GB Graphics | Form Factor | Low Profile, half length (full-height bracket included) |
| | Graphics Controller | AMD FirePro™ W2100 professional graphics based on Oland GPU. GPU: 320 Stream Processors organized into 5 Compute Units GPU Frequency: 630Mhz Power: 26W Cooling: Active |
| | Bus Type | PCI Express® x8, Generation 3.0 |
| | Memory | 2GB DDR3 memory Memory Bandwidth: up to 28.8 GB/s Memory Width: 128 bit |
| | Connectors | 2x Display Port™ 1.2 connectors |
| | | Factory Configured: No video cable adapter included After market option kit: No video cable adapter included |



| | | Additional DisplayPort™-to-VGA or DisplayPort™-to-DVI adapters are available as Factory Configuration or Option Kit accessories. |
|---------------------------------------|-------------------------------|--|
| | Maximum Resolution | DisplayPort™ 1.2: - up to 4096x2160 x 24 bpp @ 60Hz |
| | | Dual Link DVI(I) (requires adapter cable): - up to 2560 x 1600 x 32 bpp @ 60Hz |
| | | Single Link-DVI(I)(requires adapter cable): - up to 1920 x 1200 x 32 bpp @ 60Hz |
| | | VGA (requires adapter cable): - up to 1920 x 1200 x 32 bpp @ 60Hz |
| | Image Quality Features | Advanced support for 8-bit, 10-bit, and 16-bit per RGB color component. High bandwidth scaler for high quality up and downscaling. |
| | Display Output | 2 x DisplayPort™ 1.2a Maximum number of displays: 2 |
| | Shading Architecture | Shader Model 5.0 |
| | Supported Graphics APIs | OpenCL™ 1.2, DirectX [®] 11.2/12, OpenGL [®] 4.4 |
| | | OpenGL [®] 4.4 support with driver release 14.301.xxx OpenCL™ 1.2 conformance expected with drive release 14.301.xxx |
| | Available Graphics Drivers | Windows10 (64-bit) Windows 7 Professional 64-bit Linux® |
| | | HP qualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html |
| | Notes | Depending on the card model, native DisplayPort [™] connectors and/or certified DisplayPort [™] active or passive adapters to convert your monitor's native input to your card's DisplayPort [™] or Mini-DisplayPort [™] connector(s) may be required. See www.amd.com/FirePro [™] for details. |
| NVIDIA® Quadro® P1000 4GB Graphics | Form Factor | Dimensions:2.713" H x 5.7" L Single Slot, Low Profile Cooling: Active Weight: 129 grams |
| | Graphics Controller | NVIDIA® Quadro® P1000 Graphics Card GPU: 640 NVIDIA® CUDA® cores Max Power: 47 Watts |
| | Bus Type | PCI Express 3.0 x16 |
| | Memory | Size: 4 GB GDDR5, 2500 MHz |
| | - | Memory Interface: 128-bit memory interface |



| | | Memory Bandwidth: 80 GB/s memory bandwidth |
|---------------------------------------|-------------------------------|---|
| | Connectors | 4mDP Outputs |
| | Maximum Resolution | DisplayPort™ 1.4: |
| | Plaximum Resolution | - up to 4x 5120 x 2880 x 24 bpp @ 60Hz - supports Multi-Stream Transport (MST) |
| | Image Quality Features | 10-bit internal display processing pipeline 10-bit scan-out support |
| | Display Output | 4 mDP Connectors |
| | Shading Architecture | Full Microsoft DirectX [®] 12 Shader Model 5.1 |
| | Supported Graphics APIs | OpenGL [®] 4.5 DirectX [®] 12 Vulkan™ 1.0 API support includes: CUDA C, CUDA C++, DirectCompute , OpenCL [™] |
| | Available Graphics Drivers | Microsoft Windows 10 Microsoft Windows 7 Professional 64-bit Linux® |
| | | HP qualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html |
| | Notes | |
| NVIDIA® Quadro® P2000 5GB Graphics | Form Factor | Dimensions: 4.4"Hx7.9"L Single Slot Cooling: Active Weight: 260 grams |
| | Graphics Controller | NVIDIA® Quadro® P2000 Graphics Card Power: 75 Watts |
| | Bus Type | PCI Express 3.0 x16 |
| | Memory | Size: 5GB GDDR5 Memory Bandwidth: 140 GB/s Memory Width: 160-bit |
| | Connectors | 4x DisplayPort™ 1.4 |
| | | Factory Configured Option: No adapter included with card After Market Option: No video cable adapter included |
| | | Additional DVI to VGA, DisplayPort™ to VGA, DisplayPort™ to DVI, and DisplayPort™ to Dual-Link DVI adapters available as accessories. |
| | Maximum Resolution | DisplayPort™: - up to 5120 x 2880 x 24 bpp @ 60Hz - supports High Bit Rate 2 (HBR2) and Multi-Stream Transport (MST) DP 1.3 & 1.4 ready. |
| | | DL-DVI(I) output: - up to 2560 x 1600 x 32 bpp @ 60 Hz |
| | | Single Link-DVI(I) output: - up to 1920 x 1200 x 32 bpp @ 60Hz |



| | Image Quality Features | HDMI 2.0 (requires DP to HDMI adapter): 5120 x 2880 x 24 bpp @ 60Hz 12-bit internal display pipeline (hardware support for 12-bit scanout on supported panels, applications and connection) |
|---------------------------------------|---|--|
| | Display Output | Stereoscopic 3D display support including NVIDIA® 3D Vision™ technology, NVIDIA® Mosaic and nView. Maximum number of displays - 4 direct attached monitors |
| | | Maximum number of monitors across all available Quadro P2000 outputs is 4. |
| | Shading Architecture Supported Graphics APIs | Shader Model 5.1 OpenGL [®] 4.5 DirectX [®] 12 |
| | | API support includes: CUDA C, CUDA C++, DirectCompute 5.0, OpenCL™, Java, Python, and Fortran software |
| | Available Graphics Drivers | Microsoft Windows 10 Microsoft Windows 7 Professional 64bit Linux [®] - Full OpenGL [®] implementation, complete with NVIDIA [®] and ARB extensions |
| | | HP qualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html |
| | Notes | http://wetcome.np.com/country/us/en/support.ntm |
| NVIDIA® Quadro® P2200 5GB Graphics | Form Factor | Dimensions: 4.4"H x 7.9"L Single Slot, Full Height Weight: 260 grams |
| | Graphics Controller | NVIDIA® Quadro® P2200 Graphics Card GPU: 1280 CUDA cores Power: 75 Watts Cooling: Active |
| | Bus Type | PCI Express 3.0 x16 |
| | Memory | Size: 5GB GDDR5X Memory Bandwidth: 200 GB/s Memory Width: 160-bit |
| | Connectors | 4x DisplayPort™ 1.4 |
| | | Factory Configured Option: No adapter included with card After Market Option: No video cable adapter included |
| | | Additional DVI to VGA, DisplayPort™ to VGA, DisplayPort™ to DVI, and DisplayPort™ to Dual-Link DVI adapters available as accessories. |
| | Maximum Resolution | DisplayPort™: - up to 5120 x 2880 x 24 bpp @ 60Hz |



| | | - supports High Bit Rate 2 (HBR2) and Multi-Stream Transport (MST) DP 1.3 & 1.4 ready. |
|--------------------|-------------------------------|--|
| | | DL-DVI(I) output: - up to 2560 x 1600 x 32 bpp @ 60 Hz |
| | | Single Link-DVI(I) output: - up to 1920 x 1200 x 32 bpp @ 60Hz |
| | | HDMI 2.0 (requires DP to HDMI adapter): 5120 x 2880 x 24 bpp @ 60Hz |
| | Image Quality Features | 12-bit internal display pipeline (hardware support for 12-bit scanout on supported panels, applications and connection) |
| | | Stereoscopic 3D display support including NVIDIA® 3D Vision™ technology, NVIDIA® Mosaic and nView. |
| | Display Output | Maximum number of displays - 4 direct attached monitors |
| | | Maximum number of monitors across all available NVIDIA® Quadro® P2200 outputs is 4. |
| | Shading Architecture | Shader Model 5.1 |
| | Supported Graphics APIs | OpenGL [®] 4.5 DirectX [®] 12 |
| | | API support includes: CUDA C, CUDA C++, DirectCompute 5.0, OpenCL™, Java, Python, and Fortran software |
| | Available Graphics Drivers | Microsoft Windows 10 Microsoft Windows 7 Professional 64bit Linux® - Full OpenGL [®] implementation, complete with NVIDIA® Quadro® and ARB extensions |
| | | HP qualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html |
| | Notes | Quadro P2200 offered as Factory Configured Option does not include a video cable adapter. Video cable adapters must be ordered separately. Quadro P2200 offered as an After Market Option does not include video cables. Video cable adapters must be ordered separately. |
| AMD Radeon™ Pro WX | Form Factor | Low-Profile Single Slot (6.6" Length) |
| 3100 4GB Graphics | Graphics Controller | Polaris12 GL GPU: 512 Stream Processors organized into 8 Compute Units Power: 50 Watts Cooling: Active |
| | Memory | 4GB GDDR5 memory Memory Bandwidth: 6 Gbps / 96 GB/s Memory Width: 128 bit |



| AMD Radeon™ Pro WX | Form Factor | mode content requires operating system support. Low-Profile Single Slot (2.75 "H x 6.6" L) |
|--------------------|-------------------------------|--|
| | Notes | HDR content requires that the system be configured with a fully HDR-ready content chain, including: graphics card, monitor/TV, graphics driver and application. Video content must be graded in HDR and viewed with an HDR-ready player. Windowed mode content requires operating system support. AMD PowerTune and AMD ZeroCore Power are technologies offered by certain FirePro™ and Radeon™ Pro products, which are designed to intelligently manage GPU power consumption in response to certain GPU load conditions. As of September 2016, certified for DisplayPort™ 1.4 HBR3 and ready for DisplayPort™ 1.4 HDR based on independent verification by DisplayPort™ testing authority. HDR content requires that the system be configured with a fully HDR-ready content chain, including: graphics card, monitor/TV, graphics driver and application. Video content must be graded in HDR and viewed with an HDR-ready player. Windowed mode content requires operating curstom curport |
| | | HP qualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html |
| | Available Graphics Drivers | Windows 10 (Windows® 7 64-bit available from AMD) Linux® 64-bit (selected Enterprise distributions) |
| | Supported Graphics APIs | DirectX [®] 12 OpenGL [®] 4.5 OpenCL™ 2.0 Vulkan™ 1.0 |
| | GPU Architecture | Polaris |
| | Display Output | 3 full physical DP1.3 HBR3 / DP1.4 HDR outputs FreeSync support |
| | Image Quality Features | Advanced support for 8-bit and 10-bit per RGB color component. High bandwidth scaler for high quality up and downscaling |
| | Maximum Resolution | 5K support @ 60Hz 1x single-cable 5K monitor, or 2x dual-cable 5K monitors 3x 4K support @ 60Hz |
| | | Additional Mini DisplayPort™-to-DisplayPort™, DisplayPort™-to-VGA or DisplayPort™-to-DVI adapters are available as Factory Configuration or Option Kit accessories. |
| | | Factory Configured: No adapters included After market option kit: One mDP-to-DP cable adapters included |
| | Connectors | 2x Mini DisplayPort™ 1.4 plus 1x DisplayPort™ 1.4 – HDR ready connectors with HBR3 and MST support. |

GPU: 640 Stream Processors organized into 8 Compute Units

| Memory | Power: 56 Watts Cooling: Active 4GB GDDR5 memory |
|-------------------------------|---|
| nemory | Memory Bandwidth: 96 GB/s Memory Width: 128 bit |
| Connectors | 4x Mini DisplayPort™ 1.4 – HDR ready connectors with HBR3 and MST support. |
| | Factory Configured: No adapters included After market option kit: One mDP-to-DP cable adapters included |
| | Additional Mini DisplayPort™-to-DisplayPort™, DisplayPort™-to-VGA or DisplayPort™-to-DVI adapters are available as Factory Configuration or Option Kit accessories. |
| Maximum Resolution | 5K support @ 60Hz • 1x single-cable 5K monitor, or 2x dual-cable 5K monitors 4x 4K support @ 60Hz |
| Image Quality Features | Advanced support for 8-bit and 10-bit per RGB color component. High bandwidth scaler for high quality up and downscaling |
| Display Output | 4 full physical DP1.3 HBR3 / DP1.4 HDR outputs FreeSync support |
| GPU Architecture | Polaris |
| Supported Graphics APIs | DirectX®12 OpenGL® 4.6 OpenCL™ 2.0 Vulkan™ 1.0 |
| Available Graphics Drivers | Windows 10 Linux® 64-bit (selected Enterprise distributions) |
| | HP qualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html |
| Notes | HDR content requires that the system be configured with a fully HDR-ready content chain, including: graphics card, monitor/TV, graphics driver and application. Video content must be graded in HDR and viewed with an HDR-ready player. Windowed mode content requires operating system support. AMD PowerTune and AMD ZeroCore Power are technologies offered by certain FirePro[™] and Radeon[™] Pro products, which are designed to intelligently manage GPU power consumption in response to certain GPU load conditions. As of September 2016, certified for DisplayPort[™] 1.4 HBR3 and ready for DisplayPort[™] 1.4 HDR based on independent verification by DisplayPort[™] testing authority. HDR content requires that the system be configured with a fully HDR-ready content chain, including: graphics card, monitor/TV, graphics driver and application. Video content must be graded in HDR and viewed with an HDR-ready player. Windowed mode content requires operating system support. |



| Radeon™ Pro WX 4100 4GB Graphics | Form Factor | Low-Profile Single Slot (6.6" Length) |
|-------------------------------------|-------------------------|---|
| | Graphics Controller | Polaris 11 Baffin GL XT GPU: 1024 Stream Processors organized into 16 Compute Units Power: 50 Watts |
| | | Cooling: Active |
| | Memory | 4GB GDDR5 memory Memory Bandwidth: 6 Gbps / 96 GB/s Memory Width: 128 bit |
| | Connectors | 4x Mini DisplayPort™ 1.4 – HDR ready connectors with HBR3 and MST support. |
| | | Factory Configured: Four mDP-to-DP cable adapters included After market option kit: Four mDP-to-DP cable adapters included |
| | | Additional DisplayPort™-to-VGA or DisplayPort™-to-DVI adapters are available as Factory Configuration or Option Kit accessories. |
| | Maximum Resolution | 5K support @ 60Hz |
| | | • 1x single-cable 5K monitor, or 2x dual-cable 5K monitors 4x 4K support @ 60Hz |
| | Image Quality Features | Advanced support for 8-bit and 10-bit per RGB color component. High bandwidth scaler for high quality up and downscaling |
| | Display Output | 4 full physical DP1.3 HBR3 / DP1.4 HDR outputs FreeSync support |
| | GPU Architecture | GCN 4th Generation |
| | Supported Graphics APIs | |
| | | OpenGL [®] 4.5 |
| | | OpenCL™ 2.0 Vulkan™ 1.0 |
| | Available Graphics | Windows 10 |
| | Drivers | Windows® 7 64-bit Linux® 64-bit (selected Enterprise distributions) |
| | | HP qualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html |
| | Notes | HDR content requires that the system be configured with a fully HDR-ready content chain, including: graphics card, monitor/TV, graphics driver and application. Video content must be graded in HDR and viewed with an HDR-ready player. Windowed mode content requires operating system support. |
| | | AMD PowerTune and AMD ZeroCore Power are technologies offered by certain FirePro[™] and Radeon[™] Pro products, which are designed to intelligently manage GPU power consumption in response to certain GPU load conditions. As of September 2016, certified for DisplayPort[™] 1.4 HBR3 and ready for DisplayPort[™] 1.4 HDR based on independent |



| | | verification by DisplayPort™ testing authority. HDR content requires that the system be configured with a fully HDR- ready content chain, including: graphics card, monitor/TV, graphics driver and application. Video content must be graded in HDR and viewed with an HDR-ready player. Windows mode content requires operating system support. |
|---------------------------------------|------------------------|--|
| NVIDIA® Quadro® P4000 8GB Graphics | Form Factor | Dimensions: 4.4"H x 9.5"L Single-slot, full-height Weight: 475 grams (without extender) |
| | Graphics Controller | NVIDIA® Quadro® P4000 Graphics Card GPU: 1792 CUDA cores Power: 120 Watts |
| | Bus Type Memory | PCI Express 3.0 x16 Size: 8GB GDDR5 Memory Bandwidth: 243 GB/s Memory Width: 256-bit |
| | Connectors | 4 x DisplayPort 1.4 3-pin mini-DIN connector via optional bracket 1 x 6-pin auxiliary power connector 4-pin header for stereo signal SYNC connector for Quadro® Sync II 2 x SLI connectors |
| | | Factory Configured Option: No video cable adapter included After Market Option: No video cable adapter included Additional DisplayPort-to-VGA, DisplayPort-to-HDMI, or DisplayPort-to- |
| | Maximum Resolution | DVI adapters are available as accessories Dual-link internal TMDS (DVI 1.0): - up to 2560 x 1600 x 32 bpp @ 60 Hz |
| | | Single-link internal TMDS (DVI 1.0): - up to 1920 x 1200 x 32 bpp @ 60 Hz |
| | | HDMI™ 2.0b (requires DP to HDMI adapter): - up to 5120 x 2880 x 24 bpp @ 60Hz |
| | | DisplayPort: - up to 4096 x 2160 x 30 bpp @ 60Hz - up to 2560 x 1600 x 30 bpp @ 120 Hz - supports High Bit Rate 2 (HBR2) and Multi-Stream Transport (MST) |
| | Image Quality Features | Using two DP outputs, the P4000 can drive one dual DP input display with 5120 x 2880 x 30 bpp @ 60Hz resolution. Advanced support for 8-bit, 10-bit, and 12-bit per RGB color component. HDCP 2.2 support over DisplayPort, DVI, and HDMI connectors NVIDIA 3D Vision [™] and other 3D stereo technologies NVIDIA Mosaic and nView |



| Display Output | Maximum number of displays - 4 direct attached monitors | |
|---|---|--|
| Shading Architecture Supported Graphics APIs | Maximum number of monitors across all available Quadro P4000 outputs is 4. Shader Model 5.1 OpenGL 4.5 DirectX 12 Vulcan 1.0 | |
| Available Graphics Drivers | API support includes: CUDA C, CUDA C++, DirectCompute 5.0, OpenCL, Java, Python, and Fortran Microsoft Windows 10 Microsoft Windows 7 Linux - Full OpenGL implementation, complete with NVIDIA and ARB extensions | |
| Notes | HP qualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html 1. Quadro P4000 offered as Factory Configured Option does not include a video cable adapter. Video cable adapters must be ordered separately. 2. Quadro P4000 offered as an After Market Option does not include video cables. Video cable adapters must be ordered separately. | |

| NVIDIA® Quadro® GP100 16GB Graphics | Form Factor | Dual Slot (4.4" Height x 10.5" Length) Weight: 989 grams +72 grams extender |
|--|---------------------|---|
| | Graphics Controller | NVIDIA® QUADRO® GP100 GPU: 3584 NVIDIA CUDA® Parallel Processing Cores Power: 235 Watts Cooling: Active |
| | Memory | 16GB HBM2 Memory Bandwidth: Up to 717 GB/s Memory Width: 4096-bit ECC Memory (disabled by default) |
| | Connectors | DP (x4) with HDR support DL-DVI(D) 3-pin mini-DIN connector via optional bracket 4-pin header for stereo signal Quadro Sync connector (compatible with Quadro II Sync) One 8-pin auxiliary power connector (2x) NVLink connectors |
| | | Eastern configured eastern 0, air actuar adapter included with car |

Factory configured option: 8-pin power adapter included with card.



| Technical Specifi | cations - Graphics | |
|-------------------|-------------------------------|--|
| | | After market option Kit: 8-pin power adapter included with card. |
| | | DVI to VGA, DisplayPort™ to VGA, DisplayPort™ to DVI, and DisplayPort™ to Dual-Link DVI adapters available as accessories. |
| | Maximum Resolution | 5K support @ 60Hz 1x single-cable 5K monitor, or 2x dual-cable 5K monitors |
| | Image Quality Feature | s HDR support over DisplayPort[™] 1.4 (SMPTE 2084/2086, BT. 2020) (4K @ 60 Hz 10b/12b HEVC Decode, 4K @ 60 Hz 10b HEVC Encode) HDCP 2.2 support over DisplayPort[™], DVI, and HDMI connectors NVIDIA 3D Vision[™] technology NVIDIA Mosaic and nView Desktop Management |
| | Display Outputs | 4x DP1.4 MST & HDR2 outputs (up to 5120 x 2880 @ 60Hz) 1x Dual-link DVI-D output (up to 2560 x 1600 @ 60 Hz) 1x Single-link DVI-D output (up to 1920 x 1200 @ 60 Hz) HDMI™ 2.0b (up to 5120 x 2880 @ 60Hz)* |
| | | *requires DP to HDMI adapter |
| | GPU Architecture | NVIDIA Pascal™ |
| | Supported Graphics APIs | DirectX®12 , OpenGL® 4.5, Vulkan™ 1.0 Developer API support includes: CUDA C, CUDA C++, DirectCompute 5.0, OpenCL, Java, Python, and Fortran |
| | Available Graphics Drivers | Windows® 10 Windows® 7 Professional 64-bit Linux® |
| | | HP qualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html |
| | | Factory Configured (Z4 G4/ Z6 G4/ Z8 G4 Workstations): No adapters included After market option kit: No adapters included |

NVIDIA® Quadro®Form FactorFull-Height Dual Slot (4.4" Height x 10.5" Length)P5000 16GB GraphicsWeight: 815 grams / 1.80 lbs

| Graphics Controller | Quadro™ P5000 graphics GPU: 2560 NVIDIA® CUDA® Parallel Processing Cores Power: 180 Watts Cooling: Active |
|------------------------------|--|
| Memory | 16GB GDDR5X memory Memory Bandwidth: Up to 288 GB/s Memory Width: 256 bit ECC Memory (disabled by default) |
| Connectors | DP (x4) with HDR support DL-DVI(D) 3-pin mini-DIN connector SLI connector Quadro Sync connector (compatible with Quadro II Sync) One 8-pin auxiliary power connector Factory configured option: No video cable adapter included with card. After market option Kit: No video cable adaptor included with card. DVI to VGA, DisplayPort [™] to VGA, DisplayPort [™] to DVI, and DisplayPort [™] to Dual-Link DVI adapters available as accessories. |
| Maximum Resolution | 5K support @ 60Hz 1x single-cable 5K monitor, or 2x dual-cable 5K monitors |
| Image Quality Features | Advanced support for 8-bit, 10-bit, and 12-bit per RGB color component. HDCP 2.2 support over DisplayPort [™] , DVI, and HDMI connectors NVIDIA 3D Vision [™] and other 3D stereo technologies NVIDIA [®] Mosaic and nView Desktop Management |
| Display Outputs ¹ | 4x DP1.4 HDR outputs (up to 3840x2160 UHD @ 120Hz refresh, or up to 8K at 30Hz) 1x Dual-link DVI-D output (up to 2560 x 1600 @ 60 Hz and 1920x1200 @ 120 Hz) |
| GPU Architecture | NVIDIA® Pascal™ |
| Supported Graphics APIs | DirectX°12 , OpenGL° 4.5, OpenCL™ 1.0, Vulkan™ 1.0 Developer API support includes: CUDA C, CUDA C++, DirectCompute 5.0, OpenCL™, Java, Python, and Fortran |

Technical Specifications - Graphics Available Graphics Windows[®] 10 64-bit Drivers Windows[®] 7 64-bit Linux[®] 64-bit HP qualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html 1- Supports up to a total of 4 displays Notes NVIDIA[®] Quadro[®] **Form Factor** Full-Height Dual Slot (4.4" Height x 10.5" Length) P6000 24GB Graphics Weight: 967 grams / 2.14 lbs **Graphics Controller** NVIDIA[®] Quadro[®] P6000 graphics GPU: 3840 NVIDIA[®] CUDA[®] Parallel Processing Cores Power: 250 Watts **Cooling:** Active 24GB GDDR5X memory Memory Memory Bandwidth: Up to 432 GB/s Memory Width: 384 bit ECC Memory (disabled by default) Connectors DP (x4) with HDR support DL-DVI(D) 3-pin mini-DIN connector **SLI** connector Quadro Sync connector (compatible with Quadro II Sync) One 8-pin auxiliary power connector Factory configured option: No video cable adapter included with card. After market option Kit: No video cable adaptor included with card. DVI to VGA, DisplayPort[™] to VGA, DisplayPort[™] to DVI, and DisplayPort[™] to Dual-Link DVI adapters available as accessories. Maximum Resolution 5K support @ 60Hz 1x single-cable 5K monitor, or 2x dual-cable 5K monitors **Image Quality Features** Advanced support for 8-bit, 10-bit, and 12-bit per RGB color component. HDCP 2.2 support over DisplayPort[™], DVI, and HDMI connectors NVIDIA[®] 3D Vision[™] and other 3D stereo technologies



| Technical Specifications - Graphics | | | | |
|--|-------------------------------|---|--|--|
| | | NVIDIA [®] Mosaic and nView | | |
| | Display Outputs ¹ | 4x DP1.4 HDR outputs (up to 3840x2160 UHD @ 120Hz refresh, or up to 8K at 30Hz) 1x Dual-link DVI-D output (up to 2560 x 1600 @ 60 Hz and 1920x1200 @ 120 Hz) | | |
| | GPU Architecture | NVIDIA [®] Pascal™ | | |
| | Supported Graphics APIs | DirectX°12, OpenGL° 4.5, OpenCL™ 1.0, Vulkan™ 1.0 Developer API support includes: CUDA C, CUDA C++, DirectCompute 5.0, OpenCL™, Java, Python, and Fortran | | |
| | Available Graphics Drivers | Windows® 10 64-bit Windows® 7 64-bit Linux® 64-bit | | |
| | | HP qualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html | | |
| | Notes | 1- Supports up to a total of 4 displays | | |
| NVIDIA® Quadro® RTX 4000 8GB Graphics | Form Factor | Full-Height Single Slot (4.4" Height x 9.5" Length) Weight: 550 grams / 1.21 lbs | | |
| | Graphics Controller | NVIDIA® Quadro® RTX 4000 Graphics GPU: 2304 NVIDIA® CUDA® Parallel Processing Cores Power: 160 Watts Cooling: Active | | |
| | Memory | 8GB GDDR6 memory Memory Bandwidth: Up to 416 GB/s Memory Width: 384 bit | | |
| | Connectors | 3x DP 1.4a and VirtualLink Quadro Sync connector (compatible with Quadro II Sync) One 8-pin auxiliary power connector | | |
| | | Factory configured option: No video cable adapter included with card. After market option Kit: No video cable adaptor included with card. | | |
| | | DVI to VGA, DisplayPort™ to VGA, DisplayPort™ to DVI, and DisplayPort™ to Dual-Link DVI adapters available as accessories. | | |



| Technical Specifications - Graphics | | | | |
|---|-------------------------------|--|--|--|
| | Maximum Resolution | 7680x4320 @ 60Hz | | |
| | Image Quality Features | Advanced support for 8-bit, 10-bit, and 12-bit per RGB color component. HDCP 2.2 support over DisplayPort™, DVI, and HDMI connectors NVIDIA® 3D Vision™ and other 3D stereo technologies NVIDIA® Mosaic and nView | | |
| | Display Outputs ¹ | 3x DP 1.4a and VirtualLink (7680x4320 @ 60Hz) | | |
| | Supported Graphics APIs | DirectX®12, OpenGL® 4.5, OpenCL™ 1.0, Vulkan™ 1.0 Developer API support includes: CUDA C, CUDA C++, DirectCompute 5.0, OpenCL™, Java, Python, and Fortran | | |
| | Available Graphics Drivers | Windows® 10 64-bit Windows® 7 64-bit Linux® 64-bit | | |
| | | HP qualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html | | |
| | Notes | 1- Supports up to a total of 4 displays | | |
| NVIDIA® Quadro® RTX 5000 16GB Graphics | Form Factor | Full-Height Dual Slot (4.4" Height x 10.5" Length) Weight: 1050 grams / 2.31 lbs | | |
| | Graphics Controller | NVIDIA® Quadro® RTX 5000 Graphics GPU: 3072 NVIDIA® CUDA® Parallel Processing Cores Power: 265 Watts Cooling: Active | | |
| | Memory | 16GB GDDR6 memory Memory Bandwidth: Up to 448 GB/s Memory Width: 384 bit | | |
| | Connectors | 4x DP 1.4a and VirtualLink Quadro Sync connector (compatible with Quadro II Sync) One 8-pin + 6-pin auxiliary power connector | | |
| | | Factory configured option: No video cable adapter included with card. After market option Kit: No video cable adaptor included with card. | | |
| | | DVI to VGA, DisplayPort™ to VGA, DisplayPort™ to DVI, and DisplayPort™ to Dual-Link DVI adapters available as accessories. | | |



| | Maximum Resolution | 7680x4320 @ 60Hz |
|---|-------------------------------|--|
| | Image Quality Features | Advanced support for 8-bit, 10-bit, and 12-bit per RGB color component. HDCP 2.2 support over DisplayPort™, DVI, and HDMI connectors NVIDIA® 3D Vision™ and other 3D stereo technologies NVIDIA® Mosaic and nView |
| | Display Outputs ¹ | 4x DP 1.4a and VirtualLink (7680x4320 @ 60Hz) |
| | Supported Graphics APIs | DirectX®12, OpenGL® 4.5, OpenCL™ 1.0, Vulkan™ 1.0 Developer API support includes: CUDA C, CUDA C++, DirectCompute 5.0, OpenCL™, Java, Python, and Fortran |
| | Available Graphics Drivers | Windows® 10 64-bit Windows® 7 64-bit Linux® 64-bit |
| | | HP qualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html |
| | Notes | 1- Supports up to a total of 4 displays |
| NVIDIA® Quadro® RTX 6000 24GB Graphics | Form Factor | Full-Height Dual Slot (4.4" Height x 10.5" Length) Weight: 1070 grams / 2.35 lbs |
| | Graphics Controller | NVIDIA® Quadro® RTX 6000 Graphics GPU: 4608 NVIDIA® CUDA® Parallel Processing Cores Power: 295 Watts Cooling: Active |
| | Memory | 24GB GDDR6 memory Memory Bandwidth: Up to 672 GB/s Memory Width: 384 bit |



| | Connectors | 4x DP 1.4a and VirtualLink Quadro Sync connector (compatible with Quadro II Sync) One 8-pin + 6-pin auxiliary power connector |
|---|-------------------------------|---|
| | | Factory configured option: No video cable adapter included with card. After market option Kit: No video cable adaptor included with card. |
| | | |
| | | DVI to VGA, DisplayPort™ to VGA, DisplayPort™ to DVI, and DisplayPort™ to Dual-Link DVI adapters available as accessories. |
| | Maximum Resolution | 7680x4320 @ 60Hz |
| | Image Quality Features | Advanced support for 8-bit, 10-bit, and 12-bit per RGB color component. |
| | | HDCP 2.2 support over DisplayPort™, DVI, and HDMI connectors |
| | | NVIDIA® 3D Vision™ and other 3D stereo technologies NVIDIA® Mosaic and nView |
| | Display Outputs ¹ | 4x DP 1.4a and VirtualLink (7680x4320 @ 60Hz) |
| | Supported Graphics APIs | DirectX°12, OpenGL° 4.5, OpenCL™ 1.0, Vulkan™ 1.0 Developer API support includes: CUDA C, CUDA C++, DirectCompute 5.0, OpenCL™, Java, Python, and Fortran |
| | Available Graphics Drivers | Windows® 10 64-bit Windows® 7 64-bit Linux® 64-bit |
| | | HP qualified drivers may be preloaded or available from the HP support Web site: |
| | Notos | http://welcome.hp.com/country/us/en/support.html 1- Supports up to a total of 4 displays |
| | Notes | 1^{-3} Supports up to a total of 4 displays |
| NVIDIA® Quadro® RTX 8000 48GB Graphics | Form Factor | Full-Height Dual Slot (4.4" Height x 10.5" Length) Weight: 1070 grams / 2.35 lbs |
| | Graphics Controller | NVIDIA® Quadro® RTX 8000 Graphics GPU: 4608 NVIDIA® CUDA® Parallel Processing Cores Power: 295 Watts Cooling: Active |
| | Memory | 48GB GDDR6 memory Memory Bandwidth: Up to 672 GB/s Memory Width: 384 bit |



| | Connectors | 4x DP 1.4a and VirtualLink Quadro Sync connector (compatible with Quadro II Sync) One 8-pin + 6-pin auxiliary power connector |
|---------------------|-------------------------------|--|
| | | Factory configured option: No video cable adapter included with card. After market option Kit: No video cable adaptor included with card. |
| | | DVI to VGA, DisplayPort™ to VGA, DisplayPort™ to DVI, and DisplayPort™ to Dual-Link DVI adapters available as accessories. |
| | Maximum Resolution | 7680x4320 @ 60Hz |
| | Image Quality Features | Advanced support for 8-bit, 10-bit, and 12-bit per RGB color component. HDCP 2.2 support over DisplayPort [™] , DVI, and HDMI connectors NVIDIA® 3D Vision [™] and other 3D stereo technologies NVIDIA® Mosaic and nView |
| | Display Outputs ¹ | 4x DP 1.4a and VirtualLink (7680x4320 @ 60Hz) |
| | Supported Graphics APIs | DirectX [®] 12, OpenGL [®] 4.5, OpenCL™ 1.0, Vulkan™ 1.0 Developer API support includes: CUDA C, CUDA C++, DirectCompute 5.0, OpenCL™, Java, Python, and Fortran |
| | Available Graphics Drivers | Windows® 10 64-bit Linux® 64-bit |
| | Notes | HP qualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html 1- Supports up to a total of 4 displays 2- VirtualLink's USB-C™ (data) cannot be disabled at a hardware level |
| Radeon™ Pro WX 7100 | Form Factor | Full-Height Single Slot (9.5" Length) |
| 8GB Graphics | Graphics Controller | Radeon™ Pro WX 7100 graphics GPU: 2304 Stream Processors organized into 36 Compute Units Power: 130 Watts Cooling: Active |
| | Memory | 8GB GDDR5 memory Memory Bandwidth: 7 Gbps / 224 GB/s Memory Width: 256 bit |
| | Connectors | 4x DisplayPort™ 1.4 – HDR ready connectors with HBR3 and MST support. |
| | | Factory Configured: No video cable adapter included After market option kit: No video cable adapter included |



| | Additional DisplayPort™-to-VGA or DisplayPort™-to-DVI adapters are available as Factory Configuration or Option Kit accessories. |
|---|---|
| Maximum Resolution | 5K support @ 60Hz 1x single-cable 5K monitor, or 2x dual-cable 5K monitors |
| Image Quality Features | Advanced support for 8-bit, 10-bit, and 16-bit per RGB color component. High bandwidth scaler for high quality up and downscaling |
| Display Output | 4 full physical DP1.3 HBR3 / DP1.4 HDR outputs FreeSync support |
| GPU Architecture Supported Graphics APIs | GCN 4th Generation DirectX [®] 12 OpenGL [®] 4.5 OpenCL [™] 2.0 Vulkan [™] 1.0 |
| Available Graphics Drivers | Windows 10 Windows [®] 7 64-bit Linux [®] 64-bit |
| | HP qualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html |
| Notes | 10. HDR content requires that the system be configured with a fully HDR-ready content chain, including: graphics card, monitor/TV, graphics driver and application. Video content must be graded in HDR and viewed with an HDR-ready player. Windowed mode content requires operating system support. 11. Radeon VR Ready Creator Products are select Radeon Pro and AMD FirePro™ GPUs that meet or exceed the Oculus Rift or HTC Vive recommended specifications for video cards/GPUs. Other hardware (including CPU) and system requirements recommended by Oculus Rift or HTC Vive should also be met in order to operate the applicable HMDs as intended. As VR technology, HMDs and other VR hardware and software evolve and/or become available, these criteria may change without notice. 12. AMD PowerTune and AMD ZeroCore Power are technologies offered by certain FirePro™ and Radeon™ Pro products, which are designed to intelligently manage GPU power consumption in response to certain GPU load conditions. 13. As of September 2016, certified for DisplayPort™ 1.4 HBR3 and ready for DisplayPort™ 1.4 HDR based on independent verification by DisplayPort™ testing authority. HDR content requires that the system be configured with a fully HDR-ready content chain, including: graphics card, monitor/TV, graphics driver and application. Video content must be graded in HDR and viewed with an HDR-ready player. Windowed mode content requires operating system support. |



| AMD Radeon™ Pro WX 9100 16GB Graphics | Form Factor | Full-Height Dual Slot (4.4" Height x 10.5" Length) Weight: 1100 grams / 2.42 lbs |
|--|-------------------------------|--|
| | Graphics Controller | AMD Radeon™ Pro WX 9100 Vega architecture GPU GPU: 4096 NVIDIA® CUDA® Parallel Processing Cores Power: 250 Watts Cooling: Active |
| | Memory | 16GB HBM2 memory Memory Bandwidth: Up to 483 GB/s Memory Width: 384 bit |
| | Connectors | 6x mDP 1.4 Quadro Sync connector (compatible with Quadro II Sync) One 8-pin + 6-pin auxiliary power connector |
| | | Factory configured option: No video cable adapter included with card. After market option Kit: 2x mini-DP to DP. |
| | | DVI to VGA, DisplayPort™ to VGA, DisplayPort™ to DVI, and DisplayPort™ to Dual-Link DVI adapters available as accessories. |
| | Maximum Resolution | 7680 × 4320 resolution @ 60Hz 6x DP 1.3 4K @60Hz or 3x 5K @60Hz or 1x 8K @60Hz |
| | Image Quality Features | a Advanced support for 8-bit, 10-bit, and 12-bit per RGB color component. HDCP 2.2 support over DisplayPort™, DVI, and HDMI connectors NVIDIA® 3D Vision™ and other 3D stereo technologies NVIDIA® Mosaic and nView |
| | Display Outputs ¹ | 6x mDP 1.4 (7680x4320 @ 60Hz) |
| | Supported Graphics APIs | DirectX°12, OpenGL° 4.5, OpenCL™ 1.0, Vulkan™ 1.0 Developer API support includes: CUDA C, CUDA C++, DirectCompute 5.0, OpenCL™, Java, Python, and Fortran |
| | Available Graphics Drivers | Windows® 10 64-bit Windows® 7 64-bit Linux® 64-bit |



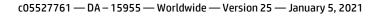
| • | · | |
|-------------------------|----------------------------------|---|
| | | HP qualified drivers may be preloaded or available from the HP |
| | | support Web site: |
| | | http://welcome.hp.com/country/us/en/support.html |
| | Notes | 1- Supports up to a total of 6 displays |
| | | |
| NVIDIA® Quadro® Sync II | Part number | 1WT20AA |
| | Dimensions (HxD) | 6.0 inches × 4.2 inches |
| | Devices Supported | NVIDIA® Quadro® P4000 |
| | | NVIDIA® Quadro® P5000 |
| | D | NVIDIA® Quadro® P6000 |
| | Bus Type | Requires one free mechanical PCIe bus slot. 6-pin PCI or SATA power connector |
| | PCI Form Factor | Full Height, half length, single slot |
| | Ports | 2 RJ45 connectors for carrying frame lock signals over CAT5 cables. BNC Connector for external house synchronization. |
| | Internal Connectors | 6 NVIDIA SLI® style edge fingers for connection to compatible GPUs Included with the board are 4 12-Inch Short Sync Cables to connect to GPU's |
| | | Included with the board are 2 24-Inch Long Sync Cables to connect to GPU's |
| | System Requirements | Requires one free mechanical PCIe bus slot. 6-pin PCI or SATA power connector |
| | | Must be used with NVIDIA Quadro P4000, P5000 or P6000 graphics cards. Requires Quadro driver version R375 or later. |
| | Temperature - Operating | 0° to 55° C |
| | Temperature - Storage | -40° to 60° C |
| | Relative Humidity - Operating | 10% to 80% |
| | Power Requirements | Board power dissipation: <15W |
| | Operating Systems | Windows 10 |
| | Supported | Windows 7 64-bit Linux® 64-bit |
| | Kit Contents | Contains: • Quadro Sync II Card • 4 x 12-Inch Short Sync Cables • 2 x 24-Inch Long Sync Cables (Two) • Quick Start Guide |

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Technical Specifications – Optical and Removable Storage

OPTICAL AND REMOVABLE STORAGE

| HP 9.5mm Slim DVD Writer | Description Mounting Orientation Interface Type Dimensions (WxHxD) Supported Media Types | 9.5mm height, tray-load Either horizontal or vertical SATA/ATAPI 128 x 9.5 x 127mm DVD+R DVD+RW DVD+RUL DVD-R DL DVD-R DVD-RW CD-R CD-RW | |
|--------------------------------|--|---|---|
| | Disc Capacity | DVD-ROM | 8.5 GB DL or 4.7 GB standard |
| | | Full Stroke DVD | < 200 ms (seek) |
| | | Full Stroke CD | < 200 ms (seek) |
| | Maximum Data Transfer Rates | CD ROM Read | CD-ROM, CD-R Up to 24X CD-RW Up to 24X |
| | | DVD ROM Read | DVD+RW Up to 8X DVD-RW Up to 8X DVD+R DL Up to 8X DVD-R DL Up to 8X DVD-ROM Up to 8X DVD-ROM DL Up to 8X DVD+R Up to 8X DVD-R Up to 8X |
| | Power | Source | SATA DC power receptacle |
| | | DC Power Requirements | 5 VDC ± 5%-100 mV ripple p-p |
| | | DC Current | 5 VDC -< 800 mA typical, <1600 mA maximum |
| | Operating Environmental | Temperature | 41° to 122° F (5° to 50° C) |
| | (all conditions non- | Relative Humidity | 10% to 80% |
| | condensing) | Maximum Wet Bulb Temperature | 84° F (29° C) |
| | Operating Systems Supported | Windows 10, Windows 7 Professional 64-bit, Red Hat® Enterprise Linux®(RHEL) WS4**, 5, 6 Desktop/Works SUSE Linux® Enterprise Desktop 10 & 11 | |
| | | * No driver is required for this device. Native support is provided by the operating system. | |
| | Kit Contents | HP SATA DVD Writer drive, installation guide. | |
| HP 9.5mm Slim DVD-ROM Drive | Description Mounting Orientation Interface Type | 9.5mm height, tray-load Either horizontal or vertical SATA / ATAPI | |



| | Dimensions (WxHxD) Disc Capacity | 128 x 9.5 x 127mm DVD-ROM | Single layer: Up to 4.7 GB |
|------------------------------------|-------------------------------------|---|---|
| | | | Double layer: Up to 8.5 GB |
| | Access Times | DVD-ROM Single Layer | < 110 ms (typical) |
| | | CD-ROM Mode 1 | < 110 ms (typical) |
| | | Full Stroke DVD | < 230 ms (typical) |
| | | Full Stroke CD | < 220 ms (typical) |
| | Power | Source | SATA DC power receptacle |
| | | DC Power Requirements | 5 VDC ± 5%-100 mV ripple p-p |
| | | DC Current | 5 VDC – <800mA typical, < 1600 mA maximum |
| | Operating Environmental | Temperature | 41° to 122° F (5° to 50° C) |
| | (all conditions non- | Relative Humidity | 10% to 80% |
| | condensing) | Maximum Wet Bulb Temperature | 84° F (29° C) |
| | Operating Systems Supported | Windows 10, Windows 7 Profession Red Hat® Enterprise Linux®(RHEL) V SUSE Linux® Enterprise Desktop 10 | WS4**, 5, 6 Desktop/Workstation |
| | | No driver is required for this device operating system. | . Native support is provided by the |
| | Kit Contents | 9.5mm Slim DVD-ROM Drive, 5.25" ODD Bay adapter/carrier, slim SATA data/power cable, installation guide | |
| | | | |
| HP HH DVD Writer (16X RW DVD-R) | Description | HP Half Height DVD Writer | |
| KW DVD-K/ | Mounting Orientation | Either Horizontal or vertical | |
| | Interface Type | SATA | |
| | Dimensions (WxHxD) | 146x42x165mm | |
| | Supported Media Types | DVD+R DVD+RW | |
| | | DVD+R DL | |
| | | DVD-R DL | |
| | | DVD-R DVD-RW | |
| | | CD-R | |
| | | CD-RW | |
| | Disc Capacity | DVD-ROM | 8.5 GB DL or 4.7 GB standard |
| | | Full Stroke DVD | 145ms (seek) |
| | | Full Stroke CD | 120ms (seek) |
| | Maximum Data Transfer Rates | CD ROM Read | CD-ROM, CD-R Up to 24X CD-RW Up to 24X |
| | | DVD ROM Read | DVD+RW Up to 13X DVD-RW Up to 13X DVD+R DL Up to 12X DVD-R DL Up to 12X DVD-ROM Up to 12X |



| | Power Operating Environmental (all conditions non- condensing) Operating Systems Supported | Source DC Power Requirements DC Current Temperature Relative Humidity Windows 10, Windows 7 Profession WS4**,5,6 Desktop/Workstation. | DVD+R Up to 16X DVD-R Up to 16X SATA DC power receptacle 5 VDC ± 5% -100 mV ripple p-p 12 VDC ± 10% -200 mV ripple p-p 5 VDC -<1500mA typical, <2000 mA maximum. 41° to 122° F (5° to 50° C) 10% to 90% (Non-Condensing) mal 64-bit. Red Hat Enterprise Linux |
|---------------------------------------|---|---|--|
| | | No driver is required for this device, operating system. | , Native support is provided by |
| | Kit Contents | HP SATA DVD Writer drive, Installat | ion guide. |
| HP 9.5mm Slim BDXL Blu- Ray Writer | Description Mounting Orientation Interface Type Dimensions (WxHxD) Supported Media Types | 9.5mm height, tray-load Either horizontal or vertical SATA/ATAPI 128 x 9.5 x 127mm BD-ROM BD-R | |
| | | BD-RE DVD+R DVD+RW DVD+R DL DVD-R DL DVD-R DVD-RW CD-RW CD-RW | |
| | Disc Capacity | DVD-ROM Blu-ray | 8.5 GB DL or 4.7 GB standard 25 GB (single-layer) 50 GB (dual-layer) 100/128 GB (BDXL) |
| | | Full Stroke DVD | < 230 ms (seek) |
| | | Full Stroke CD | < 220 ms (seek) |
| | | Blu-ray | < 230 ms (seek) (Full Stroke Blu-ray) |
| | | Startup Time | (Time to drive ready from tray loading) BD-ROM (SL/DL) 25S / 28S BD-R (SL/DL) 25S / 28S BD-RE (SL/DL) 25S / 28S DVD-ROM (SL/DL) 18S / 18S DVD-R (SL/DL) 25S / 25S DVD-RW 25S DVD-RW 25S DVD+RW 25S |



| | | | CD-ROM 15S | |
|-------------------|--------------------------------|--|--|--|
| | Maximum Data Transfer Rates | CD ROM Read | CD-ROM, CD-R Up to 24X CD-RW Up to 24X | |
| | | DVD ROM Read | DVD+RW Up to 8X DVD-RW Up to 8X DVD+R DL Up to 8X DVD-R DL Up to 8X DVD-ROM Up to 8X DVD-ROM DL Up to 8X DVD+R Up to 8X DVD-R Up to 8X | |
| | | Blu-ray | BD-ROM Up to 6X BD-ROM DL Up to 6X BD-R Up to 6X BD-R DL Up to 6X BD-R Up to 6X BD-RE SL/DL Up to 6X | |
| | Power | Source | SATA DC power receptacle | |
| | | DC Power Requirements | 5 VDC ± 5%-100 mV ripple p-p | |
| | | DC Current | 5 VDC -900 mA typical, 2000mA maximum | |
| | Operating Environmental | Temperature | 41° to 122° F (5° to 50° C) | |
| | (all conditions non- | Relative Humidity | 10% to 80% | |
| | condensing) | Maximum Wet Bulb Temperature | 84° F (29° C) | |
| | Operating Systems Supported | Windows 10, Windows 7 Profession Red Hat® Enterprise Linux® (RHEL) SUSE Linux® Enterprise Desktop 12 | 6, 7 Desktop/Workstation | |
| | | No driver is required for this device operating system. | . Native support is provided by the | |
| | Kit Contents | 9.5mm Slim BDXL Blu-Ray Writer, ! SATA data/power cable, installatio | 5.25" ODD Bay adapter/carrier, slim n guide | |
| | | | nd/or performance issues may arise, and oduct. Flawless playback on all systems e Blu-ray titles to play, they may ction and your display may require | |
| HP SD Card Reader | Description | Supports hardware ECC (Error Correction Code) function Supports hardware CRC (Cyclic Redundancy Check) function Supports SD 4-bit parallel transfer mode | | |
| | Interface Type | USB 3.1 GEN 1 High-speed interface | | |
| | Dimensions (WxHxD) | 1.15 x .9 x .15 in (29.00 x 23.6 x 3.7 Bay | I 5 mm) Fits conveniently in the Front IO | |
| | Supported Media Types | Secure Digital Card (SD) Secure Digital High Capacity (SDHC SD Extended Capacity Memory Card | | |



| | SD Ultra High Speed II(SD UHSII) |
|--------------------------------|--|
| | These additional media types are supported with a card adapter. Memory Stick Micro (M2) miniSD miniSD High Capacity Micro SD Memory Card (MicroSD) Micro SD High Capacity Memory Card (MicroSDHC) |
| | Test Parameters/Conditions - Power applied, unit operating on system ±5% |
| Operating Systems Supported | Windows 10 |
| | No driver is required for this device. Native support is provided by the operating system. |
| Kit Contents | Media card reader |
| Approvals | USB-IF, WHQL, Compliant with USB Mass Storage Class Bulk only Transport Specification Rev. 1.0, |
| | Compliant Intel® Front Panel I/O Connectivity Design Guide V. 1.3, FCC, CE, BSMI, C-Tick, VCCI, MIC, cUL, TUVT |
| Weight | 0.35 lbs. (0.16 kg) |



Technical Specifications - Controller Cards

CONTROLLER CARDS

| HP Thunderbolt-3 Dual Port2 PCle 1-port I/O Card Data Transfer Rate Devices Supported Supports up to 40 Gb/s (40,000 Mb/s) Thunderbolt™, Thunderbolt™ 2 and Thunderbolt™ 3 certified for Windows devices Bus Type Ports PCle card, full height PCle slots Two Thunderbolt™ 3 external USB type-C output connectors (Rear) | |
|--|----|
| Card Bus Type PCIe card, full height PCIe slots | |
| | ì |
| Ports Two Thunderbolt [™] 3 external USB type-C output connectors (Rear) | |
| Two full size DisplayPort input connectors (Rear) | |
| Internal Connectors One 2x5-Pin header connector | |
| System Requirements Windows 10 Professional, available dedicated PCH PCIe slot. | |
| Temperature - Operating 50° to 131° F (10° to 55° C) | |
| Temperature - Storage -22° to 140° F (-30° to 60° C) | |
| Relative Humidity - 20% to 80% Operating | |
| Compliances FCC Part 15B, cULus 60950, CE Mark EN55022B(1995)/EN55024-1998 ST Taiwan BSMI CNS13438, Korea MIC |), |
| Operating Systems Windows 10 Professional. Supported | |
| Kit ContentsHP Thunderbolt™ 3 Dual Port PCIe I/O Card, 2- DisplayPort cables, GPIO (General-Purpose Input/Output) cables, Installation documentation and warranty card. | |

*Maximum speed requires DisplayPort[™] and PCIe aggregation.

NETWORKING AND COMMUNICATIONS

| Integrated Intel® I219LM | Connector | RJ-45 |
|--------------------------|----------------------|---|
| | Controller | Intel® I219LM |
| | Data Rates Supported | 10/100/1000 Mbps |
| | Boot ROM Support | PXE, UEFI |
| | Connect Speed LED | Link/Activity LED |
| | Indicators | Off = No link |
| | | Blinking = Activity |
| | | Speed LED |
| | | Off = 10Mbps |
| | | Amber = 100Mbps |

• Green = 1000Mbps

Management Capabilities Intel[®] Active Management Technology[™] 11

| Integrated Intel® X722 | Connector | 1 RJ-45 |
|------------------------|---------------------------------------|--|
| for 1GbE | Controller | Intel® X722 for 1GbE |
| | Data Rates Supported | 1000 Mbps |
| | Boot ROM Support | PXE, UEFI |
| | Connect Speed LED Indicators | Link/Activity LED Off = No link Blinking = Activity Speed LED Off = No Link |
| | | Off = No Link Green = 1000Mbps |
| | Management Capabilities | |
| HP Z Dual 10GbE Networ | Networking Interface | 2 RJ-45 |
| Module | System Interface | Cabled from Dedicated Rear I/O Slot |
| | Networking Speeds Supported | 1Gbps, 10Gbps |
| | Cabling (up to 100m) | Cat5e (or higher) for 1Gbps Cat6a (or higher) for 10Gbps |
| | Power Consumption (active-typical) | 5.5W at 1Gbps 11.2W at 10Gbps |
| | Physical Dimensions | 0.875 in x 3 in x 2.75 in |
| | Connect Speed LED Indicators | Link/Activity LED Off = No link Blinking = Activity Speed LED |
| | | Amber = 1Gbps Green = 10Gbps |
| | Operating Temperature | 0 °C to 55 °C (32 °F to 131 °F) |

Intel® I210-T1



| | System Interface | PCI Express 2.1 x1 |
|----------------|---|--|
| | Networking Speeds Supported | 10Mbps, 100Mbps, 1Gbps |
| | Cabling (up to 100m) | Cat3 (or higher) for 10Mbps Cat5 (or higher) for 100Mbps Cat5e (or higher) for 1Gbps |
| | Power Consumption (active-typical) | 0.81W |
| | Physical Dimensions | Length: 6.7cm (2.64 inches) (Bracket) Width: 1.8cm (0.709 inches) Full-height end bracket: 12.07cm (4.755 inches) Low-profile end bracket: 8cm (3.15 inches) |
| | Connect Speed LED Indicators | Link/Activity LED • Off = No link • Blinking = Activity Speed LED • Off = 10Mbps • Green = 100Mbps • Amber = 1Gbps |
| | Operating Temperature | 0 °C to 55 °C (32 °F to 131 °F) |
| | Hardware Certifications | USA: FCC B, EU: UL CE, Japan: VCCI, Taiwan: BSMI, Australia/New Zealand: CTICK, Korea: KCC, Canada: ICES-003/NMB-003 |
| | | |
| Intel® 1350-T2 | Networking Interface | 2 RJ-45 |
| Intel® 1350-T2 | Networking Interface System Interface | |
| Intel® I350-T2 | Networking Interface System Interface Networking Speeds Supported | 2 RJ-45 PCI Express 2.1 x4 10Mbps, 100Mbps, 1Gbps |
| Intel® I350-T2 | System Interface Networking Speeds | PCI Express 2.1 x4 |
| Intel® 1350-T2 | System Interface Networking Speeds Supported | PCI Express 2.1 x4 10Mbps, 100Mbps, 1Gbps Cat3 (or higher) for 10Mbps Cat5 (or higher) for 100Mbps |
| Intel® 1350-T2 | System Interface Networking Speeds Supported Cabling (up to 100m) Power Consumption | PCI Express 2.1 x4 10Mbps, 100Mbps, 1Gbps Cat3 (or higher) for 10Mbps Cat5 (or higher) for 100Mbps Cat5e (or higher) for 1Gbps |
| Intel® 1350-T2 | System Interface Networking Speeds Supported Cabling (up to 100m) Power Consumption (active-typical) | PCI Express 2.1 x4 10Mbps, 100Mbps, 1Gbps Cat3 (or higher) for 10Mbps Cat5 (or higher) for 100Mbps Cat5e (or higher) for 1Gbps 4.4W Length: 13.54cm (5.33 inches) Width: 6.89 (2.71 inches) Full-height end bracket: 12.0cm (4.725 inches) |



| Fechnical Specifications - Networking and Communications | | |
|--|--|--|
| | Hardware Certifications | USA: FCC B, EU: UL CE, Japan: VCCI, Taiwan: BSMI, Australia/New Zealand: CTICK, Korea: KCC, Canada: ICES-003/NMB-003 |
| Intel® I350-T4 | Networking Interface | 4 RJ-45 |
| | System Interface | PCI Express 2.1 x4 |
| | Networking Speeds Supported | 10Mbps, 100Mbps, 1Gbps |
| | Cabling (up to 100m) | Cat3 (or higher) for 10Mbps Cat5 (or higher) for 100Mbps Cat5e (or higher) for 1Gbps |
| | Power Consumption (active-typical) | 5W |
| | Physical Dimensions | Length: 13.54cm (5.33 inches) Width: 6.89 (2.71 inches) Full-height end bracket: 12.0cm (4.725 inches) Low-profile end bracket: 7.92cm (3.117 inches) |
| | Connect Speed LED Indicators | Link/Activity LED • Off = No link • Blinking = Activity Speed LED • Off = 10Mbps • Green = 100Mbps • Amber = 1Gbps |
| | Operating Temperature | 0 °C to 55 °C (32 °F to 131 °F) |
| | Hardware Certifications | USA: FCC B, EU: UL CE, Japan: VCCI, Taiwan: BSMI, Australia/New Zealand: CTICK, Korea: KCC, Canada: ICES-003/NMB-003 |
| Aquantia® AQN-108 | Networking Interface | RJ-45 |
| | System Interface Networking Speeds Supported | PCI Express 3 x1 100Mbps, 1Gbps, 2.5Gbps, 5Gbps |
| | Cabling (up to 100m) | Cat5e (or higher) for all speeds |
| | Power Consumption (active-typical) | 3.5W at 5Gbps, 3.0W at 2.5Gbps |
| | Physical Dimensions | 3.72 in x 3.18 in (without bracket) |
| | | |



| | Connect Speed LED Indicators | Link/Activity LED • Off = No link • Blinking = Activity Speed LED • Off = No link • Amber = <5Gbps • Green = 5Gbps |
|-----------------|--|---|
| | Operating Temperature Hardware Certifications | 0 °C to 55 °C (32 °F to 131 °F) USA: FCC B, EU: UL CE, Japan: VCCI, Taiwan: BSMI, Australia/New Zealand: CTICK, Korea: KCC, Canada: ICES-003/NMB-003 |
| Intel® X550-T2 | Networking Interface | 2 x RJ-45 |
| | System Interface Networking Speeds Supported | PCI Express 3 x4 100Mbps, 1Gbps, 2.5Gbps, 5Gbps, 10Gbps |
| | Cabling (up to 100m) | Cat5 (or higher) for 100Mbps Cat5e (or higher) for 1Gbps, 2.5Gbps, or 5Gbps Cat6a (or higher) for 10Gbps |
| | Power Consumption (active-typical) | 3.9W at 100Mbps 5.5W at 1Gbps 11.2W at 10Gbps |
| | Physical Dimensions | 5.2 in x 2.7 in (without bracket) |
| | Connect Speed LED Indicators | Link/Activity LED • Off = No link • Blinking = Activity Speed LED • Off = No link • Amber = <10Gbps • Green = 10Gbps |
| | Operating Temperature | 0 °C to 55 °C (32 °F to 131 °F) |
| | Hardware Certifications | USA: FCC B, EU: UL CE, Japan: VCCI, Taiwan: BSMI, Australia/New Zealand: CTICK, Korea: KCC, Canada: ICES-003/NMB-003 |
| Intel® X710-DA2 | Networking Interface | 2 SFP+ Ports for LC SFP+ Transceivers |

Intel® X710-DA2 10GBASE-SR Converged Network Adapter Networking Interface System Interface Networking Speeds Supported 2 SFP+ Ports for LC SFP+ Transceivers PCI Express 3.0 x8 1Gbps, 10Gbps



| | Cabling Power Consumption (active-typical) Physical Dimensions Connect Speed LED Indicators | LC fiber optic cabling with LC SFP+ Transceivers 4.3W 6.578 in x 2.703 in Link/Activity LED • Off = No link • Blinking = Activity Speed LED • Off = 10Mbps • Green = 100Mbps • Amber = 1Gbps |
|------------------------------|--|---|
| | Operating Temperature Hardware Certifications | 0 °C to 55 °C (32 °F to 131 °F) USA: FCC B, EU: UL CE, Japan: VCCI, Taiwan: BSMI, Australia/New Zealand: CTICK, Korea: KCC, Canada: ICES-003/NMB-003 |
| | Note: Windows 7 is NOT s | upported |
| 10GbE SFP+ SR Transceiver | Connector Type Cable Type | LC 62.5/125um or 50/125um (core/cladding), graded-index, low metal content, multimode fiber optic, complying with ITU-T G.651 and ISO/IEC |
| | Cable Length Wavelength | 793-2 Type A1b or A1a, respectively. 2-300m 850nm |
| | Form Factor Physical Dimensions | SFP+ 0.47(h) x 0.54(w) x 2.19(d) inches (1.19 x 1.38 x 5.57 cm) |
| | Operating Temperature Operating Humidity | OC to 45C (32F to 113F) 0% to 85%, noncondensing |
| Intel® 8265 WLAN | Networking Speeds | 802.11ac MU-MIMO (up to 867 Mbps) Bluetooth 4.2 |
| | IEEE WLAN Standard | IEEE 802.11a/b/g/n/ac, 802.11d, 802.11e, 802.11h, 802.11i, 802.11w; 802.11r, 802.11k, 802.11v pending |
| | Bluetooth | 4.2 |
| | System Interface | PCI Express 2.1 x1 |
| | Antenna | 2x2 |



Summary of Changes

SUMMARY OF CHANGES

| Date of change: | Version History: | | Description of change: |
|--------------------|------------------|---------|--|
| November 1, 2017 | From v1 to v2 | Added | HP DisplayPort to HDMI Adapter, HP DisplayPort to VGA Adapter, NVIDIA SLI 3-slot Graphics Connector and NVIDIA Quadro Sync II to Graphics section and Microsemi 3152-8i SAS ROC RAID Controller |
| | | Changed | Graphics, Storage / Hard Drives and Memory sections, changed Front and internal view info on the Overview section, changed Operating Systems section, changed System Board section, Physical Security and Serviceability sections |
| November 29, 2017 | From v2 to v3 | Added | Processors, hard drives and graphics to offerings, added Declared Noise Emissions information |
| January 30, 2018 | From v3 to v4 | Removed | NVIDIA SLI Graphics Connectors from Graphics Cable Adapters section |
| March 27, 2018 | From v4 to v5 | Added | Intel Xeon processors added |
| April 16, 2018 | From v5 to v6 | Removed | RAID 5 |
| August 13, 2018 | From v6 to v7 | Added | Footnote to Networking and Communications section |
| | | Changed | Processors section and Operating Systems section |
| September 4, 2018 | From v7 to v8 | Removed | HP IEEE 1394b FireWire PCIe Card |
| September 6, 2018 | From v8 to v9 | Removed | Microsemi 3152-8i SAS ROC RAID Controller |
| | From v9 to v10 | Added | Intel Optane SSD 905p AiC 280GB & 480GB |
| September 26, 2018 | From v10 to v11 | Changed | NVIDIA Quadro P6000 Graphics specs |
| | From v11 to v12 | Added | New Intel Xeon Processors and graphics, added HP DX175 Removable HDD Carrier into the HDD Frame/Carriers section |
| | | Changed | Storage / Hard Drives, Memory sections and format changes |
| May 15, 2019 | From v12 to v13 | Added | NVIDIA Quadro RTX 8000 48GB Graphics |
| | | Changed | External BIOS simulator link on Physical Security and Serviceability section |
| | | Removed | Intel 9260 WLAN |
| June 12, 2019 | From v13 to v14 | Changed | Storage section |
| July 7, 2019 | From v14 to v15 | Added | Intel Xeon W Processors |
| July 15, 2019 | From v15 to v16 | Changed | Corrected Intel 905p Series AIC 480GB PCIe SSD |
| August 1, 2019 | From v16 to v17 | Changed | Processors Matrix |
| September 1, 2019 | From v17 to v18 | Added | Footnote to Memory section, Added Optane 905P 380GB M.2 SSD Module, HP Z Turbo Drive 1TB SED TLC Z4/Z6 G4 SSD Kit & module to Storage section, Added Intel® Wi-Fi 6 AX200 & BT PCIe to Networking section |
| October 26, 2019 | From v18 to v19 | Changed | Graphics section |
| November 1, 2019 | From v19 to v20 | Added | NVDIMM Memory sections, Added HP QX310 Removable NVMe Frame/Carrier w/PCIe card to Optical and Removable Storage section |
| January 2, 2020 | From v20 to v21 | Changed | Storage section |
| February 26, 2020 | From v21 to v22 | Added | New Intel Xeon Processors |
| | | Changed | Overview, PCIe Solid State Drives sections |
| April 2, 2020 | From v22 to v23 | Changed | Processors and NVDIMM Memory sections |
| July 18, 2020 | From v23 to v24 | Changed | Processors, Graphics section |
| January 5, 2021 | From v24 to v25 | Changed | Processors, Memory, Graphics, Racking and Physical Security, Operating |
| | | | Systems and Hard Drives sections |

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